

## RL78/G15 RENESAS MCU

R01DS0420EJ0110  
Rev.1.10  
Apr 28, 2023

True low-power platform, 54-μA/MHz operating current,  $T_A = 125^\circ\text{C}$  operation, from 8 to 20 pins, 4 to 8 KB code flash memory, 1 KB RAM, 2.4 to 5.5 V

## 1. OUTLINE

### 1.1 Features

#### Low power consumption technology

- $V_{DD}$  = single power supply voltage of 2.4 to 5.5 V
- HALT mode
- STOP mode

#### RL78 CPU core

- CISC architecture with 3-stage pipeline
- Minimum instruction execution time: Can be changed from high speed (0.0625 μs: @ 16 MHz operation with high-speed on-chip oscillator) to low speed (1.0 μs: @ 1 MHz operation)
- Address space: 1 MB
- General-purpose registers: (8-bit register × 8) × 4 banks
- On-chip RAM: 1 KB

#### Code flash memory

- Code flash memory: 4 to 8 KB
- Block size: 1 KB
- Only write after erase is possible
- On-chip debug function
- Self-programming (with no boot swap function/flash shield window function)

#### Data flash memory

- Data flash memory: 1 KB
- Block size: 512 B
- Unit of rewrites: 32 bits
- Background operation (BGO) is not supported (instructions cannot be executed from the code flash memory while rewriting the data flash memory)
- Number of rewrites: 1,000,000 times (TYP.)
- Voltage of rewrites:  $V_{DD} = 2.4$  to 5.5 V

#### High-speed on-chip oscillator

- Select from 16 MHz, 8 MHz, 4 MHz, 2 MHz, and 1 MHz

- Frequency accuracy  $\pm 1.0\%$   
( $V_{DD} = 2.4$  to 5.5 V,  $T_A = -20$  to  $+85^\circ\text{C}$ )  
(G: Industrial applications, M: Industrial applications)
- Frequency accuracy  $\pm 1.5\%$   
( $V_{DD} = 2.4$  to 5.5 V,  $T_A = -40$  to  $-20^\circ\text{C}$ )  
(G: Industrial applications, M: Industrial applications)
- Frequency accuracy  $\pm 2.0\%$   
( $V_{DD} = 2.4$  to 5.5 V,  $T_A = +85$  to  $+125^\circ\text{C}$ )  
(G: Industrial applications, M: Industrial applications)
- Frequency accuracy  $\pm 2.0\%$   
( $V_{DD} = 2.4$  to 5.5 V,  $T_A = -40$  to  $+85^\circ\text{C}$ )  
(A: Consumer applications)

#### Operating ambient temperature

- $T_A = -40$  to  $+85^\circ\text{C}$  (A: Consumer applications)
- $T_A = -40$  to  $+105^\circ\text{C}$  (G: Industrial applications)
- $T_A = -40$  to  $+125^\circ\text{C}$  (M: Industrial applications)

#### Power management and reset function

- On-chip selectable power-on-reset (SPOR) circuit  
(Select reset from 3 levels, stop setting is available)

#### Serial interface

- Simplified SPI (CSI<sup>Note 1</sup>): 1 to 2 channels
- UART: 1 channel
- Simplified I<sup>2</sup>C: 1 to 2 channels
- I<sup>2</sup>C: 1 channel

Note 1. Although the CSI function is generally called SPI, it is also called CSI in this product, so it is referred to as such in this manual.

#### Timer

- 16-bit timer: 8 channels
- 12-bit interval timer: 1 channel
- Watchdog timer: 1 channel (operable with the dedicated low-speed on-chip oscillator)

**A/D converter**

- 8/10-bit resolution A/D converter ( $V_{DD} = 2.4$  to  $5.5$  V)
- Analog input: 3 to 11 channels
- Internal reference voltage ( $0.815$  V (TYP.))

**Comparator**

- 1 to 2 channels
- Operation mode: High-speed mode, low-speed mode
- External reference voltage or internal reference voltage can be selected as the reference voltage.

**I/O port**

- I/O port: 6 to 18 (N-ch open drain output [withstand voltage of  $V_{DD}$ ]: 2 to 9)
- Can be set to N-ch open drain and on-chip pull-up resistor
- External interrupt function: 8 channels
- On-chip clock output/buzzer output controller

**Others**

- On-chip BCD (binary-coded decimal) correction circuit

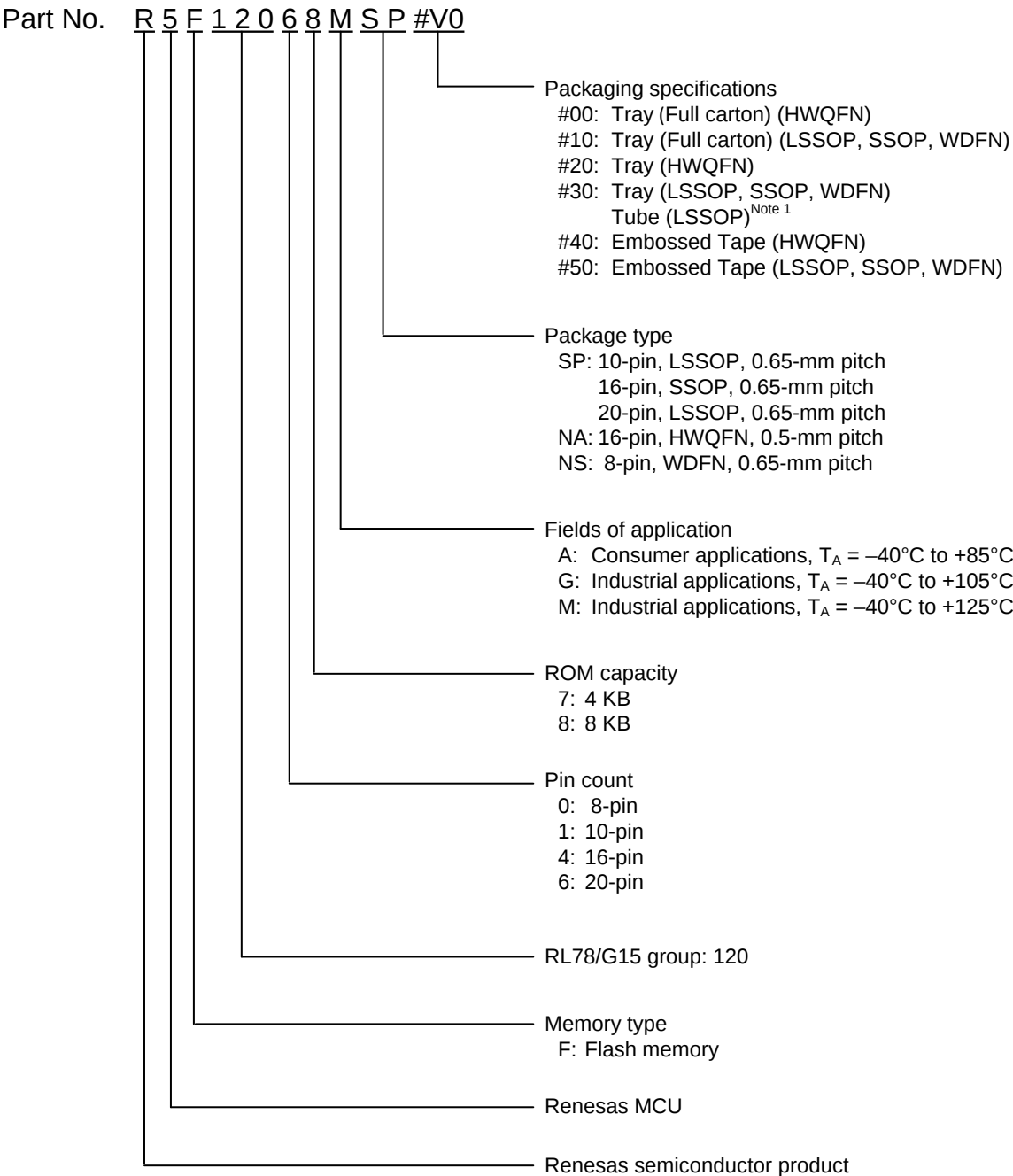
**Remark** The functions mounted depend on the product. See **1.6 Outline of Functions**.

**ROM, RAM capacities**

| Flash ROM | Data flash | RAM  | RL78/G15 |          |          |          |
|-----------|------------|------|----------|----------|----------|----------|
|           |            |      | 8 pins   | 10 pins  | 16 pins  | 20 pins  |
| 8 KB      | 1 KB       | 1 KB | R5F12008 | R5F12018 | R5F12048 | R5F12068 |
| 4 KB      | 1 KB       | 1 KB | R5F12007 | R5F12017 | R5F12047 | R5F12067 |

1.2 List of Part Numbers

Figure 1-1. Part Number, Memory Size, and Package of RL78/G15



Note 1. For the 20-pin LSSOP products only, the packaging specification is Tube.

Table 1-1. List of Ordering Part Numbers

| Pin count | Package                                               | Fields of Application<br>Note 1 | Ordering Part Number     |                          | RENESAS Code |
|-----------|-------------------------------------------------------|---------------------------------|--------------------------|--------------------------|--------------|
|           |                                                       |                                 | Product Name             | Packaging Specifications |              |
| 8 pins    | 8-pin plastic WDFN<br>(3 × 3 mm, 0.65-mm pitch)       | A                               | R5F12008ANS, R5F12007ANS | #10, #30, #50            | PWSN0008JG-A |
|           |                                                       | G                               | R5F12008GNS, R5F12007GNS |                          |              |
|           |                                                       | M                               | R5F12008MNS, R5F12007MNS |                          |              |
| 10 pins   | 10-pin plastic LSSOP<br>(4.4 × 3.6 mm, 0.65-mm pitch) | A                               | R5F12018ASP, R5F12017ASP | #10, #30, #50            | PLSP0010JA-A |
|           |                                                       | G                               | R5F12018GSP, R5F12017GSP |                          |              |
|           |                                                       | M                               | R5F12018MSP, R5F12017MSP |                          |              |
| 16 pins   | 16-pin plastic SSOP<br>(4.4 × 5.0 mm, 0.65-mm pitch)  | A                               | R5F12048ASP, R5F12047ASP | #10, #30, #50            | PRSP0016JC-B |
|           |                                                       | G                               | R5F12048GSP, R5F12047GSP |                          |              |
|           |                                                       | M                               | R5F12048MSP, R5F12047MSP |                          |              |
| 16 pins   | 16-pin plastic HWQFN<br>(3 × 3 mm, 0.5-mm pitch)      | A                               | R5F12048ANA, R5F12047ANA | #00, #20, #40            | PWQN0016KD-A |
|           |                                                       | G                               | R5F12048GNA, R5F12047GNA |                          |              |
|           |                                                       | M                               | R5F12048MNA, R5F12047MNA |                          |              |
| 20 pins   | 20-pin plastic LSSOP<br>(4.4 × 6.5 mm, 0.65-mm pitch) | A                               | R5F12068ASP, R5F12067ASP | #30, #50                 | PLSP0020JB-A |
|           |                                                       | G                               | R5F12068GSP, R5F12067GSP |                          |              |
|           |                                                       | M                               | R5F12068MSP, R5F12067MSP |                          |              |

Note 1. For the fields of application, refer to **Figure 1-1 Part Number, Memory Size, and Package of RL78/G15**.

**Caution** The ordering part numbers represent the numbers at the time of publication. For the latest ordering part numbers, refer to the target product page of the Renesas Electronics website.

## 1.3 Pin Configuration (Top View)

### 1.3.1 8-pin products

- 8-pin plastic WDFN (3 × 3 mm, 0.65-mm pitch)

|                                            |   |                        |   |                                                           |
|--------------------------------------------|---|------------------------|---|-----------------------------------------------------------|
| P40/TOOL0/PCLBUZ0/VCOUT0/INTP2/(TI01/TO01) | 1 | RL78/G15<br>(Top View) | 8 | P137/INTP0/TI00                                           |
| P125/RESET/INTP1/(VCOUT0)                  | 2 |                        | 7 | P04/ANI3/IVREF0/INTP3/TI01/TO01/SCK00/SCL00               |
| V <sub>SS</sub>                            | 3 |                        | 6 | P03/TOOLTxD/ANI2/IVCMP0/INTP4/TO00/SO00/TxD0/SCLA0/(TI00) |
| V <sub>DD</sub>                            | 4 |                        | 5 | P01/TOOLRxD/ANI0/INTP5/TI02/TO02/SI00/RxD0/SDA00/SDAA0    |

Table 1-2. Multiplexed Functions of 8-pin Products

| Pin No. | I/O          | Power supply, system, clock, debug | Analog        |            | HMI                | Timer            | Communications Interface |                       |
|---------|--------------|------------------------------------|---------------|------------|--------------------|------------------|--------------------------|-----------------------|
| 8WDFN   | Digital port |                                    | A/D converter | Comparator | Interrupt function | Timer array unit | Serial array unit        | Serial interface IICA |
| 1       | P40          | TOOL0<br>PCLBUZ0                   | —             | VCOUT0     | INTP2              | (TI01/TO01)      | —                        | —                     |
| 2       | P125         | RESET                              | —             | (VCOUT0)   | INTP1              | —                | —                        | —                     |
| 3       | —            | V <sub>SS</sub>                    | —             | —          | —                  | —                | —                        | —                     |
| 4       | —            | V <sub>DD</sub>                    | —             | —          | —                  | —                | —                        | —                     |
| 5       | P01          | TOOLRxD                            | ANI0          | —          | INTP5              | TI02/TO02        | SI00/RxD0/<br>SDA00      | SDAA0                 |
| 6       | P03          | TOOLTxD                            | ANI2          | IVCMP0     | INTP4              | (TI00)<br>TO00   | SO00/TxD0                | SCLA0                 |
| 7       | P04          | —                                  | ANI3          | IVREF0     | INTP3              | TI01/TO01        | SCK00/SCL00              | —                     |
| 8       | P137         | —                                  | —             | —          | INTP0              | TI00             | —                        | —                     |

**Remark 1.** For pin identification, see **1.4 Pin Identification**.

**Remark 2.** Functions in parentheses can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to *Figure 4-6 Format of Peripheral I/O Redirection Registers 0 to 3 (PIOR0 to PIOR3)* in the *RL78/G15 User's Manual*.

### 1.3.2 10-pin products

- 10-pin plastic LSSOP (4.4 × 3.6 mm, 0.65-mm pitch)

|                                       |   |                        |    |                                                        |
|---------------------------------------|---|------------------------|----|--------------------------------------------------------|
| P40/TOOL0/INTP2/(TI01/TO01)/(PCLBUZ0) | 1 | RL78/G15<br>(Top View) | 10 | P04/ANI3/IVREF0/INTP3/TI01/TO01                        |
| P125/RESET/INTP1/(VCOUT0)             | 2 |                        | 9  | P03/ANI2/INTP4/IVCMP0/TO00/SCLA0/(TI00)                |
| P137/INTP0/TI00                       | 3 |                        | 8  | P02/PCLBUZ0/ANI1/INTP7/VCOUT0/SCK00/SCL00/(TI01/TO01)  |
| V <sub>SS</sub>                       | 4 |                        | 7  | P01/TOOLRxD/ANI0/INTP5/TI02/TO02/SI00/RxD0/SDA00/SDAA0 |
| V <sub>DD</sub>                       | 5 |                        | 6  | P00/TOOLTxD/INTP6/SO00/TxD0                            |

Table 1-3. Multiplexed Functions of 10-pin Products

| Pin No. | I/O          | Power supply, system, clock, debug | Analog        |            | HMI                | Timer            | Communications Interface |                       |
|---------|--------------|------------------------------------|---------------|------------|--------------------|------------------|--------------------------|-----------------------|
| 10LSSOP | Digital port |                                    | A/D converter | Comparator | Interrupt function | Timer array unit | Serial array unit        | Serial interface IICA |
| 1       | P40          | TOOL0 (PCLBUZ0)                    | —             | —          | INTP2              | (TI01/TO01)      | —                        | —                     |
| 2       | P125         | RESET                              | —             | (VCOUT0)   | INTP1              | —                | —                        | —                     |
| 3       | P137         | —                                  | —             | —          | INTP0              | TI00             | —                        | —                     |
| 4       | —            | V <sub>SS</sub>                    | —             | —          | —                  | —                | —                        | —                     |
| 5       | —            | V <sub>DD</sub>                    | —             | —          | —                  | —                | —                        | —                     |
| 6       | P00          | TOOLTxD                            | —             | —          | INTP6              | —                | SO00/TxD0                | —                     |
| 7       | P01          | TOOLRxD                            | ANI0          | —          | INTP5              | TI02/TO02        | SI00/RxD0/SDA00          | SDAA0                 |
| 8       | P02          | PCLBUZ0                            | ANI1          | VCOUT0     | INTP7              | (TI01/TO01)      | SCK00/SCL00              | —                     |
| 9       | P03          | —                                  | ANI2          | IVCMP0     | INTP4              | (TI00)<br>TO00   | —                        | SCLA0                 |
| 10      | P04          | —                                  | ANI3          | IVREF0     | INTP3              | TI01/TO01        | —                        | —                     |

**Remark 1.** For pin identification, see **1.4 Pin Identification**.

**Remark 2.** Functions in parentheses can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to *Figure 4-6 Format of Peripheral I/O Redirection Registers 0 to 3 (PIOR0 to PIOR3)* in the *RL78/G15 User's Manual*.

1.3.3 16-pin products

- 16-pin plastic SSOP (4.4 × 5.0 mm, 0.65-mm pitch)

|                                       |   |                        |    |                                                                           |
|---------------------------------------|---|------------------------|----|---------------------------------------------------------------------------|
| P41/TI03/TO03/(INTP4)/(TI02/TO02)     | 1 | RL78/G15<br>(Top View) | 16 | P07/ANI6/SCK01/SCL01/SDAA0/(INTP5)/(TO03)                                 |
| P40/TOOL0/INTP2/(PCLBUZ0)/(TI01/TO01) | 2 |                        | 15 | P06/ANI5/SI01/SDA01/SCLA0/(PCLBUZ0)/(INTP7)/(SCK00/SCL00)                 |
| P125/RESET/INTP1/(VCOUT0)             | 3 |                        | 14 | P05/ANI4/TI02/TO02/SO01/(INTP6)/(SCK00/SCL00)/(SI00/RxD0/SDA00)           |
| P137/INTP0/TI00                       | 4 |                        | 13 | P04/ANI3/IVREF0/INTP3/TI01/TO01/(SI00/RxD0/SDA00)/(SO00/TxD0)             |
| P122/X2/EXCLK/TI05/TO05/(INTP2)       | 5 |                        | 12 | P03/ANI2/IVCMP0/INTP4/TO00/(TI00)/(SO00/TxD0)                             |
| P121/X1/TI07/TO07/(INTP3)             | 6 |                        | 11 | P02/PCLBUZ0/ANI1/VCOUT0/INTP7/SCK00/SCL00/(TI01/TO01)/(SO01)              |
| V <sub>SS</sub>                       | 7 |                        | 10 | P01/TOOLRxD/ANI0/INTP5/SI00/RxD0/SDA00/(TI02/TO02)/(SI01)/(SDA01)/(SDAA0) |
| V <sub>DD</sub>                       | 8 |                        | 9  | P00/TOOLTxD/INTP6/SO00/TxD0/(SCK01/SCL01)/(SCLA0)                         |

- 16-pin plastic HWQFN (3 × 3 mm, 0.5-mm pitch)

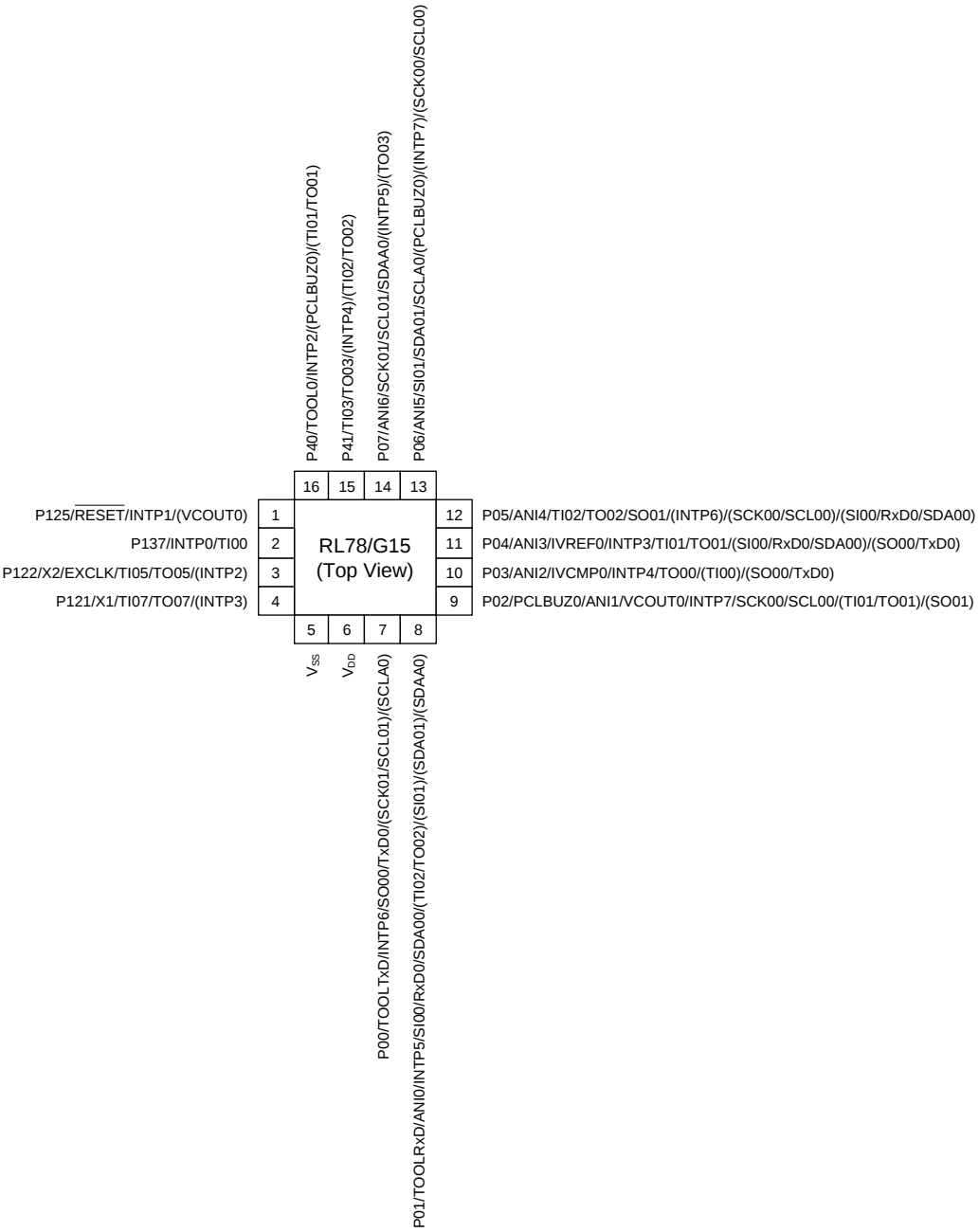


Table 1-4. Multiplexed Functions of 16-pin Products

| Pin No. |         | I/O          | Power supply,<br>system, clock,<br>debug | Analog        |            | HMI                   | Timer                    | Communications Interface                       |                          |
|---------|---------|--------------|------------------------------------------|---------------|------------|-----------------------|--------------------------|------------------------------------------------|--------------------------|
| 16SSOP  | 16HWQFN | Digital port |                                          | A/D converter | Comparator | Interrupt<br>function | Timer array<br>unit      | Serial array<br>unit                           | Serial<br>interface IICA |
| 1       | 15      | P41          | —                                        | —             | —          | (INTP4)               | TI03/TO03<br>(TI02/TO02) | —                                              | —                        |
| 2       | 16      | P40          | TOOL0<br>(PCLBUZ0)                       | —             | —          | INTP2                 | (TI01/TO01)              | —                                              | —                        |
| 3       | 1       | P125         | RESET                                    | —             | (VCOU0)    | INTP1                 | —                        | —                                              | —                        |
| 4       | 2       | P137         | —                                        | —             | —          | INTP0                 | TI00                     | —                                              | —                        |
| 5       | 3       | P122         | X2<br>EXCLK                              | —             | —          | (INTP2)               | TI05/TO05                | —                                              | —                        |
| 6       | 4       | P121         | X1                                       | —             | —          | (INTP3)               | TI07/TO07                | —                                              | —                        |
| 7       | 5       | —            | V <sub>SS</sub>                          | —             | —          | —                     | —                        | —                                              | —                        |
| 8       | 6       | —            | V <sub>DD</sub>                          | —             | —          | —                     | —                        | —                                              | —                        |
| 9       | 7       | P00          | TOOLTxD                                  | —             | —          | INTP6                 | —                        | SO00/TxD0<br>(SCK01/SCL01)                     | (SCLA0)                  |
| 10      | 8       | P01          | TOOLRxD                                  | ANI0          | —          | INTP5                 | (TI02/TO02)              | SI00/RxD0/<br>SDA00<br>(SI01)/(SDA01)          | (SDAA0)                  |
| 11      | 9       | P02          | PCLBUZ0                                  | ANI1          | VCOU0      | INTP7                 | (TI01/TO01)              | SCK00/SCL00<br>(SO01)                          | —                        |
| 12      | 10      | P03          | —                                        | ANI2          | IVCMP0     | INTP4                 | (TI00)<br>TO00           | (SO00/TxD0)                                    | —                        |
| 13      | 11      | P04          | —                                        | ANI3          | IVREF0     | INTP3                 | TI01/TO01                | (SI00/RxD0/<br>SDA00)<br>(SO00/TxD0)           | —                        |
| 14      | 12      | P05          | —                                        | ANI4          | —          | (INTP6)               | TI02/TO02                | SO01<br>(SCK00/SCL00)<br>(SI00/RxD0/<br>SDA00) | —                        |
| 15      | 13      | P06          | (PCLBUZ0)                                | ANI5          | —          | (INTP7)               | —                        | SI01/SDA01<br>(SCK00/SCL00)                    | SCLA0                    |
| 16      | 14      | P07          | —                                        | ANI6          | —          | (INTP5)               | (TO03)                   | SCK01/SCL01                                    | SDAA0                    |

**Remark 1.** For pin identification, see **1.4 Pin Identification**.

**Remark 2.** Functions in parentheses can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to *Figure 4-6 Format of Peripheral I/O Redirection Registers 0 to 3 (PIOR0 to PIOR3)* in the *RL78/G15 User's Manual*.

### 1.3.4 20-pin products

- 20-pin plastic LSSOP (4.4 × 6.5 mm, 0.65-mm pitch)

|                                                           |    |                        |    |                                                                           |
|-----------------------------------------------------------|----|------------------------|----|---------------------------------------------------------------------------|
| P21/ANI9/IVCMP1/(INTP7)/(TO00)                            | 1  | RL78/G15<br>(Top View) | 20 | P22/ANI8/TI06/TO06/(INTP5)/(SDA01)                                        |
| P20/ANI10/IVREF1/(INTP1)/(TI00)/(TI03/TO03)/(SCK01/SCL01) | 2  |                        | 19 | P23/ANI7/TI04/TO04/(INTP6)/(SCL01)                                        |
| P41/VCOOUT1/TI03/TO03/(INTP4)/(TI02/TO02)/(SO01)/(SDA01)  | 3  |                        | 18 | P07/ANI6/SCK01/SCL01/SDAA0/(INTP5)/(TO03)                                 |
| P40/TOOL0/INTP2/(PCLBUZ0)/(TI01/TO01)                     | 4  |                        | 17 | P06/ANI5/SI01/SDA01/SCLA0/(PCLBUZ0)/(INTP7)/(SCK00/SCL00)                 |
| P125/RESET/INTP1/(VCOOUT0)/(VCOOUT1)/(SI01)               | 5  |                        | 16 | P05/ANI4/TI02/TO02/SO01/(INTP6)/(SCK00/SCL00)/(SI00/RxD0/SDA00)           |
| P137/INTP0/TI00                                           | 6  |                        | 15 | P04/ANI3/IVREF0/INTP3/TI01/TO01/(SI00/RxD0/SDA00)/(SO00/TxD0)             |
| P122/X2/EXCLK/TI05/TO05/(INTP2)                           | 7  |                        | 14 | P03/ANI2/IVCMP0/INTP4/TO00/(TI00)/(SO00/TxD0)                             |
| P121/X1/TI07/TO07/(INTP3)                                 | 8  |                        | 13 | P02/PCLBUZ0/ANI1/VCOOUT0/INTP7/SCK00/SCL00/(TI01/TO01)/(SO01)             |
| V <sub>SS</sub>                                           | 9  |                        | 12 | P01/TOOLRxD/ANI0/INTP5/SI00/RxD0/SDA00/(TI02/TO02)/(SI01)/(SDA01)/(SDAA0) |
| V <sub>DD</sub>                                           | 10 |                        | 11 | P00/TOOLTxD/INTP6/SO00/TxD0/(SCK01/SCL01)/(SCLA0)                         |

Table 1-5. Multiplexed Functions of 20-pin Products (1/2)

| Pin No. | I/O  | Power supply, system, clock, debug | Analog        |                        | HMI                | Timer                    | Communications Interface                       |                       |
|---------|------|------------------------------------|---------------|------------------------|--------------------|--------------------------|------------------------------------------------|-----------------------|
|         |      |                                    | A/D converter | Comparator             | Interrupt function | Timer array unit         | Serial array unit                              | Serial interface IICA |
| 1       | P21  | —                                  | ANI9          | IVCMP1                 | (INTP7)            | (TO00)                   | —                                              | —                     |
| 2       | P20  | —                                  | ANI10         | IVREF1                 | (INTP1)            | (TI00)<br>(TI03/TO03)    | (SCK01/SCL01)                                  | —                     |
| 3       | P41  | —                                  | —             | VCOOUT1                | (INTP4)            | TI03/TO03<br>(TI02/TO02) | (SO01)/(SDA01)                                 | —                     |
| 4       | P40  | TOOL0<br>(PCLBUZ0)                 | —             | —                      | INTP2              | (TI01/TO01)              | —                                              | —                     |
| 5       | P125 | RESET                              | —             | (VCOOUT0)<br>(VCOOUT1) | INTP1              | —                        | (SI01)                                         | —                     |
| 6       | P137 | —                                  | —             | —                      | INTP0              | TI00                     | —                                              | —                     |
| 7       | P122 | X2<br>EXCLK                        | —             | —                      | (INTP2)            | TI05/TO05                | —                                              | —                     |
| 8       | P121 | X1                                 | —             | —                      | (INTP3)            | TI07/TO07                | —                                              | —                     |
| 9       |      | V <sub>SS</sub>                    | —             | —                      | —                  | —                        | —                                              | —                     |
| 10      |      | V <sub>DD</sub>                    | —             | —                      | —                  | —                        | —                                              | —                     |
| 11      | P00  | TOOLTxD                            | —             | —                      | INTP6              | —                        | SO00/TxD0<br>(SCK01/SCL01)                     | (SCLA0)               |
| 12      | P01  | TOOLRxD                            | ANI0          | —                      | INTP5              | (TI02/TO02)              | SI00/RxD0/SDA00<br>(SI01)/(SDA01)              | (SDAA0)               |
| 13      | P02  | PCLBUZ0                            | ANI1          | VCOOUT0                | INTP7              | (TI01/TO01)              | SCK00/SCL00<br>(SO01)                          | —                     |
| 14      | P03  | —                                  | ANI2          | IVCMP0                 | INTP4              | (TI00)<br>TO00           | (SO00/TxD0)                                    | —                     |
| 15      | P04  | —                                  | ANI3          | IVREF0                 | INTP3              | TI01/TO01                | (SI00/RxD0/<br>SDA00)<br>(SO00/TxD0)           | —                     |
| 16      | P05  | —                                  | ANI4          | —                      | (INTP6)            | TI02/TO02                | SO01<br>(SCK00/SCL00)<br>(SI00/RxD0/<br>SDA00) | —                     |
| 17      | P06  | (PCLBUZ0)                          | ANI5          | —                      | (INTP7)            | —                        | SI01/SDA01<br>(SCK00/SCL00)                    | SCLA0                 |
| 18      | P07  | —                                  | ANI6          | —                      | (INTP5)            | (TO03)                   | SCK01/SCL01                                    | SDAA0                 |

Table 1-5. Multiplexed Functions of 20-pin Products (2/2)

| Pin No. | I/O          | Power supply,<br>system, clock,<br>debug | Analog        |            | HMI                | Timer            | Communications Interface |                       |
|---------|--------------|------------------------------------------|---------------|------------|--------------------|------------------|--------------------------|-----------------------|
| 20LSSOP | Digital port |                                          | A/D converter | Comparator | Interrupt function | Timer array unit | Serial array unit        | Serial interface IICA |
| 19      | P23          | —                                        | ANI7          | —          | (INTP6)            | TI04/TO04        | (SCL01)                  | —                     |
| 20      | P22          | —                                        | ANI8          | —          | (INTP5)            | TI06/TO06        | (SDA01)                  | —                     |

**Remark 1.** For pin identification, see **1.4 Pin Identification**.

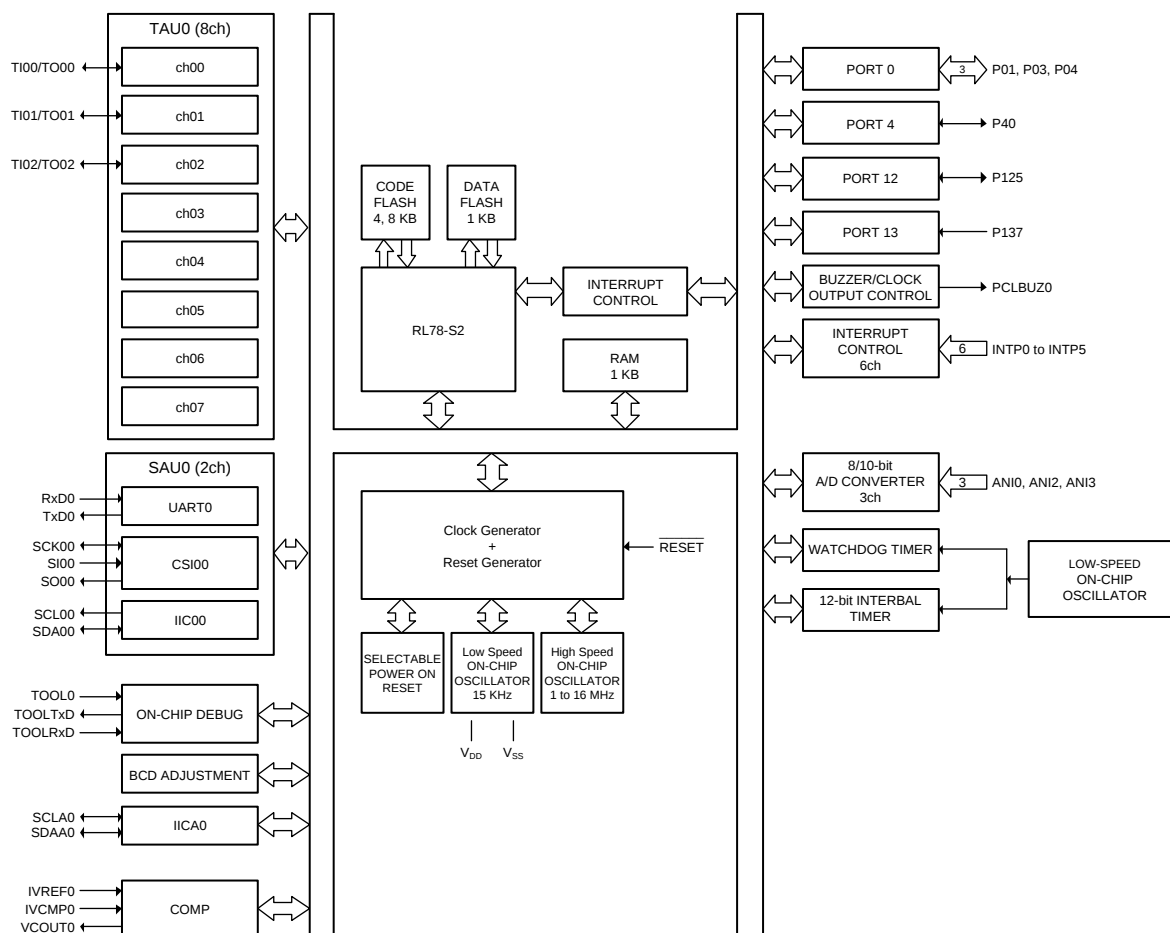
**Remark 2.** Functions in parentheses can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to *Figure 4-6 Format of Peripheral I/O Redirection Registers 0 to 3 (PIOR0 to PIOR3)* in the *RL78/G15 User's Manual*.

## 1.4 Pin Identification

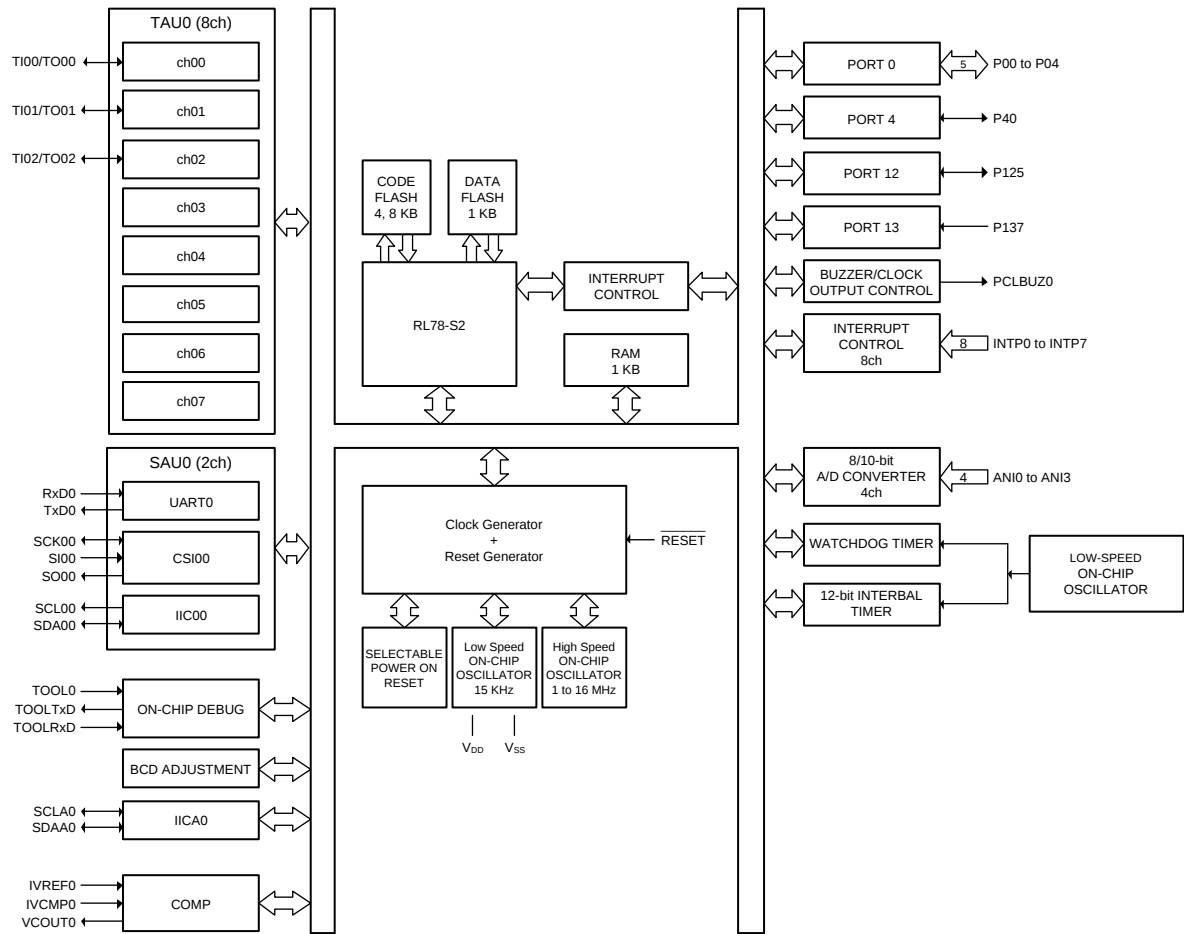
|                           |                                           |
|---------------------------|-------------------------------------------|
| ANI0 to ANI10             | : Analog Input                            |
| INTP0 to INTP7            | : Interrupt Request From Peripherals      |
| P00 to P07                | : Port 0                                  |
| P20 to P23                | : Port 2                                  |
| P40, P41                  | : Port 4                                  |
| P121, P122, P125          | : Port 12                                 |
| P137                      | : Port 13                                 |
| PCLBUZ0                   | : Programmable Clock Output/Buzzer Output |
| EXCLK                     | : External Clock Input                    |
| X1, X2                    | : Crystal Oscillator (Main System Clock)  |
| IVCMP0, IVCMP1            | : Comparator Input                        |
| VCOUT0, VCOUT1            | : Comparator Output                       |
| IVREF0, IVREF1            | : Comparator Reference Input              |
| $\overline{\text{RESET}}$ | : Reset                                   |
| RxD0                      | : Receive Data                            |
| SCK00, SCK01              | : Serial Clock Input/Output               |
| SCL00, SCL01, SCLA0       | : Serial Clock Output                     |
| SDA00, SDA01, SDAA0       | : Serial Data Input/Output                |
| SI00, SI01                | : Serial Data Input                       |
| SO00, SO01                | : Serial Data Output                      |
| TI00 to TI07              | : Timer Input                             |
| TO00 to TO07              | : Timer Output                            |
| TOOL0                     | : Data Input/Output for Tool              |
| TOOLRxD, TOOLTxD          | : Data Input/Output for External Device   |
| TxD0                      | : Transmit Data                           |
| $V_{DD}$                  | : Power Supply                            |
| $V_{SS}$                  | : Ground                                  |

## 1.5 Block Diagram

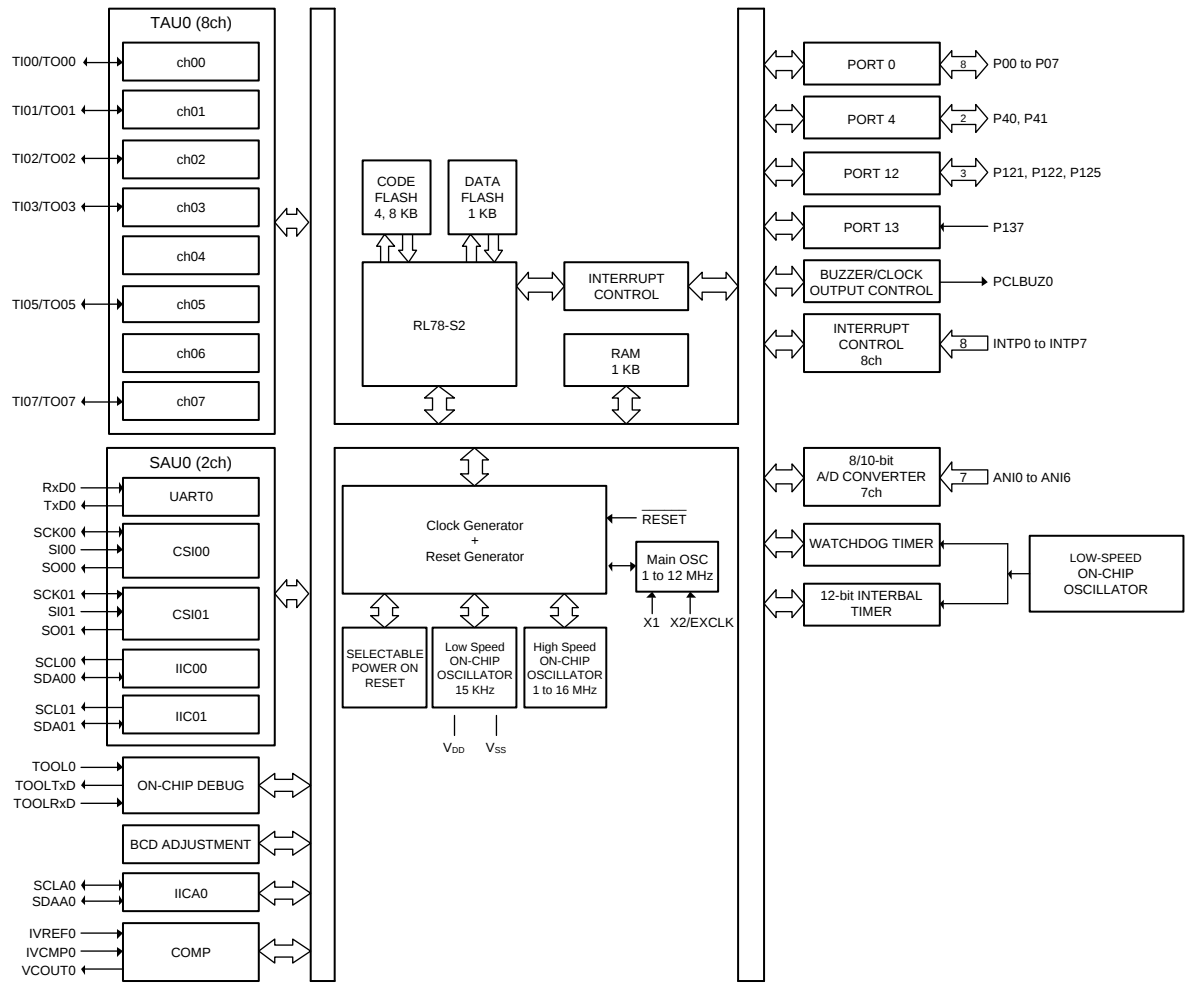
### 1.5.1 8-pin products



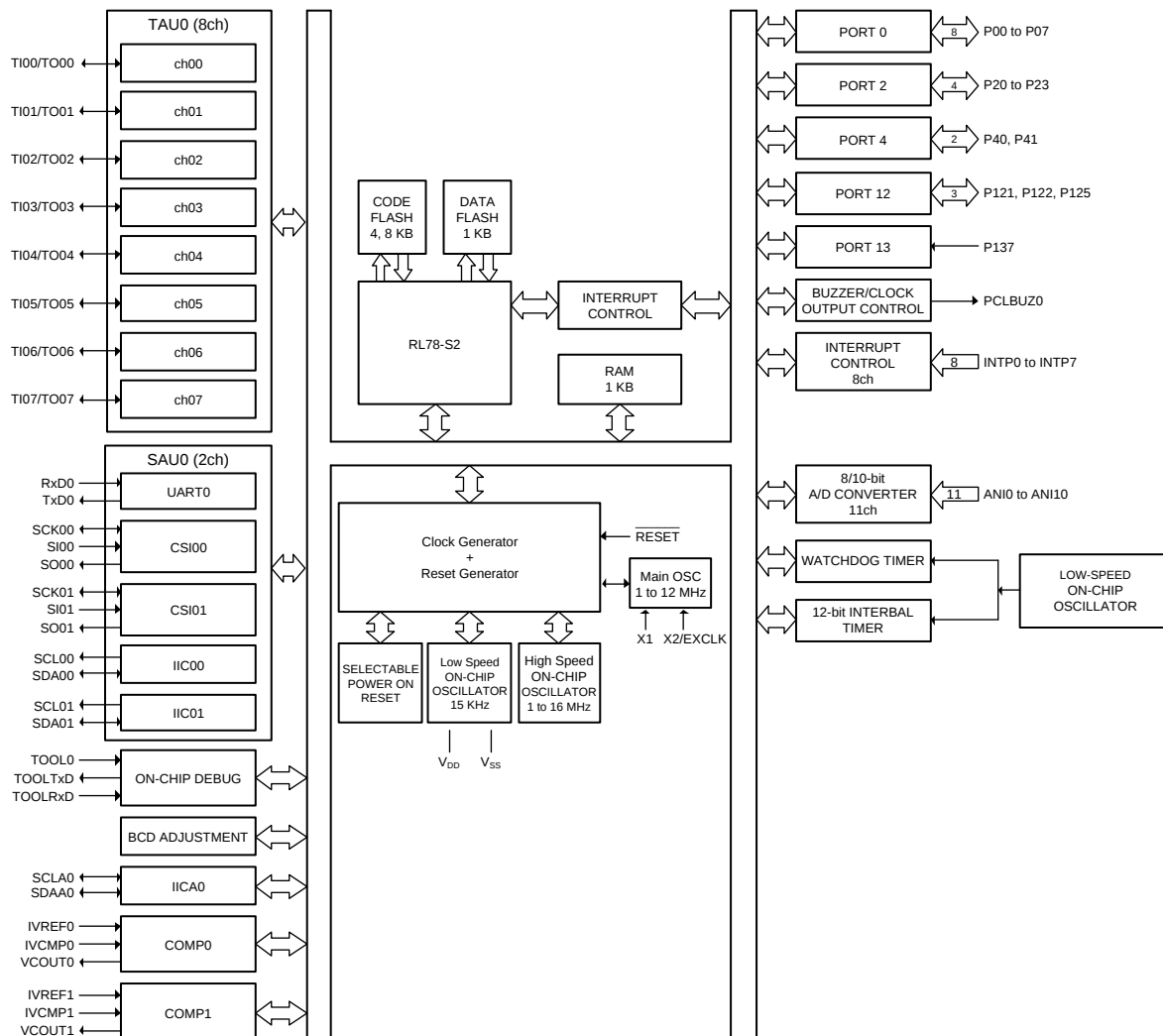
1.5.2 10-pin products



1.5.3 16-pin products



## 1.5.4 20-pin products



## 1.6 Outline of Functions

This outline describes the functions at the time when Peripheral I/O redirection register (PIOR) is set to 00H.

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| Item                                 |                               | 8-pin                                                                                                                                                                                                                                                                                                                                                                    |          | 10-pin                                           |          | 16-pin                                                                                                                                                   |          | 20-pin                                           |          |
|--------------------------------------|-------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|--------------------------------------------------|----------|----------------------------------------------------------------------------------------------------------------------------------------------------------|----------|--------------------------------------------------|----------|
|                                      |                               | R5F12007                                                                                                                                                                                                                                                                                                                                                                 | R5F12008 | R5F12017                                         | R5F12018 | R5F12047                                                                                                                                                 | R5F12048 | R5F12067                                         | R5F12068 |
| Code flash memory                    |                               | 4 KB                                                                                                                                                                                                                                                                                                                                                                     | 8 KB     | 4 KB                                             | 8 KB     | 4 KB                                                                                                                                                     | 8 KB     | 4 KB                                             | 8 KB     |
| Data flash memory                    |                               | 1 KB                                                                                                                                                                                                                                                                                                                                                                     |          |                                                  |          |                                                                                                                                                          |          |                                                  |          |
| RAM                                  |                               | 1 KB                                                                                                                                                                                                                                                                                                                                                                     |          |                                                  |          |                                                                                                                                                          |          |                                                  |          |
| Main system clock                    | High-speed system clock       | —                                                                                                                                                                                                                                                                                                                                                                        |          | —                                                |          | X1, X2 (crystal/ceramic) oscillation: 1 to 12 MHz:<br>VDD = 2.4 to 5.5 V<br>External main system clock input (EXCLK): 1 to 16 MHz:<br>VDD = 2.4 to 5.5 V |          |                                                  |          |
|                                      | High-speed on-chip oscillator | 1 to 16 MHz (VDD = 2.4 to 5.5 V)                                                                                                                                                                                                                                                                                                                                         |          |                                                  |          |                                                                                                                                                          |          |                                                  |          |
| Low-speed on-chip oscillator clock   |                               | 15 kHz (TYP.)                                                                                                                                                                                                                                                                                                                                                            |          |                                                  |          |                                                                                                                                                          |          |                                                  |          |
| General-purpose registers            |                               | (8-bit register × 8) × 4 banks                                                                                                                                                                                                                                                                                                                                           |          |                                                  |          |                                                                                                                                                          |          |                                                  |          |
| Minimum instruction execution time   |                               | 0.0625 μs (16 MHz operation)                                                                                                                                                                                                                                                                                                                                             |          |                                                  |          |                                                                                                                                                          |          |                                                  |          |
| Instruction set                      |                               | <ul style="list-style-type: none"><li>• Data transfer (8/16 bits)</li><li>• Adder and subtractor/logical operation (8/16 bits)</li><li>• Multiplication (8 bits × 8 bits)</li><li>• Rotate, barrel shift, and bit manipulation (Set, reset, test, and Boolean operation), etc.</li></ul>                                                                                 |          |                                                  |          |                                                                                                                                                          |          |                                                  |          |
| I/O port                             | Total                         | 6                                                                                                                                                                                                                                                                                                                                                                        |          | 8                                                |          | 14                                                                                                                                                       |          | 18                                               |          |
|                                      | CMOS I/O                      | 5                                                                                                                                                                                                                                                                                                                                                                        |          | 7                                                |          | 13                                                                                                                                                       |          | 17                                               |          |
|                                      | CMOS input                    | 1                                                                                                                                                                                                                                                                                                                                                                        |          |                                                  |          |                                                                                                                                                          |          |                                                  |          |
| Timer                                | 16-bit timer                  | 8 channels                                                                                                                                                                                                                                                                                                                                                               |          |                                                  |          |                                                                                                                                                          |          |                                                  |          |
|                                      | Watchdog timer                | 1 channel                                                                                                                                                                                                                                                                                                                                                                |          |                                                  |          |                                                                                                                                                          |          |                                                  |          |
|                                      | 12-bit interval timer         | 1 channel                                                                                                                                                                                                                                                                                                                                                                |          |                                                  |          |                                                                                                                                                          |          |                                                  |          |
|                                      | Timer output                  | 3 channels<br>(PWM outputs: 2) <sup>Note 1</sup>                                                                                                                                                                                                                                                                                                                         |          | 3 channels<br>(PWM outputs: 2) <sup>Note 1</sup> |          | 6 channels<br>(PWM outputs: 4) <sup>Note 1</sup>                                                                                                         |          | 8 channels<br>(PWM outputs: 7) <sup>Note 1</sup> |          |
| Clock output/buzzer output           |                               | 1                                                                                                                                                                                                                                                                                                                                                                        |          |                                                  |          |                                                                                                                                                          |          |                                                  |          |
|                                      |                               | Up to 10 MHz (peripheral hardware clock: f <sub>MAIN</sub> = 10 MHz operation)                                                                                                                                                                                                                                                                                           |          |                                                  |          |                                                                                                                                                          |          |                                                  |          |
| Comparator                           |                               | 1 channel                                                                                                                                                                                                                                                                                                                                                                |          | 1 channel                                        |          | 1 channel                                                                                                                                                |          | 2 channels                                       |          |
| 8/10-bit resolution A/D converter    |                               | 3 channels                                                                                                                                                                                                                                                                                                                                                               |          | 4 channels                                       |          | 7 channels                                                                                                                                               |          | 11 channels                                      |          |
| Serial interface                     |                               | Simplified SPI (CSI): 1 channel/simplified I <sup>2</sup> C:<br>1 channel/UART: 1 channel                                                                                                                                                                                                                                                                                |          |                                                  |          | Simplified SPI (CSI <sup>Note 2</sup> ): 2 channels/simplified I <sup>2</sup> C:<br>2 channels/UART: 1 channel                                           |          |                                                  |          |
|                                      |                               | I <sup>2</sup> C bus                                                                                                                                                                                                                                                                                                                                                     |          | 1 channel                                        |          |                                                                                                                                                          |          |                                                  |          |
| Number of Vectored interrupt sources | Internal                      | 8                                                                                                                                                                                                                                                                                                                                                                        |          | 10                                               |          | 16                                                                                                                                                       |          | 19                                               |          |
|                                      | External                      | 6                                                                                                                                                                                                                                                                                                                                                                        |          | 8                                                |          | 8                                                                                                                                                        |          | 8                                                |          |
| Reset                                |                               | <ul style="list-style-type: none"><li>• Reset by <u>RESET</u> pin</li><li>• Internal reset by watchdog timer</li><li>• Internal reset by selectable power-on-reset</li><li>• Internal reset by illegal instruction execution<sup>Note 3</sup></li><li>• Internal reset by data retention lower limit voltage</li><li>• Internal reset by illegal-memory access</li></ul> |          |                                                  |          |                                                                                                                                                          |          |                                                  |          |
| Selectable power-on-reset circuit    |                               | <ul style="list-style-type: none"><li>• Detection voltage<br/>Rising edge (V<sub>SPOR</sub>): 2.25 V/2.68 V/3.02 V/4.45 V (MAX.)<br/>Falling edge (V<sub>SPDR</sub>): 2.20 V/2.62 V/2.96 V/4.37 V (MAX.)</li></ul>                                                                                                                                                       |          |                                                  |          |                                                                                                                                                          |          |                                                  |          |

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| Item                          | 8-pin                                                                                                                                                                                                   |          | 10-pin   |          | 16-pin   |          | 20-pin   |          |
|-------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------|----------|----------|----------|----------|----------|
|                               | R5F12007                                                                                                                                                                                                | R5F12008 | R5F12017 | R5F12018 | R5F12047 | R5F12048 | R5F12067 | R5F12068 |
| On-chip debug function        | Provided                                                                                                                                                                                                |          |          |          |          |          |          |          |
| Power supply voltage          | $V_{DD} = 2.4$ to $5.5$ V                                                                                                                                                                               |          |          |          |          |          |          |          |
| Operating ambient temperature | $T_A = -40$ to $+85^{\circ}\text{C}$ (A: Consumer applications), $T_A = -40$ to $+105^{\circ}\text{C}$ (G: Industrial applications), $T_A = -40$ to $+125^{\circ}\text{C}$ (M: Industrial applications) |          |          |          |          |          |          |          |

- Note 1. The number of outputs varies, depending on the setting of channels in use and the number of the master (see 6.9.3 *Operation as multiple PWM output function in the RL78/G15 User's Manual*).
- Note 2. Although the CSI function is generally called SPI, it is also called CSI in this product, so it is referred to as such in this manual.
- Note 3. The illegal instruction is generated when instruction code FFH is executed. Reset by the illegal instruction execution not issued by emulation with the on-chip debug emulator.

## ★ 2. ELECTRICAL SPECIFICATIONS ( $T_A = -40$ to $+85^\circ\text{C}$ )

This chapter describes the electrical specifications of A: Consumer applications ( $T_A = -40$  to  $+85^\circ\text{C}$ ).

**Caution 1.** The RL78 microcontrollers have an on-chip debug function, which is provided for development and evaluation. Do not use the on-chip debug function in products designated for mass production, because the guaranteed number of rewritable times of the flash memory may be exceeded when this function is used, and product reliability therefore cannot be guaranteed. Renesas Electronics is not liable for problems occurring when the on-chip debug function is used.

**Caution 2.** The pins mounted depend on the product. Refer to *2.1 Port Function*, for the port functions, and *2.2.1 Functions for each product*, for the other functions, in the *RL78/G15 User's Manual*.

★

## 2.1 Absolute Maximum Ratings

[ $T_A = 25^\circ\text{C}$ ]

| Item                          | Symbol    | Condition         |                                        | Rating                                   | Unit             |
|-------------------------------|-----------|-------------------|----------------------------------------|------------------------------------------|------------------|
| Supply voltage                | $V_{DD}$  |                   |                                        | -0.5 to +6.5                             | V                |
| Input voltage                 | $V_{I1}$  |                   |                                        | -0.3 to $V_{DD} + 0.3$ <sup>Note 1</sup> | V                |
| Output voltage                | $V_{O1}$  |                   |                                        | -0.3 to $V_{DD} + 0.3$                   | V                |
| Output current, high          | $I_{OH1}$ | Per pin           |                                        | -40                                      | mA               |
|                               |           | Total of all pins | P20 to P23, P40, P41, P121, P122, P125 | -70                                      | mA               |
|                               |           | -170mA            | P00 to P07                             | -100                                     | mA               |
| Output current, low           | $I_{OL1}$ | Per pin           |                                        | 40                                       | mA               |
|                               |           | Total of all pins | P20 to P23, P40, P41, P121, P122, P125 | 100                                      | mA               |
|                               |           | 170mA             | P00 to P07                             | 100                                      | mA               |
| Operating ambient temperature | $T_A$     |                   |                                        | -40 to +85                               | $^\circ\text{C}$ |
| Storage temperature           | $T_{stg}$ |                   |                                        | -65 to +150                              | $^\circ\text{C}$ |

Note 1. This must be no greater than 6.5 V.

**Caution** Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any item. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

**Remark 1.** The characteristics of functions multiplexed on a given pin are the same as those for the port pin unless otherwise specified.

**Remark 2.** The reference voltage is  $V_{SS}$ .

## 2.2 Oscillator Characteristics

### 2.2.1 X1 oscillator characteristics

[ $T_A = -40$  to  $+85^\circ\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                                                  | Resonator                               | Condition                                    | MIN. | TYP. | MAX. | Unit |
|-------------------------------------------------------|-----------------------------------------|----------------------------------------------|------|------|------|------|
| X1 clock oscillation frequency (fx) <sup>Note 1</sup> | Ceramic resonator/<br>crystal resonator | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 1    |      | 12   | MHz  |

Note 1. Indicates only permissible oscillator frequency ranges. Refer to **2.4 AC Characteristics** for instruction execution time. For actual applications, request evaluation by the manufacturer of the oscillator circuit mounted on a board so you can use appropriate values.

**Caution** Since the CPU is started by the high-speed on-chip oscillator clock after release from the reset state, the user should use the oscillation stabilization time counter status register (OSTC) to check the X1 clock oscillation stabilization time. Specify the values for the oscillation stabilization time in the OSTC register and the oscillation stabilization time select register (OSTS) after having sufficiently evaluated the oscillation stabilization time with the resonator to be used.

**Remark** When using the X1 oscillator, refer to 5.4 System Clock Oscillator in the RL78/G15 User's Manual.

### 2.2.2 On-chip oscillator characteristics

[ $T_A = -40$  to  $+85^\circ\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                                                                    | Symbol   | Condition                          | MIN. | TYP. | MAX. | Unit |
|-------------------------------------------------------------------------|----------|------------------------------------|------|------|------|------|
| High-speed on-chip oscillator clock frequency <sup>Note 1, Note 2</sup> | $f_{IH}$ |                                    | 1    |      | 16   | MHz  |
| High-speed on-chip oscillator clock frequency accuracy                  |          | $T_A = -40$ to $+85^\circ\text{C}$ | -2.0 |      | +2.0 | %    |
| Low-speed on-chip oscillator clock frequency                            | $f_{IL}$ |                                    |      | 15   |      | kHz  |
| Low-speed on-chip oscillator clock frequency accuracy                   |          |                                    | -15  |      | +15  | %    |

Note 1. The high-speed on-chip oscillator frequency is selected by bits 0 to 2 of option byte (00C2H).

Note 2. The listed values only indicate the characteristics of the oscillators. Refer to **2.4 AC Characteristics** for instruction execution time.



## 2.3 DC Characteristics

### 2.3.1 Pin characteristics

[T<sub>A</sub> = -40 to +85°C, 2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V]

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| Item                           | Symbol           | Condition                                                                               | MIN.                            | TYP. | MAX.                    | Unit |
|--------------------------------|------------------|-----------------------------------------------------------------------------------------|---------------------------------|------|-------------------------|------|
| Output current, high<br>Note 1 | I <sub>OH1</sub> | Per pin for P00 to P07, P20 to P23, P40, P41, P121, P122, P125                          |                                 |      | -10.0 <sup>Note 2</sup> | mA   |
|                                |                  | Total of P20 to P23, P40, P41, P121, P122, P125<br>(when duty ≤ 70% <sup>Note 3</sup> ) | 4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V |      | -65.0                   | mA   |
|                                |                  |                                                                                         | 2.7 V ≤ V <sub>DD</sub> < 4.0 V |      | -14.0                   | mA   |
|                                |                  |                                                                                         | 2.4 V ≤ V <sub>DD</sub> < 2.7 V |      | -10.5                   | mA   |
|                                |                  | Total of P00 to P07<br>(when duty ≤ 70% <sup>Note 3</sup> )                             | 4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V |      | -65.0                   | mA   |
|                                |                  |                                                                                         | 2.7 V ≤ V <sub>DD</sub> < 4.0 V |      | -12.0                   | mA   |
|                                |                  |                                                                                         | 2.4 V ≤ V <sub>DD</sub> < 2.7 V |      | -9.0                    | mA   |
|                                |                  | Total of all pins (when duty ≤ 70% <sup>Note 3</sup> )                                  |                                 |      | -105.0                  | mA   |
| Output current, low<br>Note 4  | I <sub>OL1</sub> | Per pin for P00 to P07, P20 to P23, P40, P41, P121, P122, P125                          |                                 |      | 20.0 <sup>Note 2</sup>  | mA   |
|                                |                  | Total of P20 to P23, P40, P41, P121, P122, P125<br>(when duty ≤ 70% <sup>Note 3</sup> ) | 4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V |      | 85.0                    | mA   |
|                                |                  |                                                                                         | 2.7 V ≤ V <sub>DD</sub> < 4.0 V |      | 21.0                    | mA   |
|                                |                  |                                                                                         | 2.4 V ≤ V <sub>DD</sub> < 2.7 V |      | 4.2                     | mA   |
|                                |                  | Total of P00 to P07<br>(when duty ≤ 70% <sup>Note 3</sup> )                             | 4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V |      | 85.0                    | mA   |
|                                |                  |                                                                                         | 2.7 V ≤ V <sub>DD</sub> < 4.0 V |      | 18.0                    | mA   |
|                                |                  |                                                                                         | 2.4 V ≤ V <sub>DD</sub> < 2.7 V |      | 3.6                     | mA   |
|                                |                  | Total of all pins (when duty ≤ 70% <sup>Note 3</sup> )                                  |                                 |      | 145.0                   | mA   |

Note 1. Device operation is guaranteed at the listed currents even if current is flowing from the V<sub>DD</sub> pin to an output pin.

Note 2. The value for maximum total current must not be exceeded.

Note 3. The listed currents apply when the duty cycle is no greater than 70%. Use the following formula to calculate the output current when the duty cycle is greater than 70%, where n is the duty cycle.

- Total output current from the listed pins = (I<sub>OH</sub> × 0.7)/(n × 0.01)  
Example when n = 80% and I<sub>OH</sub> = -10.0 mA  
Total output current from the listed pins = (-10.0 × 0.7)/(80 × 0.01) ≅ -8.7 mA
- Total output current from the listed pins = (I<sub>OL</sub> × 0.7)/(n × 0.01)  
Example when n = 80% and I<sub>OL</sub> = 10.0 mA  
Total output current from the listed pins = (10.0 × 0.7)/(80 × 0.01) ≅ 8.7 mA

Note that the duty cycle has no effect on the current that is allowed to flow into a single pin. A current higher than the absolute maximum rating must not flow into a single pin.

Note 4. Device operation is guaranteed at the listed currents even if current is flowing from an output pin to the V<sub>SS</sub> pin.

**Caution** P00, P01, P03 to P07, P22, and P41 do not output high level in N-ch open-drain mode.

**Remark** The characteristics of functions multiplexed on a given pin are the same as those for the port pin unless otherwise specified.

[T<sub>A</sub> = -40 to +85°C, 2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V]

(2/2)

| Item                           | Symbol            | Condition                                                                        |                                       | MIN.                  | TYP. | MAX.                | Unit |
|--------------------------------|-------------------|----------------------------------------------------------------------------------|---------------------------------------|-----------------------|------|---------------------|------|
| Input voltage, high            | V <sub>IH1</sub>  |                                                                                  |                                       | 0.8 V <sub>DD</sub>   |      | V <sub>DD</sub>     | V    |
| Input voltage, low             | V <sub>IL1</sub>  |                                                                                  |                                       | 0                     |      | 0.2 V <sub>DD</sub> | V    |
| Output voltage, high<br>Note 1 | V <sub>OH1</sub>  | 4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V                                                  | I <sub>OH</sub> = -10 mA              | V <sub>DD</sub> - 1.5 |      |                     | V    |
|                                |                   |                                                                                  | I <sub>OH</sub> = -3.0 mA             | V <sub>DD</sub> - 0.7 |      |                     | V    |
|                                |                   | 2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V                                                  | I <sub>OH</sub> = -2.0 mA             | V <sub>DD</sub> - 0.6 |      |                     | V    |
|                                |                   | 2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V                                                  | I <sub>OH</sub> = -1.5 mA             | V <sub>DD</sub> - 0.5 |      |                     | V    |
| Output voltage, low<br>Note 2  | V <sub>OL1</sub>  | 4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V                                                  | I <sub>OL</sub> = 20 mA               |                       |      | 1.3                 | V    |
|                                |                   |                                                                                  | I <sub>OL</sub> = 8.5 mA              |                       |      | 0.7                 | V    |
|                                |                   | 2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V                                                  | I <sub>OL</sub> = 3.0 mA              |                       |      | 0.6                 | V    |
|                                |                   |                                                                                  | I <sub>OL</sub> = 1.5 mA              |                       |      | 0.4                 | V    |
| Input leakage current, high    | I <sub>LIH1</sub> | P00 to P07, P20 to P23, P40, P41, P125, P137<br>V <sub>I</sub> = V <sub>DD</sub> |                                       |                       |      | 1                   | μA   |
|                                |                   | P121, P122 (X1, X2, EXCLK)<br>V <sub>I</sub> = V <sub>DD</sub>                   | In input port or external clock input |                       |      | 1                   | μA   |
|                                | I <sub>LIH2</sub> |                                                                                  | In resonator connection               |                       |      | 10                  | μA   |
| Input leakage current, low     | I <sub>LIL1</sub> | P00 to P07, P20 to P23, P40, P41, P125, P137<br>V <sub>I</sub> = V <sub>SS</sub> |                                       |                       |      | -1                  | μA   |
|                                | I <sub>LIL2</sub> | P121, P122 (X1, X2, EXCLK)<br>V <sub>I</sub> = V <sub>SS</sub>                   | In input port or external clock input |                       |      | -1                  | μA   |
|                                |                   |                                                                                  | In resonator connection               |                       |      | -10                 | μA   |
| On-chip pull-up resistance     | R <sub>U</sub>    | V <sub>I</sub> = V <sub>SS</sub>                                                 |                                       | 10                    | 20   | 100                 | kΩ   |

Note 1. The value under the condition which satisfies the high-level output current (I<sub>OH1</sub>).

Note 2. The value under the condition which satisfies the low-level output current (I<sub>OL1</sub>).

**Caution** The maximum value of V<sub>IH</sub> of P00, P01, P03 to P07, P22, and P41 is V<sub>DD</sub> even in N-ch open-drain mode. These pins do not output high level in N-ch open-drain mode.

**Remark** The characteristics of functions multiplexed on a given pin are the same as those for the port pin unless otherwise specified.

### 2.3.2 Supply current characteristics

[T<sub>A</sub> = -40 to +85°C, 2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V]

| Item                             | Symbol                             | Condition      |                  |                                                    |                                                        | MIN. | TYP. | MAX. | Unit |
|----------------------------------|------------------------------------|----------------|------------------|----------------------------------------------------|--------------------------------------------------------|------|------|------|------|
| Supply current <sup>Note 1</sup> | I <sub>DD1</sub>                   | Operating mode | Basic operation  | f <sub>IH</sub> = 16 MHz <sup>Note 4</sup>         | V <sub>DD</sub> = 3.0 V, 5.0 V                         |      | 0.87 |      | mA   |
|                                  |                                    |                | Normal operation | f <sub>IH</sub> = 16 MHz <sup>Note 4</sup>         | V <sub>DD</sub> = 3.0 V, 5.0 V                         |      | 1.86 | 2.47 | mA   |
|                                  |                                    |                |                  | f <sub>IH</sub> = 4 MHz <sup>Note 4</sup>          | V <sub>DD</sub> = 3.0 V, 5.0 V                         |      | 1.17 | 1.64 | mA   |
|                                  |                                    |                |                  | f <sub>EX</sub> = 16 MHz <sup>Note 5, Note 6</sup> | Square wave input<br>V <sub>DD</sub> = 3.0 V, 5.0 V    |      | 1.69 | 2.30 | mA   |
|                                  |                                    |                |                  | f <sub>X</sub> = 12 MHz <sup>Note 5, Note 6</sup>  | Resonator connection<br>V <sub>DD</sub> = 3.0 V, 5.0 V |      | 1.57 | 2.30 | mA   |
|                                  |                                    |                |                  | f <sub>MX</sub> = 4 MHz <sup>Note 5, Note 6</sup>  | Square wave input<br>V <sub>DD</sub> = 3.0 V, 5.0 V    |      | 1.00 | 1.46 | mA   |
|                                  |                                    |                |                  |                                                    | Resonator connection<br>V <sub>DD</sub> = 3.0 V, 5.0 V |      | 1.05 | 1.53 | mA   |
|                                  |                                    |                |                  |                                                    |                                                        |      |      |      |      |
|                                  | I <sub>DD2</sub> <sup>Note 2</sup> | HALT mode      |                  | f <sub>IH</sub> = 16 MHz <sup>Note 4</sup>         | V <sub>DD</sub> = 3.0 V, 5.0 V                         |      | 371  | 800  | μA   |
|                                  |                                    |                |                  | f <sub>IH</sub> = 4 MHz <sup>Note 4</sup>          | V <sub>DD</sub> = 3.0 V, 5.0 V                         |      | 334  | 630  | μA   |
|                                  |                                    |                |                  | f <sub>EX</sub> = 16 MHz <sup>Note 5, Note 6</sup> | Square wave input<br>V <sub>DD</sub> = 3.0 V, 5.0 V    |      | 207  | 636  | μA   |
|                                  |                                    |                |                  | f <sub>X</sub> = 12 MHz <sup>Note 5, Note 6</sup>  | Resonator connection<br>V <sub>DD</sub> = 3.0 V, 5.0 V |      | 309  | 894  | μA   |
|                                  |                                    |                |                  | f <sub>MX</sub> = 4 MHz <sup>Note 5, Note 6</sup>  | Square wave input<br>V <sub>DD</sub> = 3.0 V, 5.0 V    |      | 156  | 452  | μA   |
|                                  |                                    |                |                  |                                                    | Resonator connection<br>V <sub>DD</sub> = 3.0 V, 5.0 V |      | 207  | 599  | μA   |
|                                  | I <sub>DD3</sub> <sup>Note 3</sup> | STOP mode      |                  | V <sub>DD</sub> = 3.0 V                            |                                                        |      | 0.62 | 2.25 | μA   |



Note 1. The listed currents are the total currents flowing into V<sub>DD</sub>, including the input leakage currents flowing when the level of the input pin is fixed to V<sub>DD</sub> or V<sub>SS</sub>.  
Regarding the values for main system clock operation, the TYP. value does not include the peripheral operating current. The MAX. value includes the peripheral operating current, but does not include those flowing into the A/D converter, comparator, I/O port, and on-chip pull-up/pull-down resistors.  
Regarding the values for subsystem clock operation, the TYP. and MAX. values do not include the peripheral operating current. However, in HALT mode, the current flowing into the RTC is included.  
Regarding the values in STOP mode, the TYP. and MAX. values do not include the peripheral operating current.

Note 2. When the HALT instruction is executed from the flash memory.

Note 3. The listed currents do not include the current flowing into the 12-bit interval timer and watchdog timer.

Note 4. When the high-speed subsystem clock is stopped.

Note 5. When the high-speed on-chip oscillator is stopped.

Note 6. 16-pin and 20-pin products only.

**Remark 1.** f<sub>IH</sub>: High-speed on-chip oscillator clock frequency

**Remark 2.** f<sub>MX</sub>: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)

**Remark 3.** The temperature condition of the TYP. value is T<sub>A</sub> = 25°C.

## Peripheral Functions

[ $T_A = -40$  to  $+85^\circ\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                                           | Symbol                                       | Condition                      | MIN. | TYP. | MAX.  | Unit          |
|------------------------------------------------|----------------------------------------------|--------------------------------|------|------|-------|---------------|
| Low-speed on-chip oscillator operating current | $I_{FIL}$ <sup>Note 1</sup>                  |                                |      | 0.30 |       | $\mu\text{A}$ |
| 12-bit interval timer operating current        | $I_{TMKA}$ <sup>Note 1, Note 2, Note 3</sup> |                                |      | 0.02 |       | $\mu\text{A}$ |
| Watchdog timer operating current               | $I_{WDT}$ <sup>Note 1, Note 4</sup>          |                                |      | 0.02 |       | $\mu\text{A}$ |
| A/D converter operating current                | $I_{ADC}$ <sup>Note 1, Note 5</sup>          | In conversion at maximum speed |      |      |       |               |
|                                                |                                              | $V_{DD} = 5.0\text{ V}$        |      | 1.30 | 1.90  | $\text{mA}$   |
|                                                |                                              | $V_{DD} = 3.0\text{ V}$        |      | 0.50 |       | $\text{mA}$   |
| Comparator operating current                   | $I_{CMP}$ <sup>Note 1, Note 6</sup>          | In high-speed mode             |      | 6.50 |       | $\mu\text{A}$ |
|                                                |                                              | In low-speed mode              |      | 1.70 |       | $\mu\text{A}$ |
| Internal reference voltage operating current   | $I_{VREG}$ <sup>Note 1</sup>                 |                                |      | 10   |       | $\mu\text{A}$ |
| Self-programming operating current             | $I_{FSP}$ <sup>Note 1, Note 7</sup>          |                                |      | 2.0  | 12.20 | $\text{mA}$   |

Note 1. The current flowing into  $V_{DD}$ .

Note 2. When the high-speed on-chip oscillator and high-speed system clock are stopped.

Note 3. This current only flows into the 12-bit interval timer. It does not include the operating current of the low-speed on-chip oscillator. The supply current of the RL78 microcontrollers is the sum of  $I_{DD1}$ ,  $I_{DD2}$  or  $I_{DD3}$  and  $I_{FIL}$  and  $I_{TMKA}$  when the 12-bit interval timer is in operation.Note 4. This current only flows into the watchdog timer. It does not include the operating current of the low-speed on-chip oscillator. The supply current of the RL78 microcontrollers is the sum of  $I_{DD1}$ ,  $I_{DD2}$  or  $I_{DD3}$  and  $I_{FIL}$  and  $I_{WDT}$  when the watchdog timer is in operation.Note 5. This current only flows into the A/D converter. The supply current of the RL78 microcontrollers is the sum of  $I_{DD1}$  or  $I_{DD2}$  and  $I_{ADC}$  when the A/D converter is operating or in the HALT mode.Note 6. This current only flows into a single comparator. The supply current of the RL78 microcontrollers is the sum of  $I_{DD1}$ ,  $I_{DD2}$  or  $I_{DD3}$  and  $I_{CMP}$  when the comparator is in operation.

Note 7. This current only flows during self-programming.

**Remark** The temperature condition of the TYP. value is  $T_A = 25^\circ\text{C}$ .

## 2.4 AC Characteristics

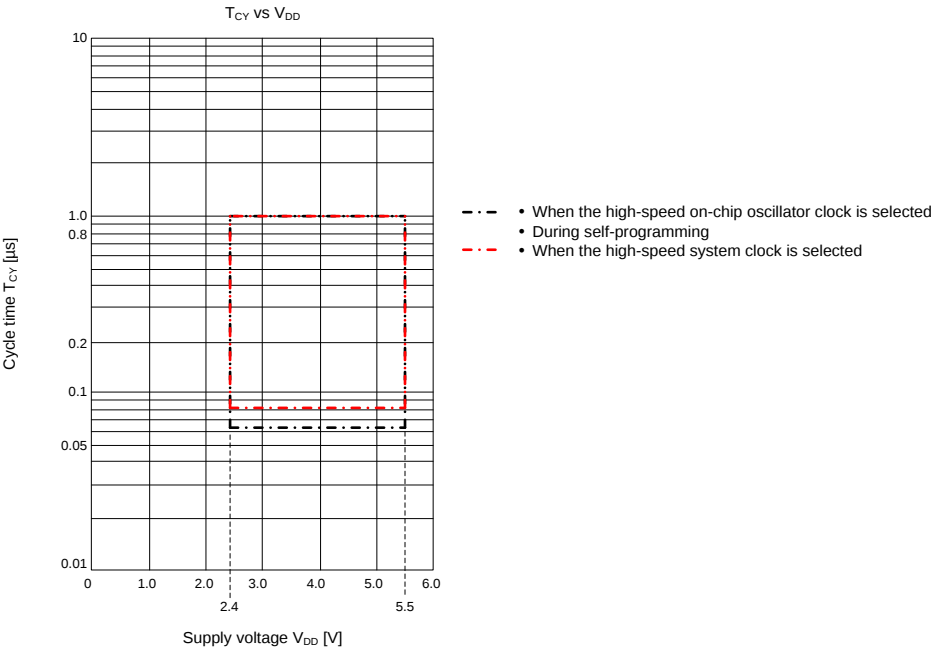
[ $T_A = -40$  to  $+85^\circ\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                                                          | Symbol             | Condition                                                         |                                              | MIN.                 | TYP.   | MAX. | Unit          |
|---------------------------------------------------------------|--------------------|-------------------------------------------------------------------|----------------------------------------------|----------------------|--------|------|---------------|
| Instruction cycle (minimum instruction execution time)        | $T_{CY}$           | When high-speed on-chip oscillator clock ( $f_{IH}$ ) is selected | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 0.0625               |        | 1.0  | $\mu\text{s}$ |
|                                                               |                    | When high-speed system clock ( $f_{MX}$ ) is selected             | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | Square wave input    | 0.0625 | 1.0  | $\mu\text{s}$ |
|                                                               |                    |                                                                   |                                              | Resonator connection | 0.0833 | 1.0  | $\mu\text{s}$ |
|                                                               |                    | In the self-programming mode                                      | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 0.0625               |        | 1.0  | $\mu\text{s}$ |
| External system clock frequency                               | $f_{EX}$           | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                      |                                              | 1.0                  |        | 16   | MHz           |
| External system clock input high-level width, low-level width | $t_{EXH}, t_{EXL}$ | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                      |                                              | 30                   |        |      | ns            |
| Ti00 to Ti07 input high-level width, low-level width          | $t_{TIH}, t_{TIL}$ | Noise filter is not used                                          |                                              | $1/f_{MCK} + 10$     |        |      | ns            |
| TO00 to TO07 output frequency                                 | $f_{TO}$           | $4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                      |                                              |                      |        | 8    | MHz           |
|                                                               |                    | $2.7\text{ V} \leq V_{DD} < 4.0\text{ V}$                         |                                              |                      |        | 5    | MHz           |
|                                                               |                    | $2.4\text{ V} \leq V_{DD} < 2.7\text{ V}$                         |                                              |                      |        | 4    | MHz           |
| PCLBUZ0 output frequency                                      | $f_{PCL}$          | $4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                      |                                              |                      |        | 10   | MHz           |
|                                                               |                    | $2.7\text{ V} \leq V_{DD} < 4.0\text{ V}$                         |                                              |                      |        | 5    | MHz           |
|                                                               |                    | $2.4\text{ V} \leq V_{DD} < 2.7\text{ V}$                         |                                              |                      |        | 4    | MHz           |
| RESET low-level width                                         | $t_{RSL}$          |                                                                   |                                              | 10                   |        |      | $\mu\text{s}$ |

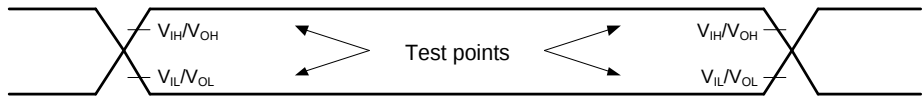
**Remark**  $f_{MCK}$ : Timer array unit operating clock frequency

(Operation clock to be set by timer clock select register 0 (TPS0) and the CKS0n1 bit of timer mode register 0n (TMR0n). n: Channel number (n = 0 to 7).)

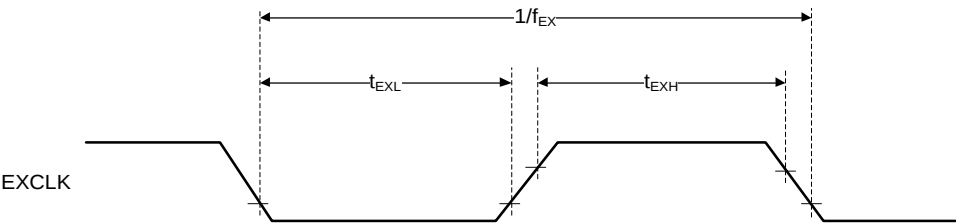
Minimum Instruction Execution Time during Main System Clock Operation

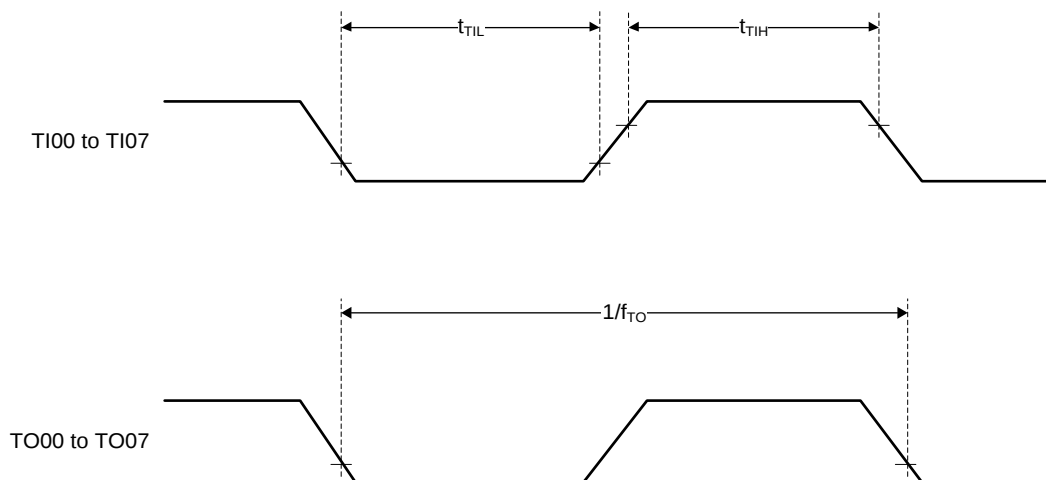
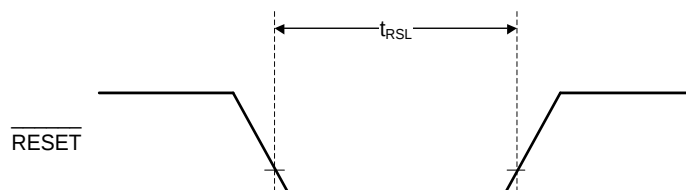


At AC Timing



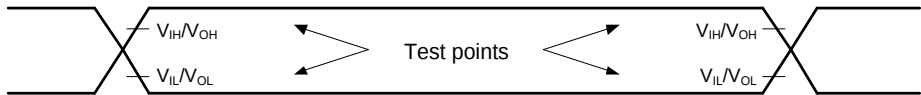
External System Clock Timing



**TI/TO Timing** **$\overline{\text{RESET}}$  Input Timing**

2.5 Serial Interface Characteristics

AC Timing Test Points



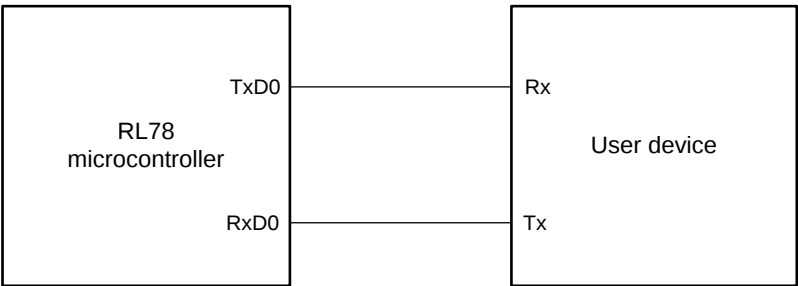
2.5.1 Serial array unit

(1) UART mode

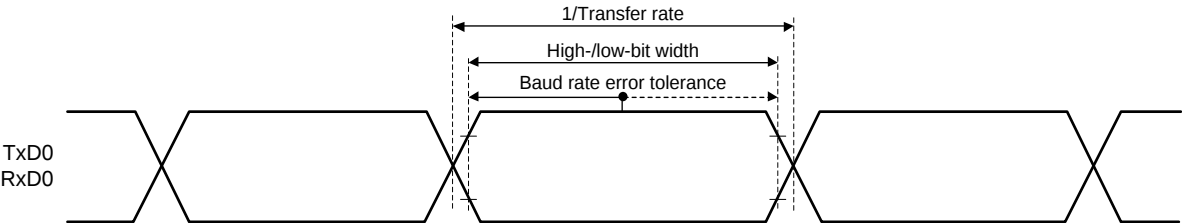
[T<sub>A</sub> = -40 to +85°C, 2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V]

| Item          | Symbol | Condition                                                                                      | MIN. | TYP. | MAX.                | Unit |
|---------------|--------|------------------------------------------------------------------------------------------------|------|------|---------------------|------|
| Transfer rate |        |                                                                                                |      |      | f <sub>MCK</sub> /6 | bps  |
|               |        | Theoretical value of the maximum transfer rate<br>f <sub>CLK</sub> = f <sub>MCK</sub> = 16 MHz |      |      | 2.6                 | Mbps |

UART mode connection diagram



UART mode bit width (reference)



**Remark** f<sub>MCK</sub>: Serial array unit operation clock frequency  
(Operation clock to be set by serial clock select register 0 (SPS0) and the CKSn bit of serial mode register 0n (SMR0n). n: Channel number (n = 0, 1))

**(2) Simplified SPI (CSI) mode (master mode, SCKp... internal clock output)****[ $T_A = -40$  to  $+85^\circ\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]**

| Item                                                              | Symbol             | Condition                                                              | MIN.              | TYP. | MAX. | Unit |
|-------------------------------------------------------------------|--------------------|------------------------------------------------------------------------|-------------------|------|------|------|
| SCKp cycle time                                                   | $t_{KCY1}$         | $t_{KCY1} \geq 4/f_{CLK}$ $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 250               |      |      | ns   |
| SCKp high-/low-level width                                        | $t_{KH1}, t_{KL1}$ | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                           | $t_{KCY1}/2 - 18$ |      |      | ns   |
|                                                                   |                    | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                           | $t_{KCY1}/2 - 38$ |      |      | ns   |
| Slp setup time<br>(to SCKp $\uparrow$ ) <sup>Note 1</sup>         | $t_{SIK1}$         | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                           | 47                |      |      | ns   |
|                                                                   |                    | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                           | 75                |      |      | ns   |
| Slp hold time<br>(from SCKp $\uparrow$ ) <sup>Note 1</sup>        | $t_{KSI1}$         |                                                                        | 19                |      |      | ns   |
| Delay time from SCKp $\downarrow$ to SOP output <sup>Note 2</sup> | $t_{KSO1}$         | $C = 30\text{ pF}$ <sup>Note 3</sup>                                   |                   |      | 25   | ns   |

Note 1. When DAP0n = 0 and CKP0n = 0, or DAP0n = 1 and CKP0n = 1. The Slp setup time becomes “to SCKp  $\downarrow$ ” and the Slp hold time becomes “from SCKp  $\downarrow$ ” when DAP0n = 0 and CKP0n = 1, or DAP0n = 1 and CKP0n = 0.

Note 2. When DAP0n = 0 and CKP0n = 0, or DAP0n = 1 and CKP0n = 1. The delay time to SOP output becomes “from SCKp  $\downarrow$ ” when DAP0n = 0 and CKP0n = 1, or DAP0n = 1 and CKP0n = 0.

Note 3. C is the load capacitance of the SCKp and SOP output lines.

**(3) Simplified SPI (CSI) mode (slave mode, SCKp... external clock input)****[ $T_A = -40$  to  $+85^\circ\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]**

| Item                                                              | Symbol             | Condition                                                                         | MIN.                     | TYP. | MAX.             | Unit |
|-------------------------------------------------------------------|--------------------|-----------------------------------------------------------------------------------|--------------------------|------|------------------|------|
| SCKp cycle time                                                   | $t_{KCY2}$         | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                                      | $6/f_{MCK}$              |      |                  | ns   |
|                                                                   |                    | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                                      | $6/f_{MCK}$ and also 500 |      |                  | ns   |
| SCKp high-/low-level width                                        | $t_{KH2}, t_{KL2}$ | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                                      | $t_{KCY2}/2 - 18$        |      |                  | ns   |
| Slp setup time<br>(to SCKp $\uparrow$ ) <sup>Note 1</sup>         | $t_{SIK2}$         | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                                      | $1/f_{MCK} + 20$         |      |                  | ns   |
|                                                                   |                    | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                                      | $1/f_{MCK} + 30$         |      |                  | ns   |
| Slp hold time<br>(from SCKp $\uparrow$ ) <sup>Note 1</sup>        | $t_{KSI2}$         | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                                      | $1/f_{MCK} + 31$         |      |                  | ns   |
| Delay time from SCKp $\downarrow$ to SOP output <sup>Note 2</sup> | $t_{KSO2}$         | $C = 30\text{ pF}$ <sup>Note 3</sup> $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ |                          |      | $2/f_{MCK} + 50$ | ns   |
|                                                                   |                    | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                                      |                          |      | $2/f_{MCK} + 75$ | ns   |

Note 1. When DAP0n = 0 and CKP0n = 0, or DAP0n = 1 and CKP0n = 1. The Slp setup time becomes “to SCKp  $\downarrow$ ” and the Slp hold time becomes “from SCKp  $\downarrow$ ” when DAP0n = 0 and CKP0n = 1, or DAP0n = 1 and CKP0n = 0.

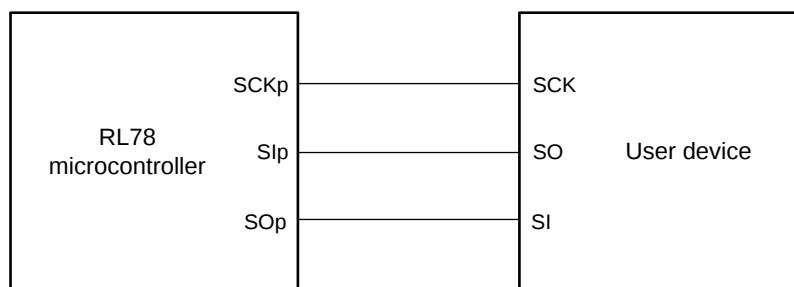
Note 2. When DAP0n = 0 and CKP0n = 0, or DAP0n = 1 and CKP0n = 1. The delay time to SOP output becomes “from SCKp  $\downarrow$ ” when DAP0n = 0 and CKP0n = 1, or DAP0n = 1 and CKP0n = 0.

Note 3. C is the load capacitance of the SOP output lines.

**Remark 1.** p: CSI number (p = 00, 01), n: Channel number (n = 0, 1)

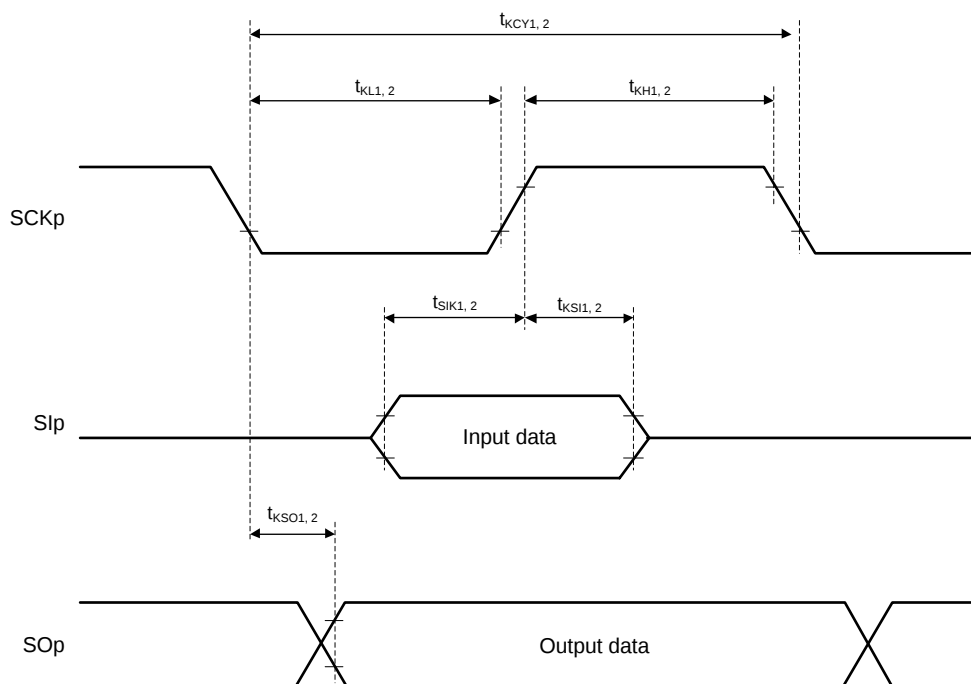
**Remark 2.**  $f_{\text{MCK}}$ : Serial array unit operation clock frequency  
(Operation clock to be set by serial clock select register 0 (SPS0) and the CKS0n bit of serial mode register 0n (SMR0n). n: Channel number (n = 0, 1))

Simplified SPI (CSI) mode connection diagram



Simplified SPI (CSI) mode serial transfer timing

(When DAP0n = 0 and CKP0n = 0, or DAP0n = 1 and CKP0n = 1)



**Remark** p: CSI number (p = 00, 01), n: Channel number (n = 0, 1)

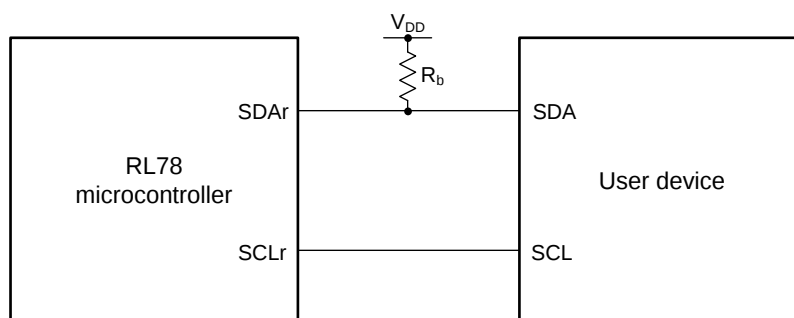
**(4) Simplified I<sup>2</sup>C mode****[ $T_A = -40$  to  $+85^\circ\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]**

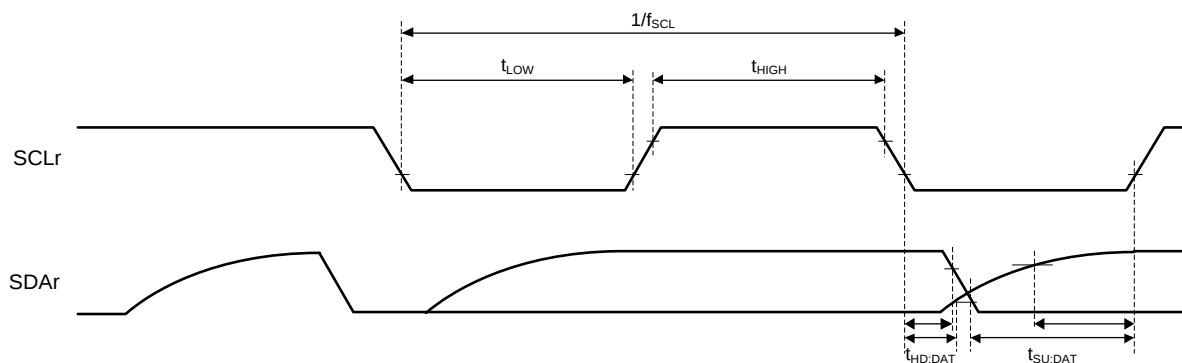
| Item                          | Symbol              | Condition                                        | MIN.                                       | MAX.                  | Unit |
|-------------------------------|---------------------|--------------------------------------------------|--------------------------------------------|-----------------------|------|
| SCLr clock frequency          | $f_{\text{SCL}}$    | $C_b = 100\text{ pF}$ , $R_b = 3\text{ k}\Omega$ |                                            | 400 <sup>Note 1</sup> | kHz  |
| Hold time when SCLr = "L"     | $t_{\text{LOW}}$    | $C_b = 100\text{ pF}$ , $R_b = 3\text{ k}\Omega$ | 1150                                       |                       | ns   |
| Hold time when SCLr = "H"     | $t_{\text{HIGH}}$   | $C_b = 100\text{ pF}$ , $R_b = 3\text{ k}\Omega$ | 1150                                       |                       | ns   |
| Data setup time (reception)   | $t_{\text{SU:DAT}}$ | $C_b = 100\text{ pF}$ , $R_b = 3\text{ k}\Omega$ | $1/f_{\text{MCK}} + 145$ <sup>Note 2</sup> |                       | ns   |
| Data hold time (transmission) | $t_{\text{HD:DAT}}$ | $C_b = 100\text{ pF}$ , $R_b = 3\text{ k}\Omega$ | 0                                          | 355                   | ns   |

Note 1. The value must also be no greater than  $f_{\text{MCK}}/4$ .

Note 2. Set  $f_{\text{MCK}}$  so that it will not exceed the hold time when SCLr = "L" or SCLr = "H".

**Caution** Select the N-ch open drain output ( $V_{DD}$  tolerance) mode for the SDAr pin by using port output mode register 0, 2, or 4 (POM0, 2, or 4).

Simplified I<sup>2</sup>C mode connection diagram

Simplified I<sup>2</sup>C mode serial transfer timing

- Remark 1.**  $R_b[\Omega]$ : Communication line (SDAr) pull-up resistance,  $C_b[F]$ : Communication line (SCLr, SDAr) load capacitance
- Remark 2.** r: IIC number (r = 00, 01)
- Remark 3.**  $f_{MCK}$ : Serial array unit operation clock frequency  
(Operation clock to be set by serial clock select register 0 (SPS0) and the CKS0n bit of serial mode register 0n (SMR0n). n: Channel number (n = 0, 1))

## 2.5.2 Serial interface IICA

[ $T_A = -40$  to  $+85^\circ\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                                            | Symbol              | Condition                                            | Standard Mode |      | Fast Mode |      | Unit          |
|-------------------------------------------------|---------------------|------------------------------------------------------|---------------|------|-----------|------|---------------|
|                                                 |                     |                                                      | MIN.          | MAX. | MIN.      | MAX. |               |
| SCLA0 clock frequency                           | $f_{\text{SCL}}$    | Fast mode:<br>$f_{\text{CLK}} \geq 3.5\text{ MHz}$   |               |      | 0         | 400  | kHz           |
|                                                 |                     | Standard mode:<br>$f_{\text{CLK}} \geq 1\text{ MHz}$ | 0             | 100  |           |      | kHz           |
| Setup time of restart condition                 | $t_{\text{SU:STA}}$ |                                                      | 4.7           |      | 0.6       |      | $\mu\text{s}$ |
| Hold time <sup>Note 1</sup>                     | $t_{\text{HD:STA}}$ |                                                      | 4.0           |      | 0.6       |      | $\mu\text{s}$ |
| Hold time when SCLA0 = "L"                      | $t_{\text{LOW}}$    |                                                      | 4.7           |      | 1.3       |      | $\mu\text{s}$ |
| Hold time when SCLA0 = "H"                      | $t_{\text{HIGH}}$   |                                                      | 4.0           |      | 0.6       |      | $\mu\text{s}$ |
| Data setup time (reception)                     | $t_{\text{SU:DAT}}$ |                                                      | 250           |      | 100       |      | ns            |
| Data hold time (transmission) <sup>Note 2</sup> | $t_{\text{HD:DAT}}$ |                                                      | 0             | 3.45 | 0         | 0.9  | $\mu\text{s}$ |
| Setup time of stop condition                    | $t_{\text{SU:STO}}$ |                                                      | 4.0           |      | 0.6       |      | $\mu\text{s}$ |
| Bus-free time                                   | $t_{\text{BUF}}$    |                                                      | 4.7           |      | 1.3       |      | $\mu\text{s}$ |

Note 1. The first clock pulse is generated after this period when the start or restart condition is detected.

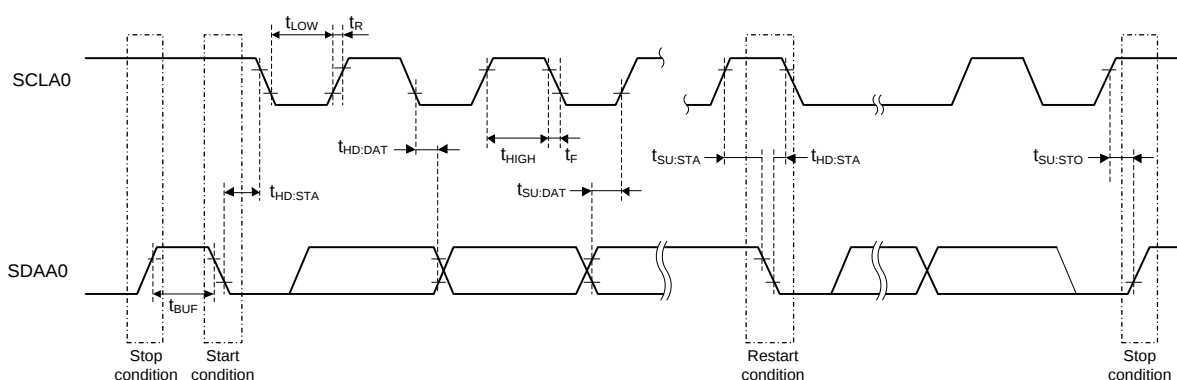
Note 2. The maximum value (MAX.) of  $t_{\text{HD:DAT}}$  applies to normal transfer and a wait is inserted at the ACK (acknowledge) timing.

**Remark** The maximum value of  $C_b$  (communication line capacitance) and the value of  $R_b$  (communication line pull-up resistance) at that time in each mode are as follows.

Standard mode:  $C_b = 400\text{ pF}$ ,  $R_b = 2.7\text{ k}\Omega$

Fast mode:  $C_b = 200\text{ pF}$ ,  $R_b = 1.7\text{ k}\Omega$

IICA serial transfer timing



## 2.6 Analog Characteristics

### 2.6.1 A/D converter characteristics

Targets: ANI0 to ANI10, internal reference voltage

[T<sub>A</sub> = -40 to +85°C, 2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V]

| Item                                                           | Symbol            | Condition                                                                 |                                                   | MIN. | TYP. | MAX.            | Unit |
|----------------------------------------------------------------|-------------------|---------------------------------------------------------------------------|---------------------------------------------------|------|------|-----------------|------|
| Resolution                                                     | RES               |                                                                           |                                                   | 8    |      | 10              | bit  |
| Overall error <sup>Note 1, Note 2, Note 3</sup>                | AINL              | 10-bit resolution                                                         | V <sub>DD</sub> = 5 V                             |      | ±1.7 | ±3.1            | LSB  |
|                                                                |                   |                                                                           | V <sub>DD</sub> = 3 V                             |      | ±2.3 | ±4.5            | LSB  |
| Conversion time                                                | t <sub>CONV</sub> | 10-bit resolution                                                         | 2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V                   | 4.25 |      | 17              | μs   |
|                                                                |                   | Targets: ANI0 to ANI10                                                    | 2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V <sup>Note 5</sup> | 5.75 |      | 23              | μs   |
|                                                                |                   | 10-bit resolution<br>Target: Internal reference voltage <sup>Note 6</sup> | 2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V                   | 5.75 |      | 23              | μs   |
| Zero-scale error <sup>Note 1, Note 2, Note 3, Note 4</sup>     | E <sub>ZS</sub>   | 10-bit resolution                                                         | V <sub>DD</sub> = 5 V                             |      |      | ±0.19           | %FSR |
|                                                                |                   |                                                                           | V <sub>DD</sub> = 3 V                             |      |      | ±0.39           | %FSR |
| Full-scale error <sup>Note 1, Note 2, Note 3, Note 4</sup>     | E <sub>FS</sub>   | 10-bit resolution                                                         | V <sub>DD</sub> = 5 V                             |      |      | ±0.29           | %FSR |
|                                                                |                   |                                                                           | V <sub>DD</sub> = 3 V                             |      |      | ±0.42           | %FSR |
| Integral linearity error <sup>Note 1, Note 2, Note 3</sup>     | ILE               | 10-bit resolution                                                         | V <sub>DD</sub> = 5 V                             |      |      | ±1.8            | LSB  |
|                                                                |                   |                                                                           | V <sub>DD</sub> = 3 V                             |      |      | ±1.7            | LSB  |
| Differential linearity error <sup>Note 1, Note 2, Note 3</sup> | DLE               | 10-bit resolution                                                         | V <sub>DD</sub> = 5 V                             |      |      | ±1.4            | LSB  |
|                                                                |                   |                                                                           | V <sub>DD</sub> = 3 V                             |      |      | ±1.5            | LSB  |
| Analog input voltage                                           | V <sub>AIN</sub>  | Targets: ANI0 to ANI10                                                    | 0                                                 |      |      | V <sub>DD</sub> | V    |
|                                                                |                   | Target: Internal reference voltage <sup>Note 6</sup>                      | V <sub>REG</sub> <sup>Note 7</sup>                |      |      |                 | V    |

Note 1. The TYP. value is an average value at T<sub>A</sub> = 25°C. The MAX. value is an average value ±3σ at normal distribution.

Note 2. These values are the results of characteristic evaluation and are not checked for shipment.

Note 3. A quantization error (±1/2 LSB) is not included.

Note 4. Expressed as a ratio (%FSR) relative to the full-scale value.

Note 5. Be sure to set the LV0 bit in A/D converter mode register 0 (ADM0) to 0 when conversion is done in the operating voltage range of 2.4 V ≤ V<sub>DD</sub> < 2.7 V.

Note 6. Be sure to set the LV0 bit in A/D converter mode register 0 (ADM0) to 0 when the internal reference voltage is selected as the target for conversion.

Note 7. Refer to 2.6.3 Internal reference voltage characteristics.

**Caution 1.** Arrange wiring and insert the capacitor so that no noise appears on the power supply/ground line.

**Caution 2.** Do not allow any pulses that rapidly change such as digital signals to be input/output to/from the pins adjacent to the conversion pin during A/D conversion.

**Caution 3.** Note that the internal reference voltage cannot be used as the reference voltage of the comparator when the internal reference voltage is selected as the target for A/D conversion.

## 2.6.2 Comparator characteristics

[ $T_A = -40$  to  $+85^\circ\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                              | Symbol     | Condition                                                                 | MIN.                        | TYP. | MAX.           | Unit          |
|-----------------------------------|------------|---------------------------------------------------------------------------|-----------------------------|------|----------------|---------------|
| Input voltage range               | $I_{VREF}$ | IVREFn pin input (CnVRF bit = 0)                                          | 0                           |      | $V_{DD} - 1.4$ | V             |
|                                   |            | Internal reference voltage (CnVRF bit = 1) <sup>Note 1</sup>              | $V_{REG}$ <sup>Note 2</sup> |      |                | V             |
|                                   | $I_{VCMP}$ | IVCMPn pin input                                                          | -0.3                        |      | $V_{DD} + 0.3$ | V             |
| Output delay                      | $t_d$      | $V_{DD} = 3.0\text{ V}$ ,<br>input slew rate $> 50\text{ mV}/\mu\text{s}$ |                             |      | 0.5            | $\mu\text{s}$ |
|                                   |            |                                                                           |                             |      |                | $\mu\text{s}$ |
| Operation stabilization wait time | $t_{CMP}$  |                                                                           | 100                         |      |                | $\mu\text{s}$ |

Note 1. When the internal reference voltage is selected as the reference voltage of the comparator, the internal reference voltage cannot be used as the target for A/D conversion.

Note 2. Refer to **2.6.3 Internal reference voltage characteristics**.

**Remark** n: Channel number ( $n = 0, 1$ )

## 2.6.3 Internal reference voltage characteristics

[ $T_A = -40$  to  $+85^\circ\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                              | Symbol    | Condition                                  | MIN. | TYP.  | MAX. | Unit          |
|-----------------------------------|-----------|--------------------------------------------|------|-------|------|---------------|
| Internal reference voltage        | $V_{REG}$ |                                            | 0.74 | 0.815 | 0.89 | V             |
| Operation stabilization wait time | $t_{AMP}$ | A/D converter is used (ADS register = 0DH) | 5    |       |      | $\mu\text{s}$ |

**Caution** The internal reference voltage cannot be simultaneously used by the A/D converter and the comparator; only one of them must be selected.

### 2.6.4 SPOR circuit characteristics

[ $T_A = -40$  to  $+85^\circ\text{C}$ ,  $V_{SS} = 0$  V]

| Item                                  |                            | Symbol             | Condition            | MIN. | TYP. | MAX. | Unit |
|---------------------------------------|----------------------------|--------------------|----------------------|------|------|------|------|
| Detection voltage                     | Power supply voltage level | V <sub>SPOR0</sub> | Power supply rising  | 4.08 | 4.28 | 4.45 | V    |
|                                       |                            | V <sub>SPDR0</sub> | Power supply falling | 4.00 | 4.20 | 4.37 | V    |
|                                       |                            | V <sub>SPOR1</sub> | Power supply rising  | 2.76 | 2.90 | 3.02 | V    |
|                                       |                            | V <sub>SPDR1</sub> | Power supply falling | 2.70 | 2.84 | 2.96 | V    |
|                                       |                            | V <sub>SPOR2</sub> | Power supply rising  | 2.44 | 2.57 | 2.68 | V    |
|                                       |                            | V <sub>SPDR2</sub> | Power supply falling | 2.40 | 2.52 | 2.62 | V    |
|                                       |                            | V <sub>SPOR3</sub> | Power supply rising  |      | 2.16 |      | V    |
|                                       |                            | V <sub>SPDR3</sub> | Power supply falling |      | 2.11 |      | V    |
| Minimum pulse width <sup>Note 1</sup> |                            | T <sub>SPW</sub>   |                      | 300  |      |      | μs   |

Note 1. Time required for the reset operation by the SPOR circuit when  $V_{DD}$  falls below  $V_{SPDR}$ .

**Caution** Make sure to keep the internal reset state by the SPOR or an external reset until the power supply voltage ( $V_{DD}$ ) reaches the operating voltage range shown in 2.4 AC Characteristics.

### 2.6.5 Power supply voltage rising slope characteristics

[ $T_A = -40$  to  $+85^\circ\text{C}$ ,  $V_{SS} = 0$  V]

| Item                              | Symbol    | Condition | MIN. | TYP. | MAX. | Unit |
|-----------------------------------|-----------|-----------|------|------|------|------|
| Power supply voltage rising slope | $S_{VDD}$ |           |      |      | 54   | V/ms |

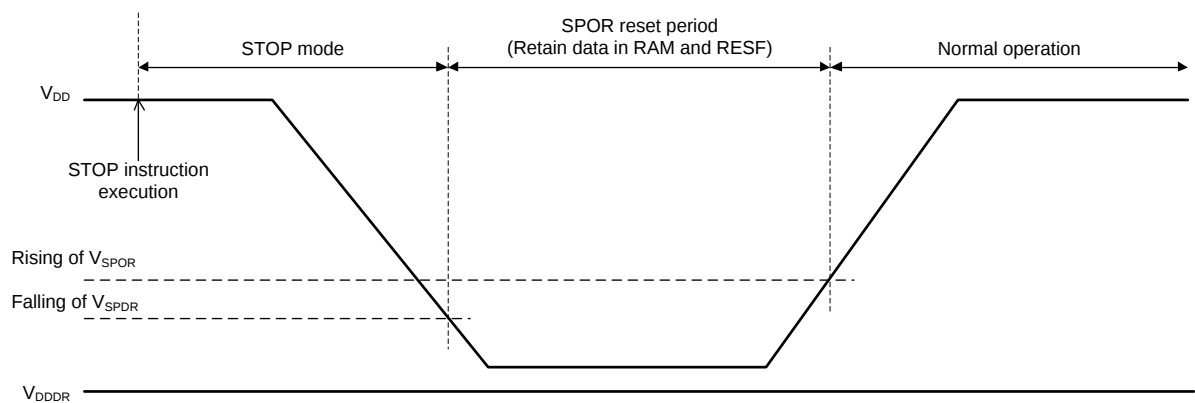
**Caution** Make sure to keep the internal reset state by the SPOR or an external reset until the power supply voltage ( $V_{DD}$ ) reaches the operating voltage range shown in 2.4 AC Characteristics.

2.7 RAM Data Retention Characteristics

[T<sub>A</sub> = -40 to +85°C, V<sub>SS</sub> = 0 V]

| Item                                | Symbol            | Condition | MIN. | TYP. | MAX. | Unit |
|-------------------------------------|-------------------|-----------|------|------|------|------|
| Data retention power supply voltage | V <sub>DDDR</sub> |           | 1.9  |      | 5.5  | V    |

**Caution** Data in RAM is retained until the power supply voltage falls below the MIN. value of the data retention power supply voltage (V<sub>DDDR</sub>). Note that data in the RESF register might not be cleared even if the power supply voltage falls below the MIN. value of the data retention power supply voltage (V<sub>DDDR</sub>).



## 2.8 Flash Memory Programming Characteristics

[ $T_A = -40$  to  $+85^\circ\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                                                           | Symbol            | Condition             |                        | MIN.    | TYP.      | MAX. | Unit  |
|----------------------------------------------------------------|-------------------|-----------------------|------------------------|---------|-----------|------|-------|
| Number of code flash rewrites<br><small>Note 1, Note 2</small> | C <sub>erwr</sub> | Retained for 20 years | T <sub>A</sub> = +85°C | 1000    |           |      | Times |
| Number of data flash rewrites<br><small>Note 1, Note 2</small> |                   | Retained for 1 year   | T <sub>A</sub> = +25°C |         | 1,000,000 |      | Times |
|                                                                |                   | Retained for 5 years  | T <sub>A</sub> = +85°C | 100,000 |           |      | Times |
|                                                                |                   | Retained for 20 years | T <sub>A</sub> = +85°C | 10,000  |           |      | Times |

Note 1. 1 erase + 1 write after the erase is regarded as 1 rewrite. The retaining years are until next rewrite after the rewrite.

Note 2. These are the characteristics of the flash memory and the results obtained from reliability testing by Renesas Electronics.

### Code flash/data flash self-programming time



[ $T_A = -40$  to  $+85^\circ\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                 | Symbol    | $f_{CLK} = 1\text{ MHz}$ |      |       | $f_{CLK} = 16\text{ MHz}$ |      |       | Unit          |
|----------------------|-----------|--------------------------|------|-------|---------------------------|------|-------|---------------|
|                      |           | MIN.                     | TYP. | MAX.  | MIN.                      | TYP. | MAX.  |               |
| Writing (4 bytes)    | $t_{P4}$  |                          | 104  | 905   |                           | 53.8 | 504.9 | $\mu\text{s}$ |
| Block erasure (1 KB) | $t_{E1K}$ |                          | 7.9  | 262.3 |                           | 5.5  | 214.1 | ms            |

**Caution** The listed values do not include the time until the operations of the flash memory start following execution of an instruction by software.

## 2.9 Dedicated Flash Memory Programmer Communication (UART)

[ $T_A = -40$  to  $+85^\circ\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item          | Symbol | Condition | MIN. | TYP.    | MAX. | Unit |
|---------------|--------|-----------|------|---------|------|------|
| Transfer rate |        |           |      | 115,200 |      | bps  |

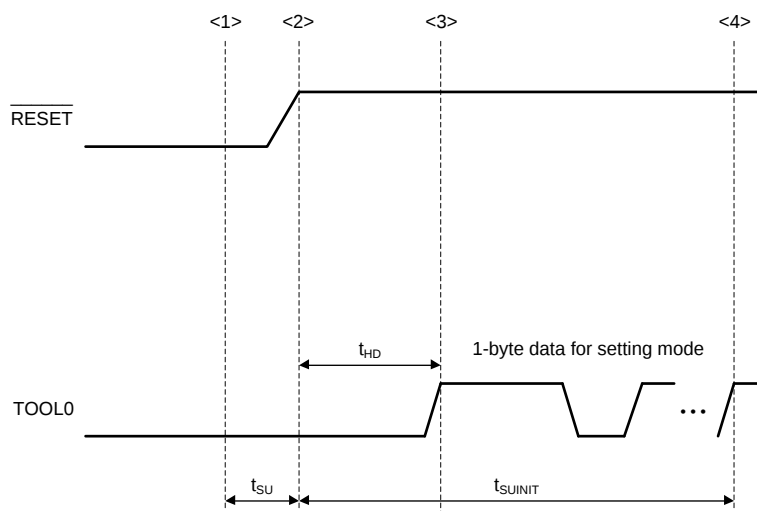
**Remark** The transfer rate during flash memory programming is fixed to 115,200 bps.

## 2.10 Timing of Entry to Flash Memory Programming Mode



[ $T_A = -40$  to  $+85^\circ\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                                                                                            | Symbol             | Condition                                                              | MIN. | TYP. | MAX. | Unit          |
|-------------------------------------------------------------------------------------------------|--------------------|------------------------------------------------------------------------|------|------|------|---------------|
| Time to complete the communication for the initial setting after the external reset is released | $t_{\text{SUNIT}}$ | The SPOR reset must be released before the external reset is released. |      |      | 100  | ms            |
| Time to release the external reset after the TOOL0 pin is set to the low level                  | $t_{\text{SU}}$    | The SPOR reset must be released before the external reset is released. | 10   |      |      | $\mu\text{s}$ |
| Time to hold the TOOL0 pin at the low level after the external reset is released                | $t_{\text{HD}}$    | The SPOR reset must be released before the external reset is released. | 1    |      |      | ms            |



<1> The low level is input to the TOOL0 pin.

<2> The external reset is released (the SPOR reset must have been released before that).

<3> The TOOL0 pin is released from the low level.

<4> Setting of entry to the flash memory programming mode by UART reception is completed.

**Remark**  $t_{\text{SUNIT}}$ : During this period, the communications for the initial setting must be completed within 100 ms after release from the reset.

$t_{\text{SU}}$ : Time to release the external reset after the TOOL0 pin is set to the low level

$t_{\text{HD}}$ : Time to hold the TOOL0 pin at the low level after the external reset is released

### ★ 3. ELECTRICAL SPECIFICATIONS ( $T_A = -40$ to $+105^\circ\text{C}$ , $T_A = -40$ to $+125^\circ\text{C}$ )

This chapter describes the electrical specifications of the following target products.

Target product G: Industrial applications  $T_A = -40$  to  $+105^\circ\text{C}$

Target product M: Industrial applications  $T_A = -40$  to  $+125^\circ\text{C}$

**Caution 1.** The RL78 microcontrollers have an on-chip debug function, which is provided for development and evaluation. Do not use the on-chip debug function in products designated for mass production, because the guaranteed number of rewritable times of the flash memory may be exceeded when this function is used, and product reliability therefore cannot be guaranteed. Renesas Electronics is not liable for problems occurring when the on-chip debug function is used.

**Caution 2.** The pins mounted depend on the product. Refer to *2.1 Port Function*, for the port functions, and *2.2.1 Functions for each product*, for the other functions, in the *RL78/G15 User's Manual*.

★

### 3.1 Absolute Maximum Ratings

[ $T_A = 25^{\circ}\text{C}$ ]

| Item                          | Symbol    | Condition         |                                        | Rating                                   | Unit               |
|-------------------------------|-----------|-------------------|----------------------------------------|------------------------------------------|--------------------|
| Supply voltage                | $V_{DD}$  |                   |                                        | -0.5 to +6.5                             | V                  |
| Input voltage                 | $V_{I1}$  |                   |                                        | -0.3 to $V_{DD} + 0.3$ <sup>Note 1</sup> | V                  |
| Output voltage                | $V_{O1}$  |                   |                                        | -0.3 to $V_{DD} + 0.3$                   | V                  |
| Output current, high          | $I_{OH1}$ | Per pin           |                                        | -40                                      | mA                 |
|                               |           | Total of all pins | P20 to P23, P40, P41, P121, P122, P125 | -70                                      | mA                 |
|                               |           | -170mA            | P00 to P07                             | -100                                     | mA                 |
| Output current, low           | $I_{OL1}$ | Per pin           |                                        | 40                                       | mA                 |
|                               |           | Total of all pins | P20 to P23, P40, P41, P121, P122, P125 | 100                                      | mA                 |
|                               |           | 170mA             | P00 to P07                             | 100                                      | mA                 |
| Operating ambient temperature | $T_A$     | G products        |                                        | -40 to +105                              | $^{\circ}\text{C}$ |
|                               |           | M products        |                                        | -40 to +125                              | $^{\circ}\text{C}$ |
| Storage temperature           | $T_{stg}$ |                   |                                        | -65 to +150                              | $^{\circ}\text{C}$ |

Note 1. This must be no greater than 6.5 V.

**Caution** Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any item. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

**Remark 1.** The characteristics of functions multiplexed on a given pin are the same as those for the port pin unless otherwise specified.

**Remark 2.** The reference voltage is  $V_{SS}$ .

## 3.2 Oscillator Characteristics

### 3.2.1 X1 oscillator characteristics

[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                                                  | Resonator                               | Condition                                    | MIN. | TYP. | MAX. | Unit |
|-------------------------------------------------------|-----------------------------------------|----------------------------------------------|------|------|------|------|
| X1 clock oscillation frequency (fx) <sup>Note 1</sup> | Ceramic resonator/<br>crystal resonator | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 1    |      | 12   | MHz  |

Note 1. Indicates only permissible oscillator frequency ranges. Refer to **3.4 AC Characteristics** for instruction execution time. For actual applications, request evaluation by the manufacturer of the oscillator circuit mounted on a board so you can use appropriate values.

**Caution** Since the CPU is started by the high-speed on-chip oscillator clock after release from the reset state, the user should use the oscillation stabilization time counter status register (OSTC) to check the X1 clock oscillation stabilization time. Specify the values for the oscillation stabilization time in the OSTC register and the oscillation stabilization time select register (OSTS) after having sufficiently evaluated the oscillation stabilization time with the resonator to be used.

**Remark** When using the X1 oscillator, refer to 5.4 System Clock Oscillator in the RL78/G15 User's Manual.

### 3.2.2 On-chip oscillator characteristics

[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                                                                    | Symbol   | Condition                           | MIN. | TYP. | MAX. | Unit |
|-------------------------------------------------------------------------|----------|-------------------------------------|------|------|------|------|
| High-speed on-chip oscillator clock frequency <sup>Note 1, Note 2</sup> | $f_{IH}$ |                                     | 1    |      | 16   | MHz  |
| High-speed on-chip oscillator clock frequency accuracy                  |          | $T_A = +85$ to $+125^\circ\text{C}$ | -1.5 |      | +1.5 | %    |
|                                                                         |          | $T_A = -20$ to $+85^\circ\text{C}$  | -1.0 |      | +1.0 | %    |
|                                                                         |          | $T_A = -40$ to $-20^\circ\text{C}$  | -1.5 |      | +1.5 | %    |
| Low-speed on-chip oscillator clock frequency                            | $f_{IL}$ |                                     |      | 15   |      | kHz  |
| Low-speed on-chip oscillator clock frequency accuracy                   |          |                                     | -15  |      | +15  | %    |

Note 1. The high-speed on-chip oscillator frequency is selected by bits 0 to 2 of option byte (00C2H).

Note 2. The listed values only indicate the characteristics of the oscillators. Refer to **3.4 AC Characteristics** for instruction execution time.

### 3.3 DC Characteristics

#### 3.3.1 Pin characteristics

[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

(1/2)

| Item                                      | Symbol    | Condition                                                                                     | MIN.                                         | TYP.                                | MAX.                   | Unit |
|-------------------------------------------|-----------|-----------------------------------------------------------------------------------------------|----------------------------------------------|-------------------------------------|------------------------|------|
| Output current,<br>high <sup>Note 1</sup> | $I_{OH1}$ | Per pin for P00 to P07, P20 to P23, P40, P41, P121, P122, P125                                |                                              |                                     | -3.0 <sup>Note 2</sup> | mA   |
|                                           |           | Total of P20 to P23, P40, P41, P121, P122, P125<br>(when duty $\leq 70\%$ <sup>Note 3</sup> ) | $4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ |                                     | -25.0                  | mA   |
|                                           |           |                                                                                               | $2.4\text{ V} \leq V_{DD} < 4.0\text{ V}$    |                                     | -7.0                   | mA   |
|                                           |           | Total of P00 to P07<br>(when duty $\leq 70\%$ <sup>Note 3</sup> )                             | $4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ |                                     | -24.0                  | mA   |
|                                           |           |                                                                                               | $2.4\text{ V} \leq V_{DD} < 4.0\text{ V}$    |                                     | -6.0                   | mA   |
|                                           |           | Total of all pins (when duty $\leq 70\%$ <sup>Note 3</sup> )                                  |                                              |                                     | -40.0                  | mA   |
| Output current,<br>low <sup>Note 4</sup>  | $I_{OL1}$ | Per pin for P00 to P07, P20 to P23, P40, P41, P121, P122, P125                                |                                              |                                     | 8.5 <sup>Note 2</sup>  | mA   |
|                                           |           | Total of P20 to P23, P40, P41, P121, P122, P125<br>(when duty $\leq 70\%$ <sup>Note 3</sup> ) | $4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | $T_A = -40$ to $+105^\circ\text{C}$ | 50.0                   | mA   |
|                                           |           |                                                                                               |                                              | $T_A = -40$ to $+125^\circ\text{C}$ | 40.0                   | mA   |
|                                           |           |                                                                                               | $2.7\text{ V} \leq V_{DD} < 4.0\text{ V}$    |                                     | 10.5                   | mA   |
|                                           |           |                                                                                               | $2.4\text{ V} \leq V_{DD} < 2.7\text{ V}$    |                                     | 4.2                    | mA   |
|                                           |           | Total of P00 to P07<br>(when duty $\leq 70\%$ <sup>Note 3</sup> )                             | $4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | $T_A = -40$ to $+105^\circ\text{C}$ | 50.0                   | mA   |
|                                           |           |                                                                                               |                                              | $T_A = -40$ to $+125^\circ\text{C}$ | 40.0                   | mA   |
|                                           |           |                                                                                               | $2.7\text{ V} \leq V_{DD} < 4.0\text{ V}$    |                                     | 9.0                    | mA   |
|                                           |           |                                                                                               | $2.4\text{ V} \leq V_{DD} < 2.7\text{ V}$    |                                     | 3.6                    | mA   |
|                                           |           | Total of all pins (when duty $\leq 70\%$ <sup>Note 3</sup> )                                  | $T_A = -40$ to $+105^\circ\text{C}$          |                                     | 80.0                   | mA   |
|                                           |           |                                                                                               | $T_A = -40$ to $+125^\circ\text{C}$          |                                     | 60.0                   | mA   |

Note 1. Device operation is guaranteed at the listed currents even if current is flowing from the  $V_{DD}$  pin to an output pin.

Note 2. The value for maximum total current must not be exceeded.

Note 3. The listed currents apply when the duty cycle is no greater than 70%. Use the following formula to calculate the output current when the duty cycle is greater than 70%, where  $n$  is the duty cycle.

- Total output current from the listed pins =  $(I_{OH} \times 0.7)/(n \times 0.01)$   
Example when  $n = 80\%$  and  $I_{OH} = -10.0\text{ mA}$   
Total output current from the listed pins =  $(-10.0 \times 0.7)/(80 \times 0.01) \cong -8.7\text{ mA}$
- Total output current from the listed pins =  $(I_{OL} \times 0.7)/(n \times 0.01)$   
Example when  $n = 80\%$  and  $I_{OL} = 10.0\text{ mA}$   
Total output current from the listed pins =  $(10.0 \times 0.7)/(80 \times 0.01) \cong 8.7\text{ mA}$

Note that the duty cycle has no effect on the current that is allowed to flow into a single pin. A current higher than the absolute maximum rating must not flow into a single pin.

Note 4. Device operation is guaranteed at the listed currents even if current is flowing from an output pin to the  $V_{SS}$  pin.

**Caution** P00, P01, P03 to P07, P22, and P41 do not output high level in N-ch open-drain mode.

**Remark** The characteristics of functions multiplexed on a given pin are the same as those for the port pin unless otherwise specified.

[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

(2/2)

| Item                           | Symbol     | Condition                                                      |                                       | MIN.           | TYP. | MAX.         | Unit          |
|--------------------------------|------------|----------------------------------------------------------------|---------------------------------------|----------------|------|--------------|---------------|
| Input voltage, high            | $V_{IH1}$  |                                                                |                                       | $0.8 V_{DD}$   |      | $V_{DD}$     | V             |
| Input voltage, low             | $V_{IL1}$  |                                                                |                                       | 0              |      | $0.2 V_{DD}$ | V             |
| Output voltage, high<br>Note 1 | $V_{OH1}$  | $4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                   | $I_{OH} = -3.0\text{ mA}$             | $V_{DD} - 0.7$ |      |              | V             |
|                                |            | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                   | $I_{OH} = -1.0\text{ mA}$             | $V_{DD} - 0.5$ |      |              | V             |
| Output voltage, low<br>Note 2  | $V_{OL1}$  | $4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                   | $I_{OL} = 8.5\text{ mA}$              |                |      | 0.7          | V             |
|                                |            | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                   | $I_{OL} = 1.5\text{ mA}$              |                |      | 0.5          | V             |
|                                |            | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                   | $I_{OL} = 0.6\text{ mA}$              |                |      | 0.4          | V             |
| Input leakage current, high    | $I_{LH1}$  | P00 to P07, P20 to P23, P40, P41, P125, P137<br>$V_i = V_{DD}$ |                                       |                |      | 1            | $\mu\text{A}$ |
|                                | $I_{LH2}$  | P121, P122 (X1, X2, EXCLK)<br>$V_i = V_{DD}$                   | In input port or external clock input |                |      | 1            | $\mu\text{A}$ |
|                                |            |                                                                | In resonator connection               |                |      | 10           | $\mu\text{A}$ |
| Input leakage current, low     | $I_{LIL1}$ | P00 to P07, P20 to P23, P40, P41, P125, P137<br>$V_i = V_{SS}$ |                                       |                |      | -1           | $\mu\text{A}$ |
|                                | $I_{LIL2}$ | P121, P122 (X1, X2, EXCLK)<br>$V_i = V_{SS}$                   | In input port or external clock input |                |      | -1           | $\mu\text{A}$ |
|                                |            |                                                                | In resonator connection               |                |      | -10          | $\mu\text{A}$ |
| On-chip pull-up resistance     | $R_U$      | $V_i = V_{SS}$                                                 |                                       | 10             | 20   | 100          | k $\Omega$    |

Note 1. The value under the condition which satisfies the high-level output current ( $I_{OH1}$ ).

Note 2. The value under the condition which satisfies the low-level output current ( $I_{OL1}$ ).

**Caution** The maximum value of  $V_{IH}$  of P00, P01, P03 to P07, P22, and P41 is  $V_{DD}$  even in N-ch open-drain mode. These pins do not output high level in N-ch open-drain mode.

**Remark** The characteristics of functions multiplexed on a given pin are the same as those for the port pin unless otherwise specified.

### 3.3.2 Supply current characteristics

[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                             | Symbol                      | Condition      |                  |                                                    |                                                               | MIN. | TYP. | MAX. | Unit          |
|----------------------------------|-----------------------------|----------------|------------------|----------------------------------------------------|---------------------------------------------------------------|------|------|------|---------------|
| Supply current <sup>Note 1</sup> | $I_{DD1}$                   | Operating mode | Basic operation  | $f_{IH} = 16\text{ MHz}$ <sup>Note 4</sup>         | $V_{DD} = 3.0\text{ V}, 5.0\text{ V}$                         |      | 0.87 |      | mA            |
|                                  |                             |                | Normal operation | $f_{IH} = 16\text{ MHz}$ <sup>Note 4</sup>         | $V_{DD} = 3.0\text{ V}, 5.0\text{ V}$                         |      | 1.86 | 2.49 | mA            |
|                                  |                             |                |                  | $f_{IH} = 4\text{ MHz}$ <sup>Note 4</sup>          | $V_{DD} = 3.0\text{ V}, 5.0\text{ V}$                         |      | 1.17 | 1.65 | mA            |
|                                  |                             |                |                  | $f_{EX} = 16\text{ MHz}$ <sup>Note 5, Note 6</sup> | Square wave input<br>$V_{DD} = 3.0\text{ V}, 5.0\text{ V}$    |      | 1.69 | 2.32 | mA            |
|                                  |                             |                |                  | $f_X = 12\text{ MHz}$ <sup>Note 5, Note 6</sup>    | Resonator connection<br>$V_{DD} = 3.0\text{ V}, 5.0\text{ V}$ |      | 1.57 | 2.32 | mA            |
|                                  |                             |                |                  | $f_{MX} = 4\text{ MHz}$ <sup>Note 5, Note 6</sup>  | Square wave input<br>$V_{DD} = 3.0\text{ V}, 5.0\text{ V}$    |      | 1.00 | 1.47 | mA            |
|                                  |                             |                |                  |                                                    | Resonator connection<br>$V_{DD} = 3.0\text{ V}, 5.0\text{ V}$ |      | 1.05 | 1.55 | mA            |
|                                  | $I_{DD2}$ <sup>Note 2</sup> | HALT mode      |                  | $f_{IH} = 16\text{ MHz}$ <sup>Note 4</sup>         | $V_{DD} = 3.0\text{ V}, 5.0\text{ V}$                         |      | 371  | 811  | $\mu\text{A}$ |
|                                  |                             |                |                  | $f_{IH} = 4\text{ MHz}$ <sup>Note 4</sup>          | $V_{DD} = 3.0\text{ V}, 5.0\text{ V}$                         |      | 334  | 637  | $\mu\text{A}$ |
|                                  |                             |                |                  | $f_{EX} = 16\text{ MHz}$ <sup>Note 5, Note 6</sup> | Square wave input<br>$V_{DD} = 3.0\text{ V}, 5.0\text{ V}$    |      | 207  | 647  | $\mu\text{A}$ |
|                                  |                             |                |                  | $f_X = 12\text{ MHz}$ <sup>Note 5, Note 6</sup>    | Resonator connection<br>$V_{DD} = 3.0\text{ V}, 5.0\text{ V}$ |      | 309  | 909  | $\mu\text{A}$ |
|                                  |                             |                |                  | $f_{MX} = 4\text{ MHz}$ <sup>Note 5, Note 6</sup>  | Square wave input<br>$V_{DD} = 3.0\text{ V}, 5.0\text{ V}$    |      | 156  | 459  | $\mu\text{A}$ |
|                                  |                             |                |                  |                                                    | Resonator connection<br>$V_{DD} = 3.0\text{ V}, 5.0\text{ V}$ |      | 207  | 609  | $\mu\text{A}$ |
|                                  | $I_{DD3}$ <sup>Note 3</sup> | STOP mode      |                  | $V_{DD} = 3.0\text{ V}$                            | $T_A = +105^\circ\text{C}$                                    |      | 0.62 | 3.71 | $\mu\text{A}$ |
|                                  |                             |                |                  |                                                    | $T_A = +125^\circ\text{C}$                                    |      | 0.62 | 7.44 | $\mu\text{A}$ |



Note 1. The listed currents are the total currents flowing into  $V_{DD}$ , including the input leakage currents flowing when the level of the input pin is fixed to  $V_{DD}$  or  $V_{SS}$ .  
Regarding the values for main system clock operation, the TYP. value does not include the peripheral operating current. The MAX. value includes the peripheral operating current, but does not include those flowing into the A/D converter, comparator, I/O port, and on-chip pull-up/pull-down resistors.  
Regarding the values for subsystem clock operation, the TYP. and MAX. values do not include the peripheral operating current. However, in HALT mode, the current flowing into the RTC is included.  
Regarding the values in STOP mode, the TYP. and MAX. values do not include the peripheral operating current.

Note 2. When the HALT instruction is executed from the flash memory.

Note 3. The listed currents do not include the current flowing into the 12-bit interval timer and watchdog timer.

Note 4. When the high-speed subsystem clock is stopped.

Note 5. When the high-speed on-chip oscillator is stopped.

Note 6. 16-pin and 20-pin products only.

**Remark 1.**  $f_{IH}$ : High-speed on-chip oscillator clock frequency

**Remark 2.**  $f_{MX}$ : High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)

**Remark 3.** The temperature condition of the TYP. value is  $T_A = 25^\circ\text{C}$ .

## Peripheral Functions

[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                                           | Symbol                                       | Condition                      |                         | MIN. | TYP. | MAX.  | Unit          |
|------------------------------------------------|----------------------------------------------|--------------------------------|-------------------------|------|------|-------|---------------|
| Low-speed on-chip oscillator operating current | $I_{FIL}$ <sup>Note 1</sup>                  |                                |                         |      | 0.30 |       | $\mu\text{A}$ |
| 12-bit interval timer operating current        | $I_{TMKA}$ <sup>Note 1, Note 2, Note 3</sup> |                                |                         |      | 0.02 |       | $\mu\text{A}$ |
| Watchdog timer operating current               | $I_{WDT}$ <sup>Note 1, Note 4</sup>          |                                |                         |      | 0.02 |       | $\mu\text{A}$ |
| A/D converter operating current                | $I_{ADC}$ <sup>Note 1, Note 5</sup>          | In conversion at maximum speed | $V_{DD} = 5.0\text{ V}$ |      | 1.30 | 1.90  | $\text{mA}$   |
|                                                |                                              |                                | $V_{DD} = 3.0\text{ V}$ |      | 0.50 |       | $\text{mA}$   |
| Comparator operating current                   | $I_{CMP}$ <sup>Note 1, Note 6</sup>          | In high-speed mode             | $V_{DD} = 5.0\text{ V}$ |      | 6.50 |       | $\mu\text{A}$ |
|                                                |                                              | In low-speed mode              | $V_{DD} = 5.0\text{ V}$ |      | 1.70 |       | $\mu\text{A}$ |
| Internal reference voltage operating current   | $I_{VREG}$ <sup>Note 1</sup>                 |                                |                         |      | 10   |       | $\mu\text{A}$ |
| Self-programming operating current             | $I_{FSP}$ <sup>Note 1, Note 7</sup>          |                                |                         |      | 2.0  | 12.20 | $\text{mA}$   |

Note 1. The current flowing into  $V_{DD}$ .

Note 2. When the high-speed on-chip oscillator and high-speed system clock are stopped.

Note 3. This current only flows into the 12-bit interval timer. It does not include the operating current of the low-speed on-chip oscillator. The supply current of the RL78 microcontrollers is the sum of  $I_{DD1}$ ,  $I_{DD2}$  or  $I_{DD3}$  and  $I_{FIL}$  and  $I_{TMKA}$  when the 12-bit interval timer is in operation.

Note 4. This current only flows into the watchdog timer. It does not include the operating current of the low-speed on-chip oscillator. The supply current of the RL78 microcontrollers is the sum of  $I_{DD1}$ ,  $I_{DD2}$  or  $I_{DD3}$  and  $I_{FIL}$  and  $I_{WDT}$  when the watchdog timer is in operation.

Note 5. This current only flows into the A/D converter. The supply current of the RL78 microcontrollers is the sum of  $I_{DD1}$  or  $I_{DD2}$  and  $I_{ADC}$  when the A/D converter is operating or in the HALT mode.

Note 6. This current only flows into a single comparator. The supply current of the RL78 microcontrollers is the sum of  $I_{DD1}$ ,  $I_{DD2}$  or  $I_{DD3}$  and  $I_{CMP}$  when the comparator is in operation.

Note 7. This current only flows during self-programming.

**Remark** The temperature condition of the TYP. value is  $T_A = 25^\circ\text{C}$ .

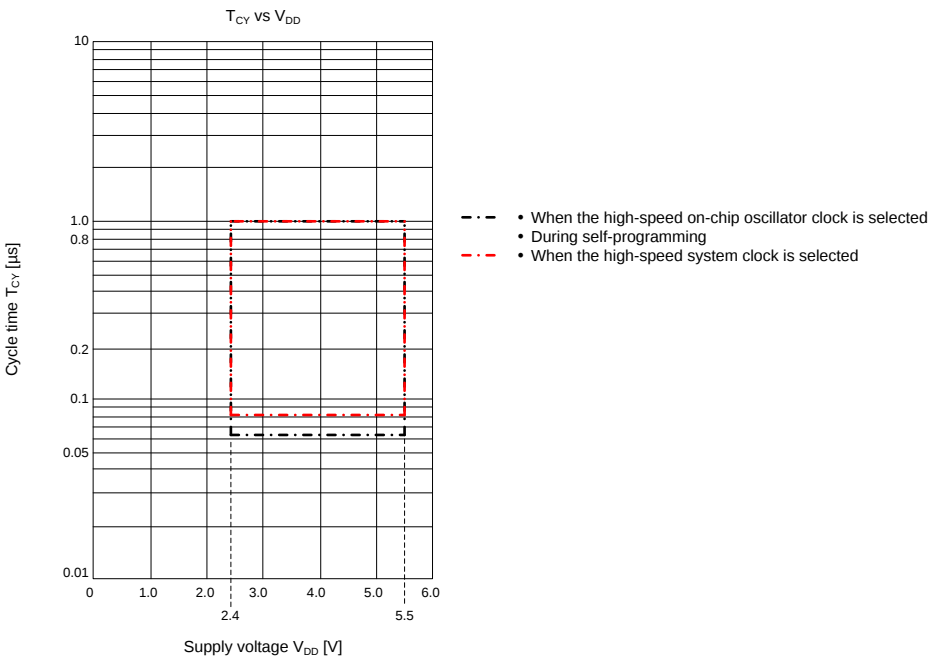
### 3.4 AC Characteristics

[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

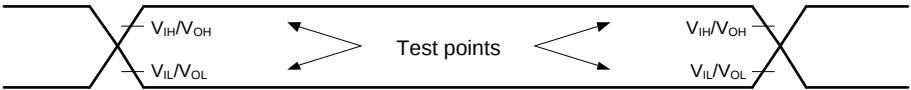
| Item                                                          | Symbol             | Condition                                                         |                                              | MIN.                 | TYP.   | MAX. | Unit          |
|---------------------------------------------------------------|--------------------|-------------------------------------------------------------------|----------------------------------------------|----------------------|--------|------|---------------|
| Instruction cycle (minimum instruction execution time)        | $T_{CY}$           | When high-speed on-chip oscillator clock ( $f_{IH}$ ) is selected | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 0.0625               |        | 1.0  | $\mu\text{s}$ |
|                                                               |                    | When high-speed system clock ( $f_{MX}$ ) is selected             | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | Square wave input    | 0.0625 | 1.0  | $\mu\text{s}$ |
|                                                               |                    |                                                                   |                                              | Resonator connection | 0.0833 | 1.0  | $\mu\text{s}$ |
|                                                               |                    | In the self-programming mode                                      | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 0.0625               |        | 1.0  | $\mu\text{s}$ |
| External system clock frequency                               | $f_{EX}$           | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                      |                                              | 1.0                  |        | 16   | MHz           |
| External system clock input high-level width, low-level width | $t_{EXH}, t_{EXL}$ | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                      |                                              | 30                   |        |      | ns            |
| Ti00 to Ti07 input high-level width, low-level width          | $t_{TIH}, t_{TIL}$ | Noise filter is not used                                          |                                              | $1/f_{MCK} + 10$     |        |      | ns            |
| TO00 to TO07 output frequency                                 | $f_{TO}$           | $4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                      |                                              |                      |        | 8    | MHz           |
|                                                               |                    | $2.7\text{ V} \leq V_{DD} < 4.0\text{ V}$                         |                                              |                      |        | 5    | MHz           |
|                                                               |                    | $2.4\text{ V} \leq V_{DD} < 2.7\text{ V}$                         |                                              |                      |        | 4    | MHz           |
| PCLBUZ0 output frequency                                      | $f_{PCL}$          | $4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                      |                                              |                      |        | 10   | MHz           |
|                                                               |                    | $2.7\text{ V} \leq V_{DD} < 4.0\text{ V}$                         |                                              |                      |        | 5    | MHz           |
|                                                               |                    | $2.4\text{ V} \leq V_{DD} < 2.7\text{ V}$                         |                                              |                      |        | 4    | MHz           |
| RESET low-level width                                         | $t_{RSL}$          |                                                                   |                                              | 10                   |        |      | $\mu\text{s}$ |

**Remark**  $f_{MCK}$ : Timer array unit operating clock frequency  
 (Operation clock to be set by timer clock select register 0 (TPS0) and the CKS0n1 bit of timer mode register 0n (TMR0n). n: Channel number (n = 0 to 7).)

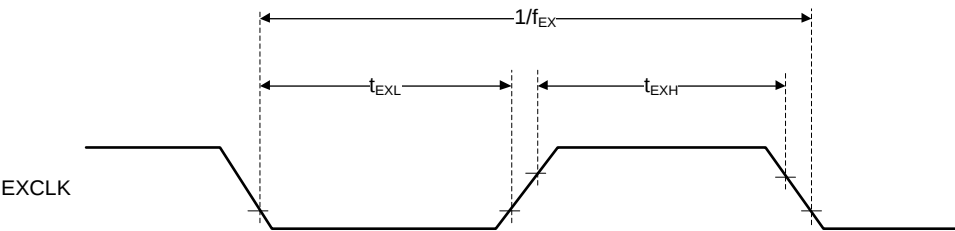
Minimum Instruction Execution Time during Main System Clock Operation



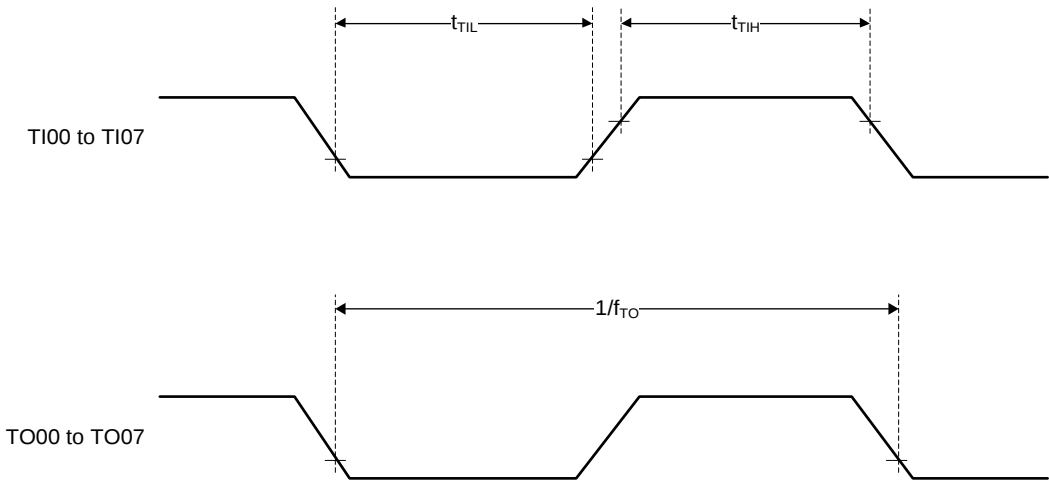
At AC Timing



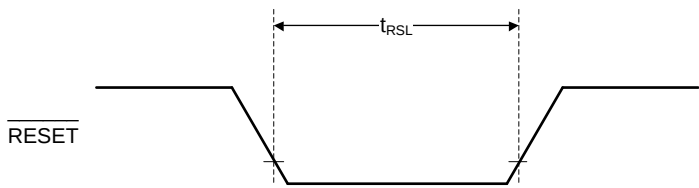
External System Clock Timing



TI/TO Timing

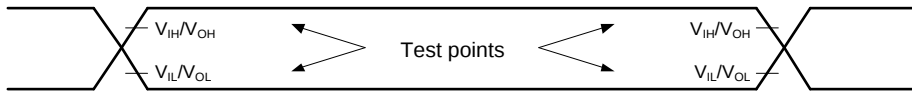


**RESET** Input Timing



3.5 Serial Interface Characteristics

AC Timing Test Points



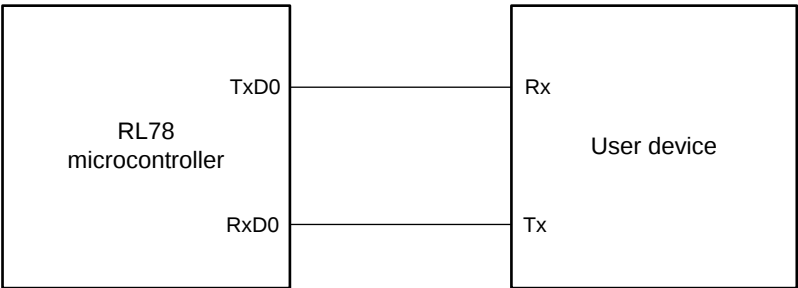
3.5.1 Serial array unit

(1) UART mode

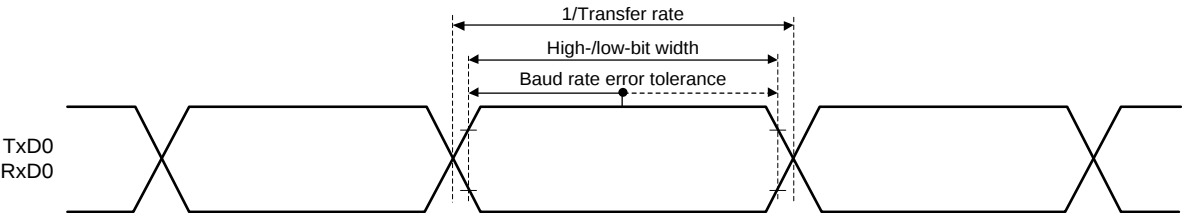
[T<sub>A</sub> = -40 to +105°C: G products, T<sub>A</sub> = -40 to +125°C: M products, 2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V]

| Item          | Symbol | Condition                                                                             | MIN. | TYP. | MAX.         | Unit |
|---------------|--------|---------------------------------------------------------------------------------------|------|------|--------------|------|
| Transfer rate |        |                                                                                       |      |      | $f_{MCK}/12$ | bps  |
|               |        | Theoretical value of the maximum transfer rate<br>$f_{CLK} = f_{MCK} = 16\text{ MHz}$ |      |      | 1.3          | Mbps |

UART mode connection diagram



UART mode bit width (reference)



**Remark**  $f_{MCK}$ : Serial array unit operation clock frequency  
(Operation clock to be set by serial clock select register 0 (SPS0) and the CKS0n bit of serial mode register 0n (SMR0n). n: Channel number (n = 0, 1))

**(2) Simplified SPI (CSI) mode (master mode, SCKp... internal clock output)****[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]**

| Item                                                              | Symbol             | Condition                                    | MIN.                                         | TYP. | MAX. | Unit |
|-------------------------------------------------------------------|--------------------|----------------------------------------------|----------------------------------------------|------|------|------|
| SCKp cycle time                                                   | $t_{KCY1}$         | $t_{KCY1} \geq 4/f_{CLK}$                    | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 250  |      | ns   |
|                                                                   |                    |                                              | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 500  |      | ns   |
| SCKp high-/low-level width                                        | $t_{KH1}, t_{KL1}$ | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | $t_{KCY1}/2 - 36$                            |      |      | ns   |
|                                                                   |                    | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | $t_{KCY1}/2 - 76$                            |      |      | ns   |
| Slp setup time<br>(to SCKp $\uparrow$ ) <sup>Note 1</sup>         | $t_{SIK1}$         | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 66                                           |      |      | ns   |
|                                                                   |                    | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 113                                          |      |      | ns   |
| Slp hold time<br>(from SCKp $\uparrow$ ) <sup>Note 1</sup>        | $t_{KSI1}$         |                                              | 38                                           |      |      | ns   |
| Delay time from SCKp $\downarrow$ to SOp output <sup>Note 2</sup> | $t_{KSO1}$         | $C = 30\text{ pF}$ <sup>Note 3</sup>         |                                              |      | 66   | ns   |

Note 1. When DAP0n = 0 and CKP0n = 0, or DAP0n = 1 and CKP0n = 1. The Slp setup time becomes “to SCKp  $\downarrow$ ” and the Slp hold time becomes “from SCKp  $\downarrow$ ” when DAP0n = 0 and CKP0n = 1, or DAP0n = 1 and CKP0n = 0.

Note 2. When DAP0n = 0 and CKP0n = 0, or DAP0n = 1 and CKP0n = 1. The delay time to SOp output becomes “from SCKp  $\downarrow$ ” when DAP0n = 0 and CKP0n = 1, or DAP0n = 1 and CKP0n = 0.

Note 3. C is the load capacitance of the SCKp and SOp output lines.

**(3) Simplified SPI (CSI) mode (slave mode, SCKp... external clock input)****[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]**

| Item                                                              | Symbol             | Condition                                    | MIN.                                         | TYP. | MAX.              | Unit |
|-------------------------------------------------------------------|--------------------|----------------------------------------------|----------------------------------------------|------|-------------------|------|
| SCKp cycle time                                                   | $t_{KCY2}$         | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | $12/f_{MCK}$                                 |      |                   | ns   |
|                                                                   |                    | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | $12/f_{MCK}$ and also 1000                   |      |                   | ns   |
| SCKp high-/low-level width                                        | $t_{KH2}, t_{KL2}$ | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | $t_{KCY2}/2 - 16$                            |      |                   | ns   |
|                                                                   |                    | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | $t_{KCY2}/2 - 36$                            |      |                   | ns   |
| Slp setup time<br>(to SCKp $\uparrow$ ) <sup>Note 1</sup>         | $t_{SIK2}$         | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | $1/f_{MCK} + 40$                             |      |                   | ns   |
|                                                                   |                    | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | $1/f_{MCK} + 60$                             |      |                   | ns   |
| Slp hold time<br>(from SCKp $\uparrow$ ) <sup>Note 1</sup>        | $t_{KSI2}$         | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | $1/f_{MCK} + 62$                             |      |                   | ns   |
| Delay time from SCKp $\downarrow$ to SOp output <sup>Note 2</sup> | $t_{KSO2}$         | $C = 30\text{ pF}$ <sup>Note 3</sup>         | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ |      | $2/f_{MCK} + 66$  | ns   |
|                                                                   |                    |                                              | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ |      | $2/f_{MCK} + 113$ | ns   |

Note 1. When DAP0n = 0 and CKP0n = 0, or DAP0n = 1 and CKP0n = 1. The Slp setup time becomes “to SCKp  $\downarrow$ ” and the Slp hold time becomes “from SCKp  $\downarrow$ ” when DAP0n = 0 and CKP0n = 1, or DAP0n = 1 and CKP0n = 0.

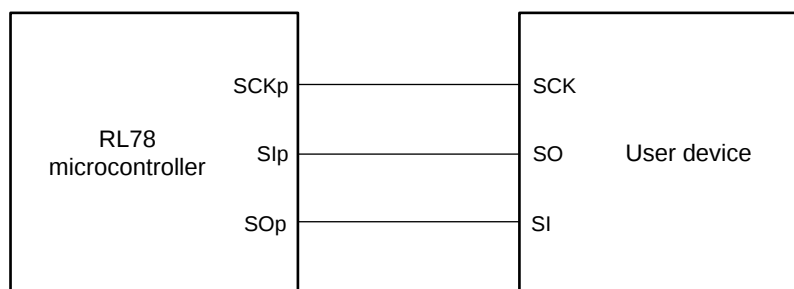
Note 2. When DAP0n = 0 and CKP0n = 0, or DAP0n = 1 and CKP0n = 1. The delay time to SOp output becomes “from SCKp  $\downarrow$ ” when DAP0n = 0 and CKP0n = 1, or DAP0n = 1 and CKP0n = 0.

Note 3. C is the load capacitance of the SOp output lines.

**Remark 1.** p: CSI number (p = 00, 01), n: Channel number (n = 0, 1)

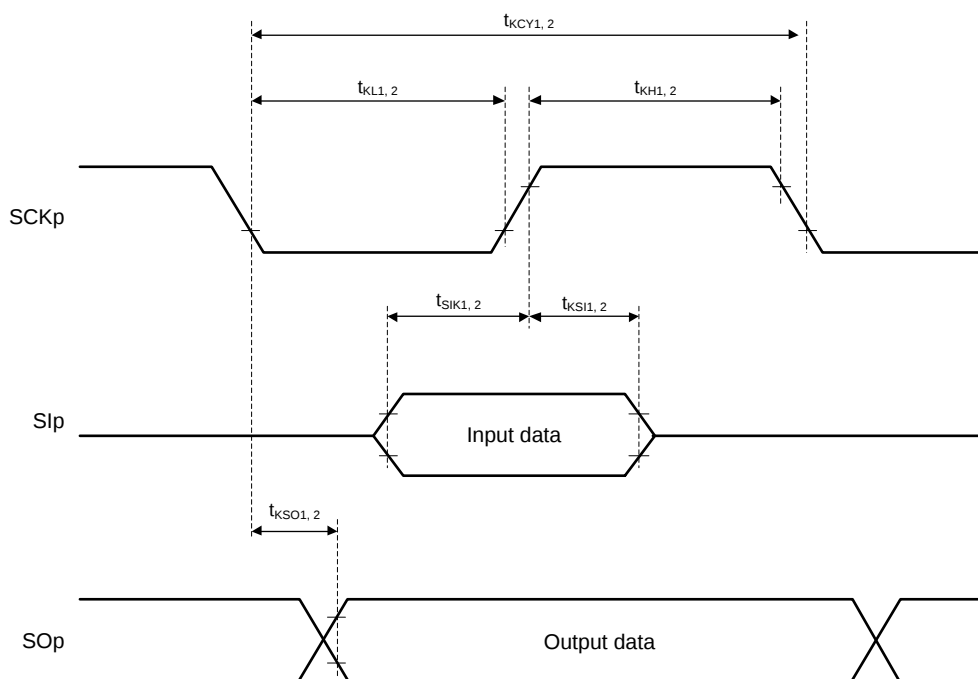
**Remark 2.**  $f_{\text{MCK}}$ : Serial array unit operation clock frequency  
(Operation clock to be set by serial clock select register 0 (SPS0) and the CKS0n bit of serial mode register 0n (SMR0n). n: Channel number (n = 0, 1))

Simplified SPI (CSI) mode connection diagram



Simplified SPI (CSI) mode serial transfer timing

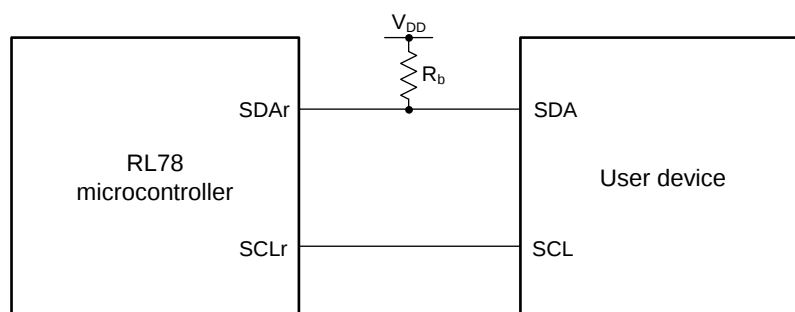
(When DAP0n = 0 and CKP0n = 0, or DAP0n = 1 and CKP0n = 1)

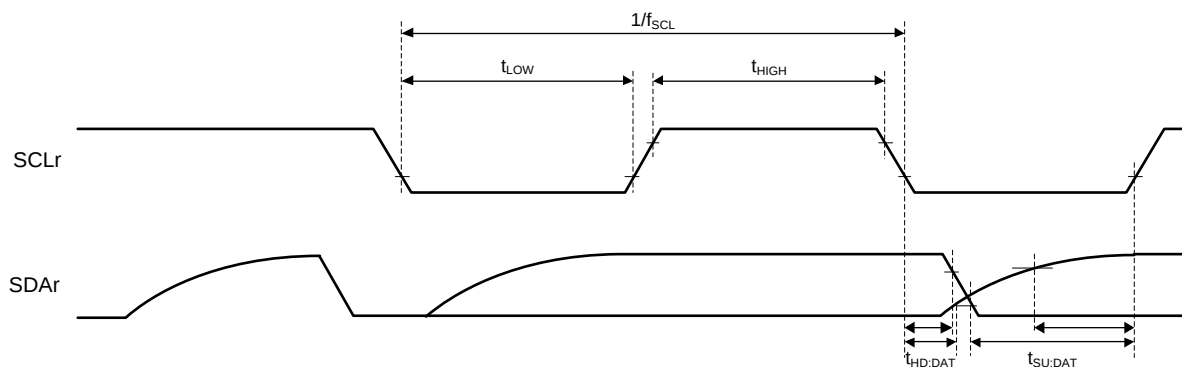


**Remark** p: CSI number (p = 00, 01), n: Channel number (n = 0, 1)

**(4) Simplified I<sup>2</sup>C mode****[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]**

| Item                          | Symbol              | Condition                                                                                        | MIN.                                       | MAX.                  | Unit |
|-------------------------------|---------------------|--------------------------------------------------------------------------------------------------|--------------------------------------------|-----------------------|------|
| SCLr clock frequency          | $f_{\text{SCL}}$    | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$<br>$C_b = 100\text{ pF}$ , $R_b = 3\text{ k}\Omega$ |                                            | 400 <sup>Note 1</sup> | kHz  |
|                               |                     | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$<br>$C_b = 100\text{ pF}$ , $R_b = 3\text{ k}\Omega$ |                                            | 100 <sup>Note 1</sup> | kHz  |
| Hold time when SCLr = "L"     | $t_{\text{LOW}}$    | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$<br>$C_b = 100\text{ pF}$ , $R_b = 3\text{ k}\Omega$ | 1200                                       |                       | ns   |
|                               |                     | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$<br>$C_b = 100\text{ pF}$ , $R_b = 3\text{ k}\Omega$ | 4600                                       |                       | ns   |
| Hold time when SCLr = "H"     | $t_{\text{HIGH}}$   | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$<br>$C_b = 100\text{ pF}$ , $R_b = 3\text{ k}\Omega$ | 1200                                       |                       | ns   |
|                               |                     | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$<br>$C_b = 100\text{ pF}$ , $R_b = 3\text{ k}\Omega$ | 4600                                       |                       | ns   |
| Data setup time (reception)   | $t_{\text{SU:DAT}}$ | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$<br>$C_b = 100\text{ pF}$ , $R_b = 3\text{ k}\Omega$ | $1/f_{\text{MCK}} + 220$ <sup>Note 2</sup> |                       | ns   |
|                               |                     | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$<br>$C_b = 100\text{ pF}$ , $R_b = 3\text{ k}\Omega$ | $1/f_{\text{MCK}} + 580$ <sup>Note 2</sup> |                       | ns   |
| Data hold time (transmission) | $t_{\text{HD:DAT}}$ | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$<br>$C_b = 100\text{ pF}$ , $R_b = 3\text{ k}\Omega$ | 0                                          | 770                   | ns   |
|                               |                     | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$<br>$C_b = 100\text{ pF}$ , $R_b = 3\text{ k}\Omega$ | 0                                          | 1420                  | ns   |

Note 1. The value must also be no greater than  $f_{\text{MCK}}/4$ .Note 2. Set  $f_{\text{MCK}}$  so that it will not exceed the hold time when SCLr = "L" or SCLr = "H".**Caution** Select the N-ch open drain output ( $V_{DD}$  tolerance) mode for the SDAr pin by using port output mode register 0, 2, or 4 (POM0, 2, or 4).Simplified I<sup>2</sup>C mode connection diagram

Simplified I<sup>2</sup>C mode serial transfer timing

**Remark 1.**  $R_b[\Omega]$ : Communication line (SDAr) pull-up resistance,  $C_b[F]$ : Communication line (SCLr, SDAr) load capacitance

**Remark 2.** r: IIC number (r = 00, 01)

**Remark 3.**  $f_{MCK}$ : Serial array unit operation clock frequency  
(Operation clock to be set by serial clock select register 0 (SPS0) and the CKS0n bit of serial mode register 0n (SMR0n). n: Channel number (n = 0, 1))

### 3.5.2 Serial interface IICA

[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                                            | Symbol              | Condition                                            | Standard Mode |      | Fast Mode |      | Unit          |
|-------------------------------------------------|---------------------|------------------------------------------------------|---------------|------|-----------|------|---------------|
|                                                 |                     |                                                      | MIN.          | MAX. | MIN.      | MAX. |               |
| SCLA0 clock frequency                           | $f_{\text{SCL}}$    | Fast mode:<br>$f_{\text{CLK}} \geq 3.5\text{ MHz}$   |               |      | 0         | 400  | kHz           |
|                                                 |                     | Standard mode:<br>$f_{\text{CLK}} \geq 1\text{ MHz}$ | 0             | 100  |           |      | kHz           |
| Setup time of restart condition                 | $t_{\text{SU:STA}}$ |                                                      | 4.7           |      | 0.6       |      | $\mu\text{s}$ |
| Hold time <sup>Note 1</sup>                     | $t_{\text{HD:STA}}$ |                                                      | 4.0           |      | 0.6       |      | $\mu\text{s}$ |
| Hold time when SCLA0 = "L"                      | $t_{\text{LOW}}$    |                                                      | 4.7           |      | 1.3       |      | $\mu\text{s}$ |
| Hold time when SCLA0 = "H"                      | $t_{\text{HIGH}}$   |                                                      | 4.0           |      | 0.6       |      | $\mu\text{s}$ |
| Data setup time (reception)                     | $t_{\text{SU:DAT}}$ |                                                      | 250           |      | 100       |      | ns            |
| Data hold time (transmission) <sup>Note 2</sup> | $t_{\text{HD:DAT}}$ |                                                      | 0             | 3.45 | 0         | 0.9  | $\mu\text{s}$ |
| Setup time of stop condition                    | $t_{\text{SU:STO}}$ |                                                      | 4.0           |      | 0.6       |      | $\mu\text{s}$ |
| Bus-free time                                   | $t_{\text{BUF}}$    |                                                      | 4.7           |      | 1.3       |      | $\mu\text{s}$ |

Note 1. The first clock pulse is generated after this period when the start or restart condition is detected.

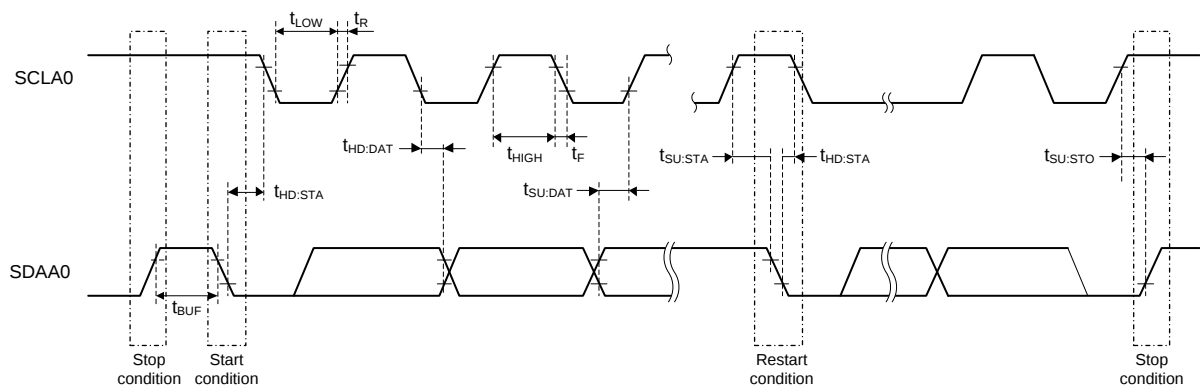
Note 2. The maximum value (MAX.) of  $t_{\text{HD:DAT}}$  applies to normal transfer and a wait is inserted at the ACK (acknowledge) timing.

**Remark** The maximum value of  $C_b$  (communication line capacitance) and the value of  $R_b$  (communication line pull-up resistance) at that time in each mode are as follows.

Standard mode:  $C_b = 400\text{ pF}$ ,  $R_b = 2.7\text{ k}\Omega$

Fast mode:  $C_b = 200\text{ pF}$ ,  $R_b = 1.7\text{ k}\Omega$

IICA serial transfer timing



## 3.6 Analog Characteristics

### 3.6.1 A/D converter characteristics

Targets: ANI0 to ANI10, internal reference voltage

[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                                                              | Symbol            | Condition                                                                 |                                                                   | MIN.                               | TYP.      | MAX.       | Unit          |
|-------------------------------------------------------------------|-------------------|---------------------------------------------------------------------------|-------------------------------------------------------------------|------------------------------------|-----------|------------|---------------|
| Resolution                                                        | RES               |                                                                           |                                                                   | 8                                  |           | 10         | bit           |
| Overall error <sup>Note 1, Note 2, Note 3</sup>                   | AINL              | 10-bit resolution                                                         | $V_{DD} = 5\text{ V}$                                             |                                    | $\pm 1.7$ | $\pm 3.1$  | LSB           |
|                                                                   |                   |                                                                           | $V_{DD} = 3\text{ V}$                                             |                                    | $\pm 2.3$ | $\pm 4.5$  | LSB           |
| Conversion time                                                   | $t_{\text{CONV}}$ | 10-bit resolution                                                         | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                      | 4.25                               |           | 17         | $\mu\text{s}$ |
|                                                                   |                   | Targets: ANI0 to ANI10                                                    | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$<br><sup>Note 5</sup> | 5.75                               |           | 23         | $\mu\text{s}$ |
|                                                                   |                   | 10-bit resolution<br>Target: Internal reference voltage <sup>Note 6</sup> | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$                      | 5.75                               |           | 23         | $\mu\text{s}$ |
| Zero-scale error<br><sup>Note 1, Note 2, Note 3, Note 4</sup>     | $E_{\text{ZS}}$   | 10-bit resolution                                                         | $V_{DD} = 5\text{ V}$                                             |                                    |           | $\pm 0.19$ | %FSR          |
|                                                                   |                   |                                                                           | $V_{DD} = 3\text{ V}$                                             |                                    |           | $\pm 0.39$ | %FSR          |
| Full-scale error<br><sup>Note 1, Note 2, Note 3, Note 4</sup>     | $E_{\text{FS}}$   | 10-bit resolution                                                         | $V_{DD} = 5\text{ V}$                                             |                                    |           | $\pm 0.29$ | %FSR          |
|                                                                   |                   |                                                                           | $V_{DD} = 3\text{ V}$                                             |                                    |           | $\pm 0.42$ | %FSR          |
| Integral linearity error<br><sup>Note 1, Note 2, Note 3</sup>     | ILE               | 10-bit resolution                                                         | $V_{DD} = 5\text{ V}$                                             |                                    |           | $\pm 1.8$  | LSB           |
|                                                                   |                   |                                                                           | $V_{DD} = 3\text{ V}$                                             |                                    |           | $\pm 1.7$  | LSB           |
| Differential linearity error<br><sup>Note 1, Note 2, Note 3</sup> | DLE               | 10-bit resolution                                                         | $V_{DD} = 5\text{ V}$                                             |                                    |           | $\pm 1.4$  | LSB           |
|                                                                   |                   |                                                                           | $V_{DD} = 3\text{ V}$                                             |                                    |           | $\pm 1.5$  | LSB           |
| Analog input voltage                                              | $V_{\text{AIN}}$  | Targets: ANI0 to ANI10                                                    |                                                                   | 0                                  |           | $V_{DD}$   | V             |
|                                                                   |                   | Target: Internal reference voltage <sup>Note 6</sup>                      |                                                                   | $V_{\text{REG}}$ <sup>Note 7</sup> |           |            | V             |

Note 1. The TYP. value is an average value at  $T_A = 25^\circ\text{C}$ . The MAX. value is an average value  $\pm 3\sigma$  at normal distribution.

Note 2. These values are the results of characteristic evaluation and are not checked for shipment.

Note 3. A quantization error ( $\pm 1/2$  LSB) is not included.

Note 4. Expressed as a ratio (%FSR) relative to the full-scale value.

Note 5. Be sure to set the LV0 bit in A/D converter mode register 0 (ADM0) to 0 when conversion is done in the operating voltage range of  $2.4\text{ V} \leq V_{DD} < 2.7\text{ V}$ .

Note 6. Be sure to set the LV0 bit in A/D converter mode register 0 (ADM0) to 0 when the internal reference voltage is selected as the target for conversion.

Note 7. Refer to **3.6.3 Internal reference voltage characteristics**.

**Caution 1.** Arrange wiring and insert the capacitor so that no noise appears on the power supply/ground line.

**Caution 2.** Do not allow any pulses that rapidly change such as digital signals to be input/output to/from the pins adjacent to the conversion pin during A/D conversion.

**Caution 3.** Note that the internal reference voltage cannot be used as the reference voltage of the comparator when the internal reference voltage is selected as the target for A/D conversion.

### 3.6.2 Comparator characteristics

[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                              | Symbol     | Condition                                                                 | MIN.                        | TYP. | MAX.           | Unit          |
|-----------------------------------|------------|---------------------------------------------------------------------------|-----------------------------|------|----------------|---------------|
| Input voltage range               | $I_{VREF}$ | IVREFn pin input (CnVRF bit = 0)                                          | 0                           |      | $V_{DD} - 1.4$ | V             |
|                                   |            | Internal reference voltage (CnVRF bit = 1) <sup>Note 1</sup>              | $V_{REG}$ <sup>Note 2</sup> |      |                | V             |
|                                   | $I_{VCMP}$ | IVCMPn pin input                                                          | -0.3                        |      | $V_{DD} + 0.3$ | V             |
| Output delay                      | $t_d$      | $V_{DD} = 3.0\text{ V}$ ,<br>input slew rate $> 50\text{ mV}/\mu\text{s}$ | High-speed mode             |      | 0.5            | $\mu\text{s}$ |
|                                   |            |                                                                           | Low-speed mode              |      | 2.0            | $\mu\text{s}$ |
| Operation stabilization wait time | $t_{CMP}$  |                                                                           | 100                         |      |                | $\mu\text{s}$ |

Note 1. When the internal reference voltage is selected as the reference voltage of the comparator, the internal reference voltage cannot be used as the target for A/D conversion.

Note 2. Refer to **3.6.3 Internal reference voltage characteristics**.

**Remark** n: Channel number (n = 0, 1)

### 3.6.3 Internal reference voltage characteristics

[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                              | Symbol    | Condition                                  | MIN. | TYP.  | MAX. | Unit          |
|-----------------------------------|-----------|--------------------------------------------|------|-------|------|---------------|
| Internal reference voltage        | $V_{REG}$ |                                            | 0.74 | 0.815 | 0.89 | V             |
| Operation stabilization wait time | $t_{AMP}$ | A/D converter is used (ADS register = 0DH) | 5    |       |      | $\mu\text{s}$ |

**Caution** The internal reference voltage cannot be simultaneously used by the A/D converter and the comparator; only one of them must be selected.

### 3.6.4 SPOR circuit characteristics

[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $V_{SS} = 0$  V]

| Item                                  |                            | Symbol             | Condition            | MIN. | TYP. | MAX. | Unit |
|---------------------------------------|----------------------------|--------------------|----------------------|------|------|------|------|
| Detection voltage                     | Power supply voltage level | V <sub>SPOR0</sub> | Power supply rising  | 4.08 | 4.28 | 4.45 | V    |
|                                       |                            | V <sub>SPDR0</sub> | Power supply falling | 4.00 | 4.20 | 4.37 | V    |
|                                       |                            | V <sub>SPOR1</sub> | Power supply rising  | 2.76 | 2.90 | 3.02 | V    |
|                                       |                            | V <sub>SPDR1</sub> | Power supply falling | 2.70 | 2.84 | 2.96 | V    |
|                                       |                            | V <sub>SPOR2</sub> | Power supply rising  | 2.44 | 2.57 | 2.68 | V    |
|                                       |                            | V <sub>SPDR2</sub> | Power supply falling | 2.40 | 2.52 | 2.62 | V    |
|                                       |                            | V <sub>SPOR3</sub> | Power supply rising  |      | 2.16 |      | V    |
|                                       |                            | V <sub>SPDR3</sub> | Power supply falling |      | 2.11 |      | V    |
| Minimum pulse width <sup>Note 1</sup> |                            | T <sub>SPW</sub>   |                      | 300  |      |      | μs   |

Note 1. Time required for the reset operation by the SPOR circuit when  $V_{DD}$  falls below  $V_{SPDR}$ .

**Caution** Make sure to keep the internal reset state by the SPOR or an external reset until the power supply voltage ( $V_{DD}$ ) reaches the operating voltage range shown in 3.4 AC Characteristics.

### 3.6.5 Power supply voltage rising slope characteristics

[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $V_{SS} = 0$  V]

| Item                              | Symbol    | Condition | MIN. | TYP. | MAX. | Unit |
|-----------------------------------|-----------|-----------|------|------|------|------|
| Power supply voltage rising slope | $S_{VDD}$ |           |      |      | 54   | V/ms |

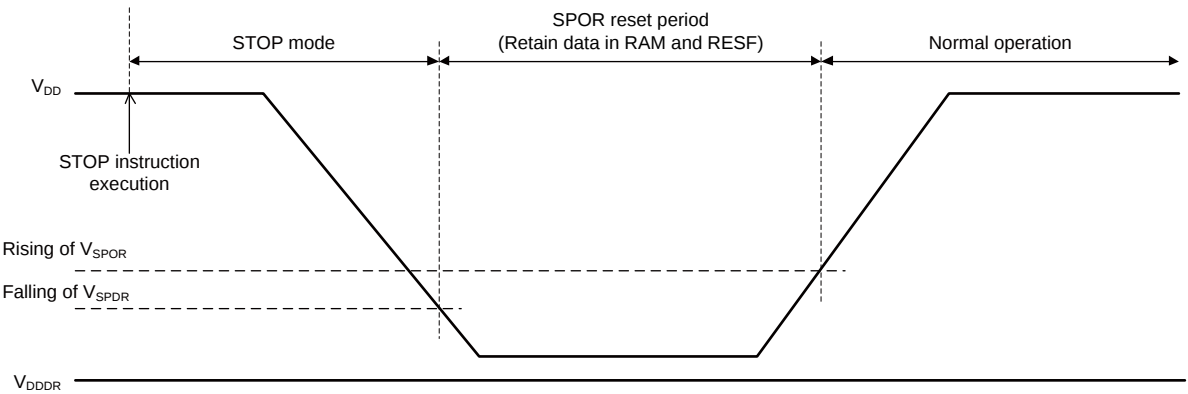
**Caution** Make sure to keep the internal reset state by the SPOR or an external reset until the power supply voltage ( $V_{DD}$ ) reaches the operating voltage range shown in 3.4 AC Characteristics.

3.7 RAM Data Retention Characteristics

[T<sub>A</sub> = -40 to +105°C: G products, T<sub>A</sub> = -40 to +125°C: M products, V<sub>SS</sub> = 0 V]

| Item                                | Symbol            | Condition | MIN. | TYP. | MAX. | Unit |
|-------------------------------------|-------------------|-----------|------|------|------|------|
| Data retention power supply voltage | V <sub>DDDR</sub> |           | 1.9  |      | 5.5  | V    |

**Caution** Data in RAM is retained until the power supply voltage falls below the MIN. value of the data retention power supply voltage (V<sub>DDDR</sub>). Note that data in the RESF register might not be cleared even if the power supply voltage falls below the MIN. value of the data retention power supply voltage (V<sub>DDDR</sub>).



### 3.8 Flash Memory Programming Characteristics



[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                                                           | Symbol            | Condition             |                                          | MIN.    | TYP.      | MAX. | Unit  |
|----------------------------------------------------------------|-------------------|-----------------------|------------------------------------------|---------|-----------|------|-------|
| Number of code flash rewrites<br><small>Note 1, Note 2</small> | C <sub>erwr</sub> | Retained for 20 years | T <sub>A</sub> = +85°C <sup>Note 3</sup> | 1000    |           |      | Times |
| Number of data flash rewrites<br><small>Note 1, Note 2</small> |                   | Retained for 1 year   | T <sub>A</sub> = +25°C                   |         | 1,000,000 |      | Times |
|                                                                |                   | Retained for 5 years  | T <sub>A</sub> = +85°C <sup>Note 3</sup> | 100,000 |           |      | Times |
|                                                                |                   | Retained for 20 years | T <sub>A</sub> = +85°C <sup>Note 3</sup> | 10,000  |           |      | Times |

Note 1. 1 erase + 1 write after the erase is regarded as 1 rewrite. The retaining years are until next rewrite after the rewrite.

Note 2. These are the characteristics of the flash memory and the results obtained from reliability testing by Renesas Electronics.



Note 3. This temperature is the average value at which data are retained.

#### Code flash/data flash self-programming time



[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                 | Symbol    | $f_{CLK} = 1\text{ MHz}$ |      |       | $f_{CLK} = 16\text{ MHz}$ |      |       | Unit          |
|----------------------|-----------|--------------------------|------|-------|---------------------------|------|-------|---------------|
|                      |           | MIN.                     | TYP. | MAX.  | MIN.                      | TYP. | MAX.  |               |
| Writing (4 bytes)    | $t_{P4}$  |                          | 104  | 905   |                           | 53.8 | 504.9 | $\mu\text{s}$ |
| Block erasure (1 KB) | $t_{E1K}$ |                          | 7.9  | 262.3 |                           | 5.5  | 214.1 | ms            |

**Caution** The listed values do not include the time until the operations of the flash memory start following execution of an instruction by software.

### 3.9 Dedicated Flash Memory Programmer Communication (UART)

[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item          | Symbol | Condition | MIN. | TYP.    | MAX. | Unit |
|---------------|--------|-----------|------|---------|------|------|
| Transfer rate |        |           |      | 115,200 |      | bps  |

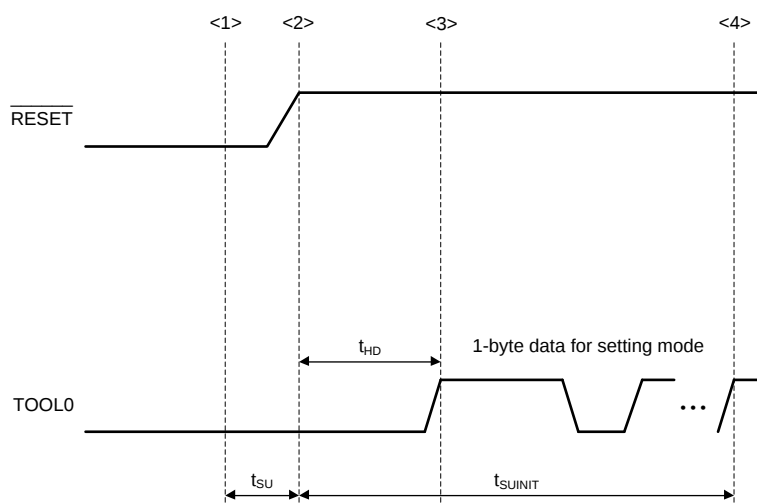
**Remark** The transfer rate during flash memory programming is fixed to 115,200 bps.

### 3.10 Timing of Entry to Flash Memory Programming Mode



[ $T_A = -40$  to  $+105^\circ\text{C}$ : G products,  $T_A = -40$  to  $+125^\circ\text{C}$ : M products,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ]

| Item                                                                                            | Symbol             | Condition                                                              | MIN. | TYP. | MAX. | Unit          |
|-------------------------------------------------------------------------------------------------|--------------------|------------------------------------------------------------------------|------|------|------|---------------|
| Time to complete the communication for the initial setting after the external reset is released | $t_{\text{SUNIT}}$ | The SPOR reset must be released before the external reset is released. |      |      | 100  | ms            |
| Time to release the external reset after the TOOL0 pin is set to the low level                  | $t_{\text{SU}}$    | The SPOR reset must be released before the external reset is released. | 10   |      |      | $\mu\text{s}$ |
| Time to hold the TOOL0 pin at the low level after the external reset is released                | $t_{\text{HD}}$    | The SPOR reset must be released before the external reset is released. | 1    |      |      | ms            |



<1> The low level is input to the TOOL0 pin.

<2> The external reset is released (the SPOR reset must have been released before that).

<3> The TOOL0 pin is released from the low level.

<4> Setting of entry to the flash memory programming mode by UART reception is completed.

**Remark**  $t_{\text{SUNIT}}$ : During this period, the communications for the initial setting must be completed within 100 ms after release from the reset.

$t_{\text{SU}}$ : Time to release the external reset after the TOOL0 pin is set to the low level

$t_{\text{HD}}$ : Time to hold the TOOL0 pin at the low level after the external reset is released

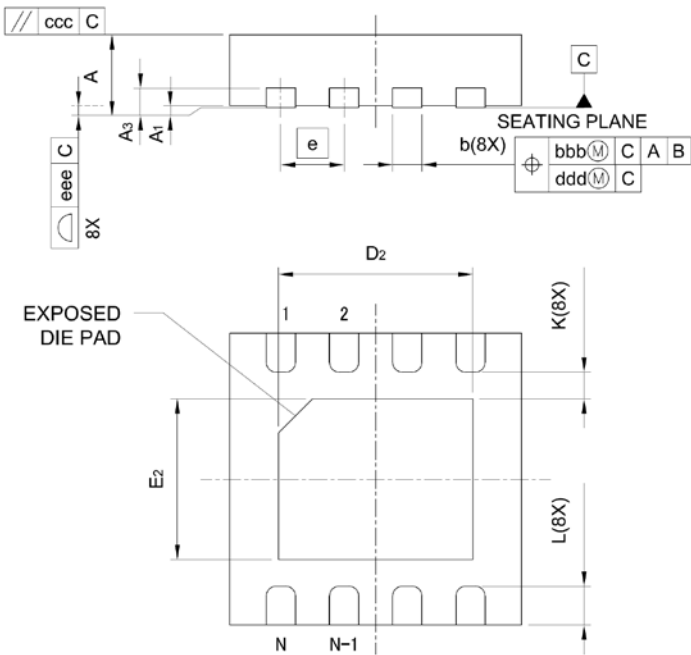
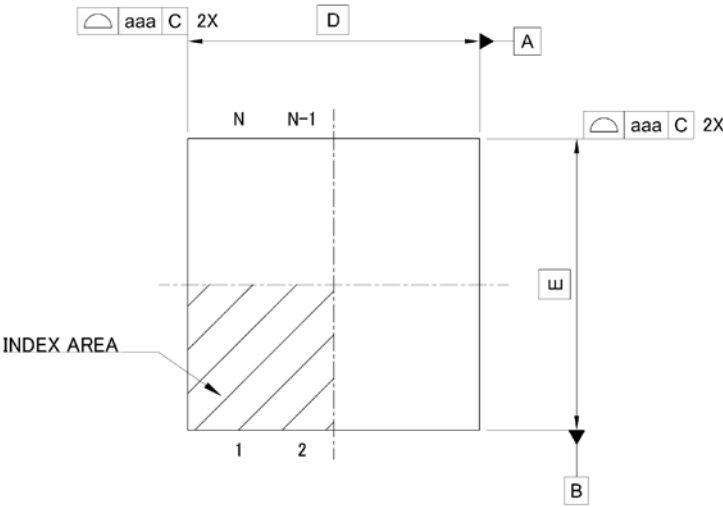
4. PACKAGE DRAWINGS

★ 4.1 8-pin products

R5F12008MNS, R5F12008GNS, R5F12008ANS

R5F12007MNS, R5F12007GNS, R5F12007ANS

| JEITA Package code | RENESAS code | MASS(TYP.)[g] |
|--------------------|--------------|---------------|
| P-HWSON8-3x3-0.65  | PWSN0008JG-A | 0.02          |



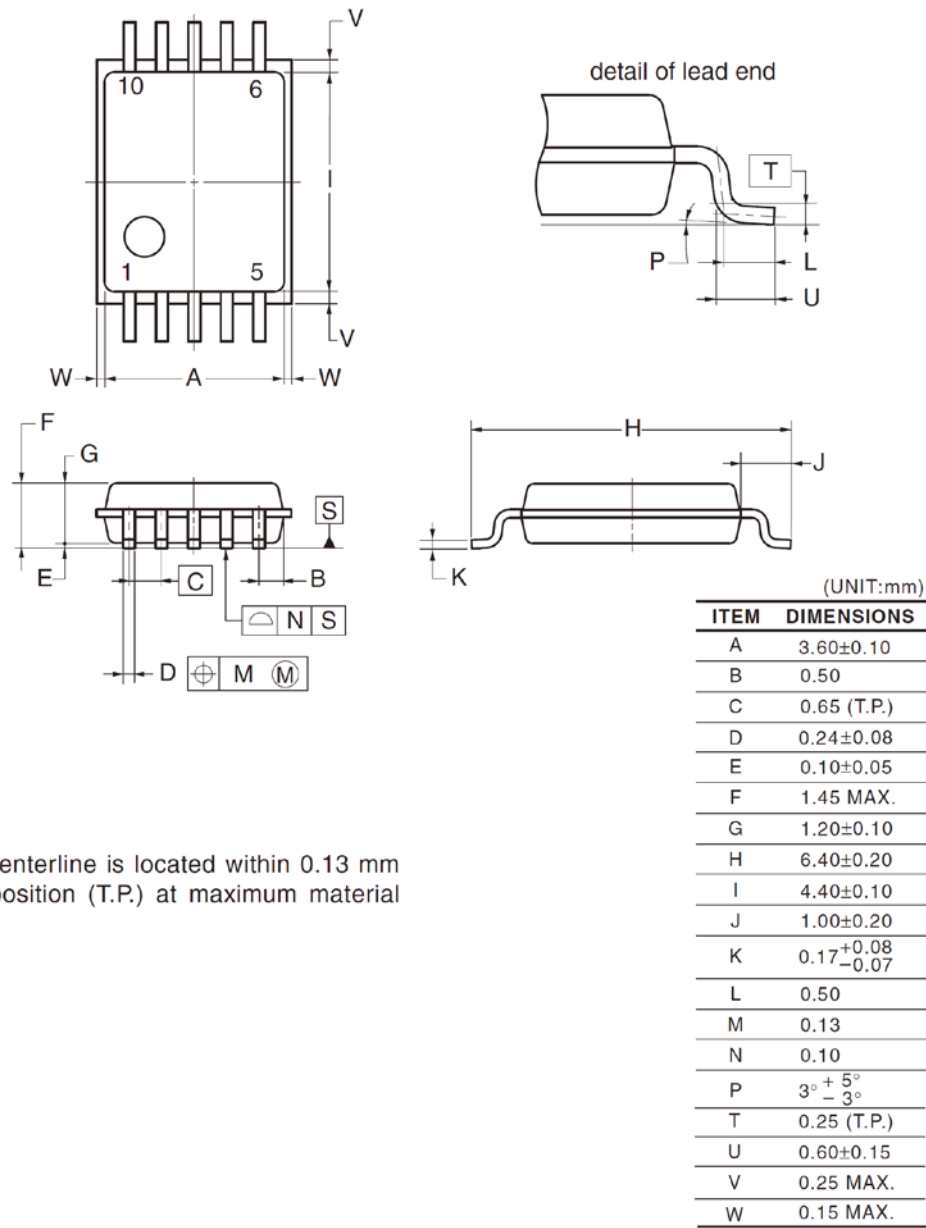
| Reference Symbol | Dimension in Millimeters |      |      |
|------------------|--------------------------|------|------|
|                  | Min.                     | Nom. | Max. |
| A                | —                        | —    | 0.80 |
| A <sub>1</sub>   | 0.00                     | —    | 0.05 |
| A <sub>3</sub>   | 0.203 REF.               |      |      |
| b                | 0.25                     | 0.30 | 0.35 |
| D                | 3.00                     |      |      |
| E                | 3.00                     |      |      |
| e                | 0.65                     |      |      |
| N                | 8                        |      |      |
| L                | 0.35                     | 0.40 | 0.45 |
| K                | 0.20                     | —    | —    |
| D <sub>2</sub>   | 1.95                     | 2.00 | 2.05 |
| E <sub>2</sub>   | 1.60                     | 1.65 | 1.70 |
| aaa              | —                        | —    | 0.15 |
| bbb              | —                        | —    | 0.10 |
| ccc              | —                        | —    | 0.10 |
| ddd              | —                        | —    | 0.05 |
| eee              | —                        | —    | 0.08 |

4.2 10-pin products

R5F12018MSP, R5F12018GSP, R5F12018ASP

R5F12017MSP, R5F12017GSP, R5F12017ASP

|                        |              |                |                 |
|------------------------|--------------|----------------|-----------------|
| JEITA Package Code     | RENESAS Code | Previous Code  | MASS (TYP.) [g] |
| P-LSSOP10-4.4x3.6-0.65 | PLSP0010JA-A | P10MA-65-CAC-2 | 0.05            |



**NOTE**  
Each lead centerline is located within 0.13 mm of its true position (T.P.) at maximum material condition.

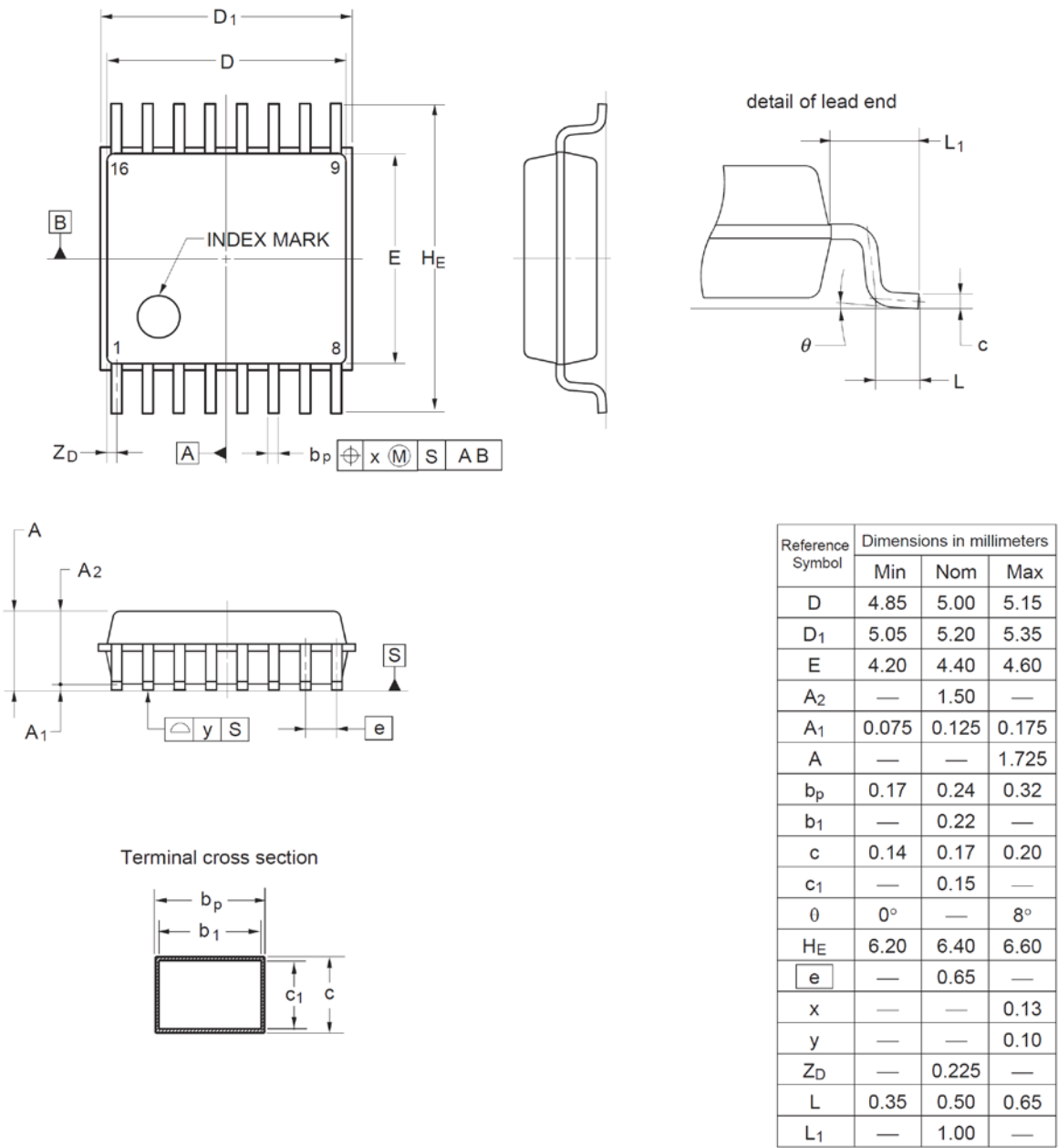
4.3 16-pin products

R5F12048MSP, R5F12048GSP, R5F12048ASP

R5F12047MSP, R5F12047GSP, R5F12047ASP

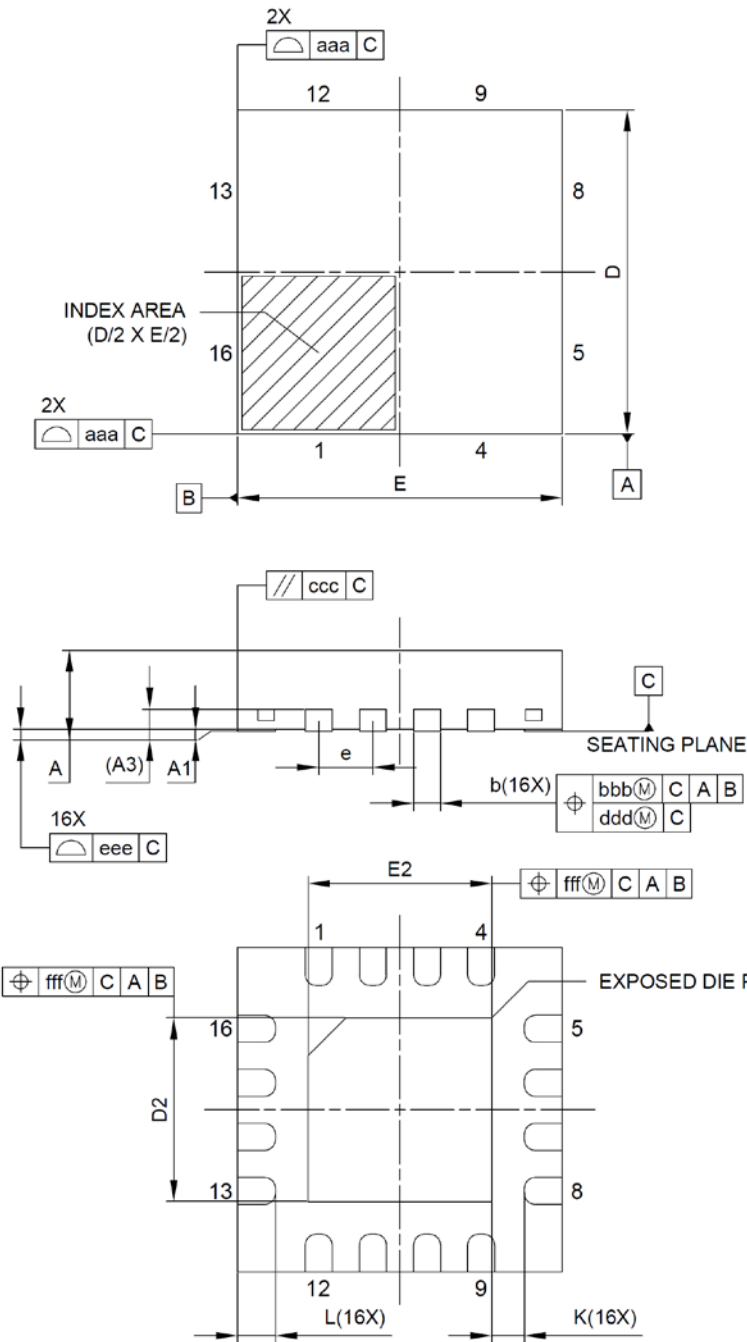
| JEITA Package Code  | RENESAS Code | Previous Code  | MASS (Typ) [g] |
|---------------------|--------------|----------------|----------------|
| P-SSOP16-4.4x5-0.65 | PRSP0016JC-B | P16MA-65-FAB-1 | 0.08           |

Unit: mm



R5F12048MNA, R5F12048GNA, R5F12048ANA  
R5F12047MNA, R5F12047GNA, R5F12047ANA

| JEITA Package code  | RENESAS code | MASS(TYP.)[g] |
|---------------------|--------------|---------------|
| P-HWQFN016-3x3-0.50 | PWQN0016KD-A | 0.02          |



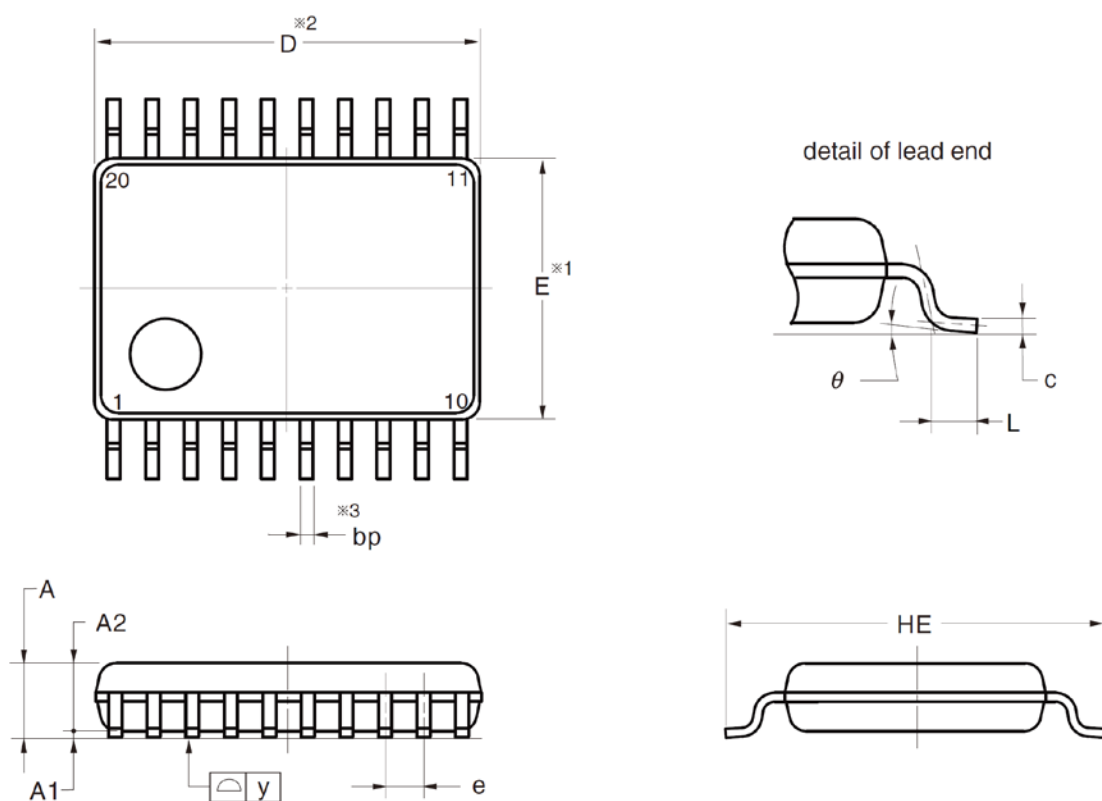
| Reference Symbol | Dimension in Millimeters |      |      |
|------------------|--------------------------|------|------|
|                  | Min.                     | Nom. | Max. |
| A                | —                        | —    | 0.80 |
| A1               | 0.00                     | 0.02 | 0.05 |
| A3               | 0.203 REF.               |      |      |
| b                | 0.20                     | 0.25 | 0.30 |
| D                | 3.00 BSC                 |      |      |
| E                | 3.00 BSC                 |      |      |
| e                | 0.50 BSC                 |      |      |
| L                | 0.30                     | 0.35 | 0.40 |
| K                | 0.20                     | —    | —    |
| D2               | 1.65                     | 1.70 | 1.75 |
| E2               | 1.65                     | 1.70 | 1.75 |
| aaa              | 0.15                     |      |      |
| bbb              | 0.10                     |      |      |
| ccc              | 0.10                     |      |      |
| ddd              | 0.05                     |      |      |
| eee              | 0.08                     |      |      |
| fff              | 0.10                     |      |      |

## 4.4 20-pin products

R5F12068MSP, R5F12068GSP, R5F12068ASP

R5F12067MSP, R5F12067GSP, R5F12067ASP

| JEITA Package Code     | RENESAS Code | Previous Code  | MASS (TYP.) [g] |
|------------------------|--------------|----------------|-----------------|
| P-LSSOP20-4.4x6.5-0.65 | PLSP0020JB-A | P20MA-65-NAA-1 | 0.1             |



### NOTE

1. Dimensions "※1" and "※2" do not include mold flash.
2. Dimension "※3" does not include trim offset.

(UNIT:mm)

| ITEM | DIMENSIONS                             |
|------|----------------------------------------|
| D    | 6.50±0.10                              |
| E    | 4.40±0.10                              |
| HE   | 6.40±0.20                              |
| A    | 1.45 MAX.                              |
| A1   | 0.10±0.10                              |
| A2   | 1.15                                   |
| e    | 0.65±0.12                              |
| bp   | 0.22 <sup>+0.10</sup> <sub>-0.05</sub> |
| c    | 0.15 <sup>+0.05</sup> <sub>-0.02</sub> |
| L    | 0.50±0.20                              |
| y    | 0.10                                   |
| θ    | 0° to 10°                              |

|                  |                    |
|------------------|--------------------|
| REVISION HISTORY | RL78/G15 Datasheet |
|------------------|--------------------|

| Rev. | Date         | Description |                                                                                                                                                                                                  |
|------|--------------|-------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|      |              | Page        | Summary                                                                                                                                                                                          |
| 1.00 | Oct 17, 2022 | —           | First edition issued                                                                                                                                                                             |
| 1.10 | Apr 28, 2023 | 19          | 2. ELECTRICAL SPECIFICATIONS ( $T_A = -40$ to $+85^\circ\text{C}$ ): The section title, modified. Caution 3, deleted.                                                                            |
|      |              | 21          | 2.2.2 On-chip oscillator characteristics: Note 3, deleted                                                                                                                                        |
|      |              | 24          | 2.3.2 Supply current characteristics: Note 1, modified                                                                                                                                           |
|      |              | 39          | 2.8 Flash Memory Programming Characteristics: The condition was added to the code flash/data flash self-programming time                                                                         |
|      |              | 40          | 2.10 Timing of Entry to Flash Memory Programming Mode: The condition, added                                                                                                                      |
|      |              | 41          | 3. ELECTRICAL SPECIFICATIONS ( $T_A = -40$ to $+105^\circ\text{C}$ , $T_A = -40$ to $+125^\circ\text{C}$ ): The section title, modified. Caution 3, deleted.                                     |
|      |              | 43          | 3.2.2 On-chip oscillator characteristics: The MIN. and MAX. values of high-speed on-chip oscillator clock frequency accuracy ( $T_A = +85$ to $+125^\circ\text{C}$ ), modified. Note 3, deleted. |
|      |              | 46          | 3.3.2 Supply current characteristics: Note 1, modified                                                                                                                                           |
|      |              | 61          | 3.8 Flash Memory Programming Characteristics: The condition in the table, modified. Note 3, added. The condition was added to the code flash/data flash self-programming time.                   |
|      |              | 62          | 3.10 Timing of Entry to Flash Memory Programming Mode: The condition, added                                                                                                                      |
|      |              | 63          | 4.1 8-pin products: The description, deleted. The package drawing, added.                                                                                                                        |

# General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

## 1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

## 2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

## 3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

## 4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

## 5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

## 6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).

## 7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

## 8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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